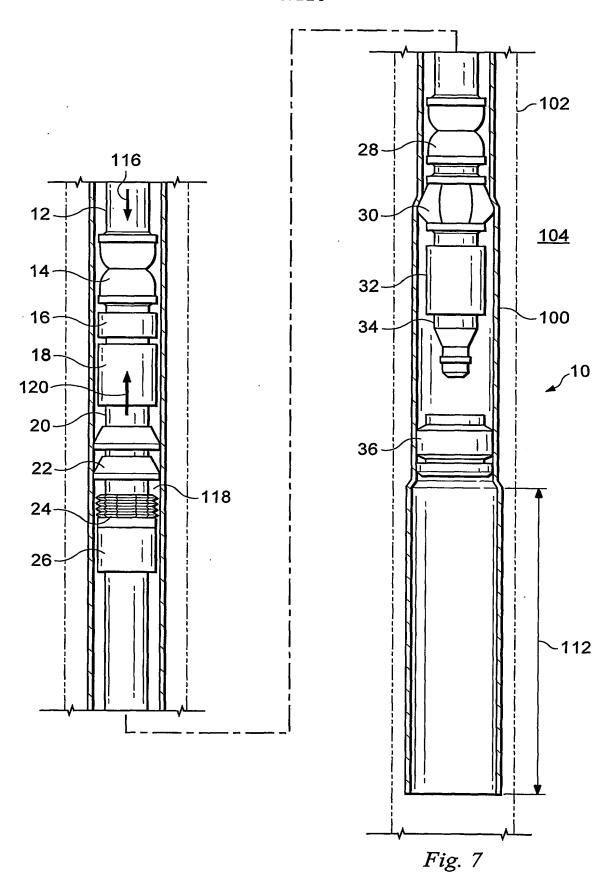
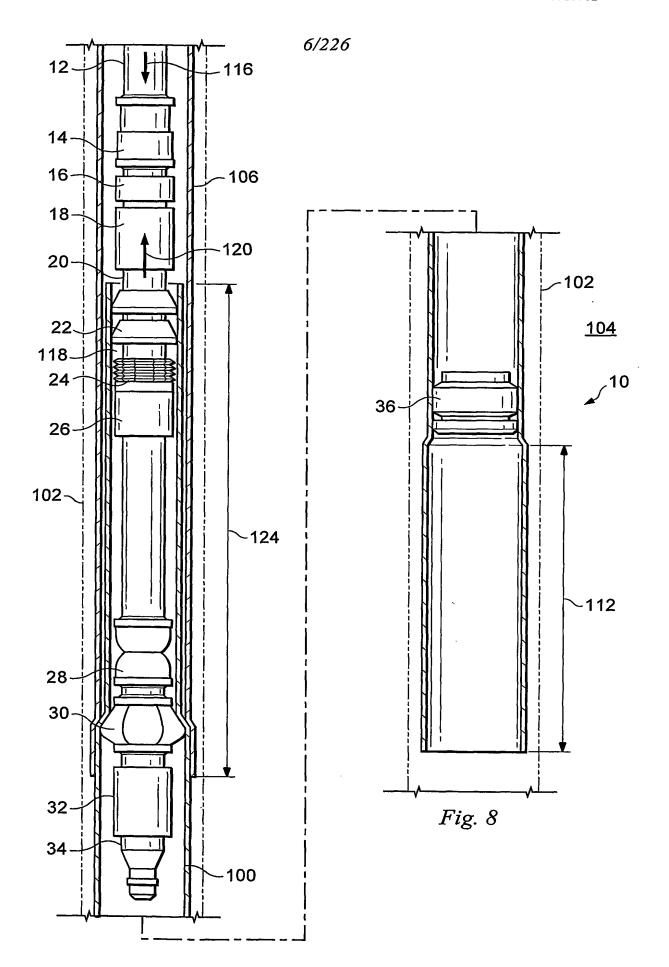
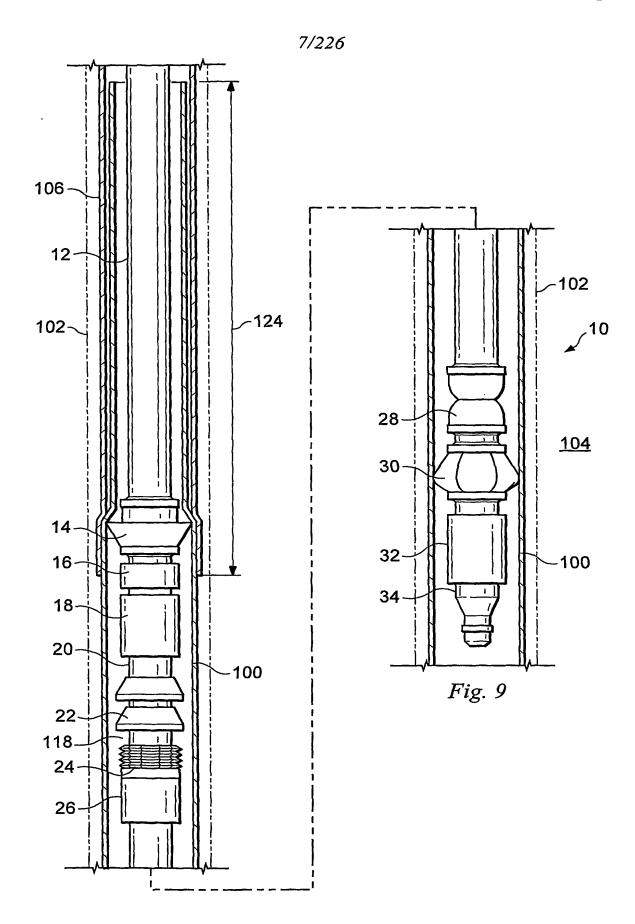
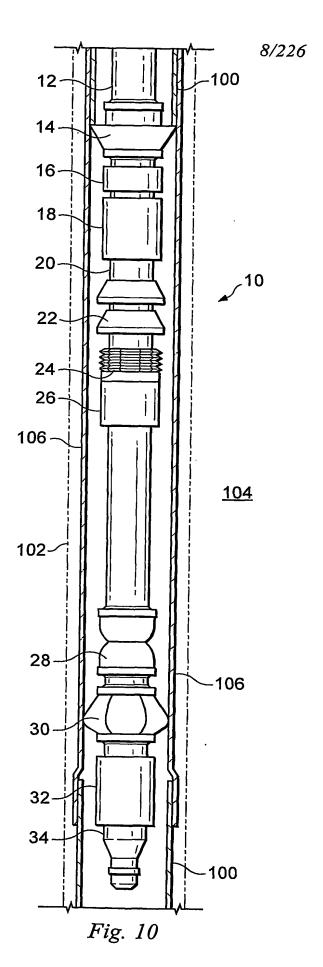


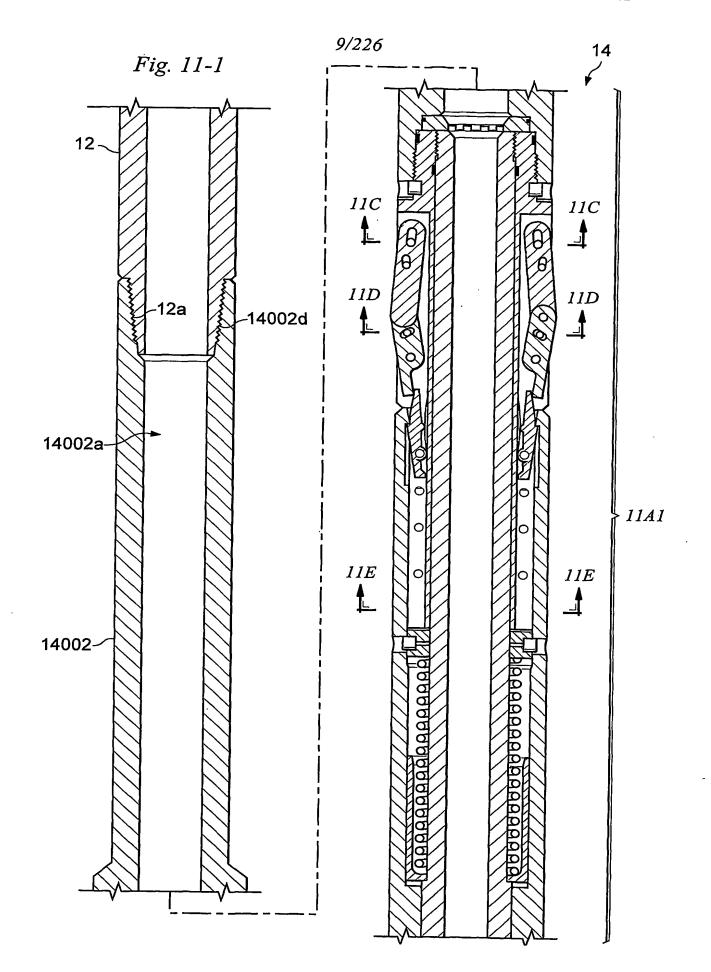
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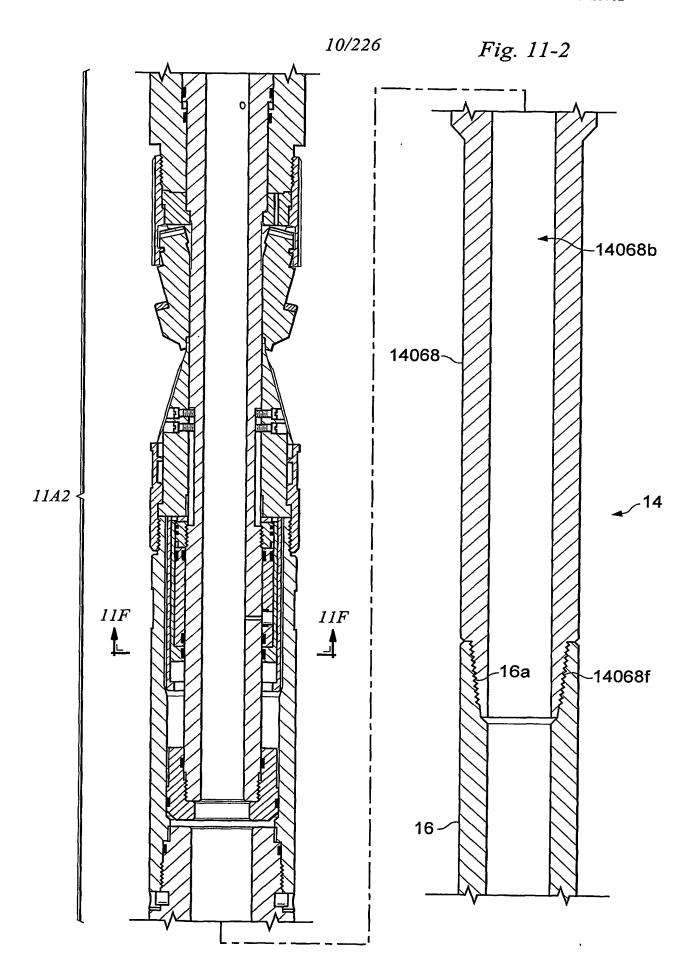


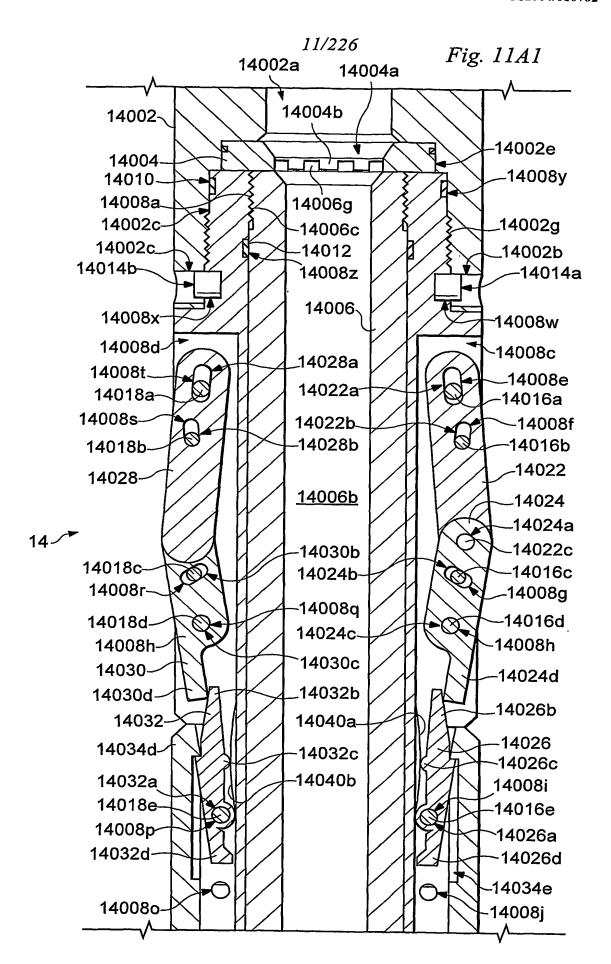


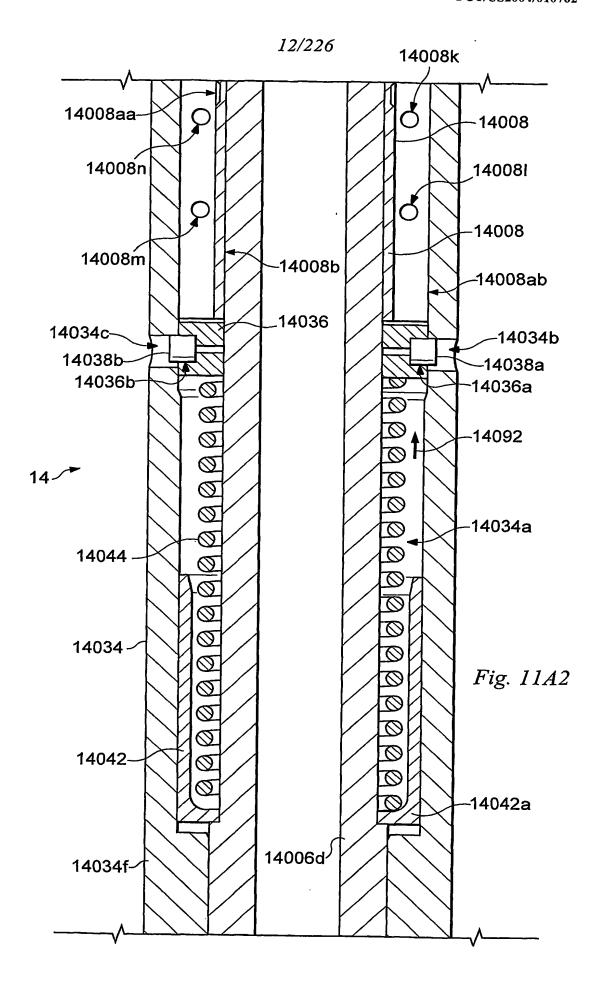


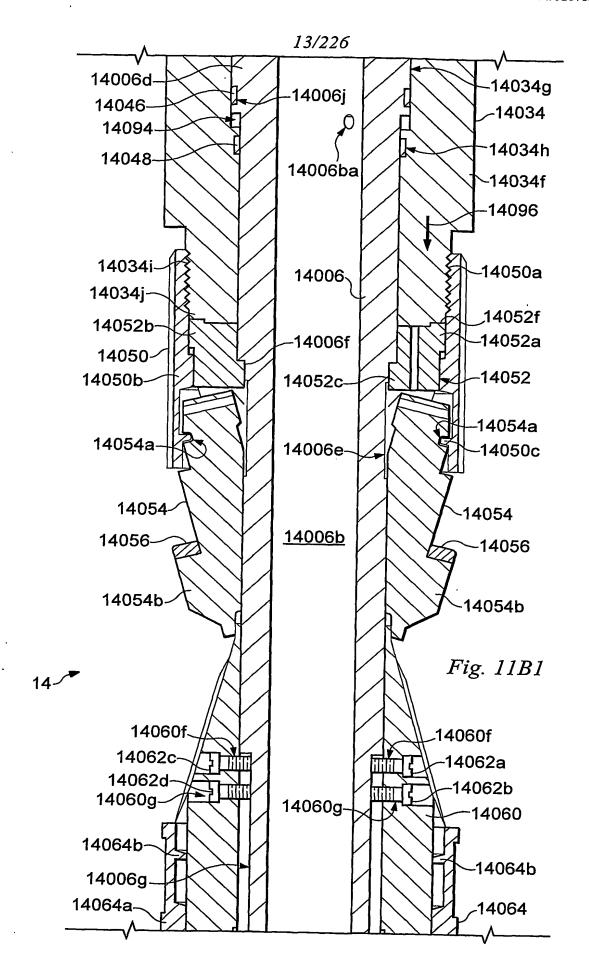




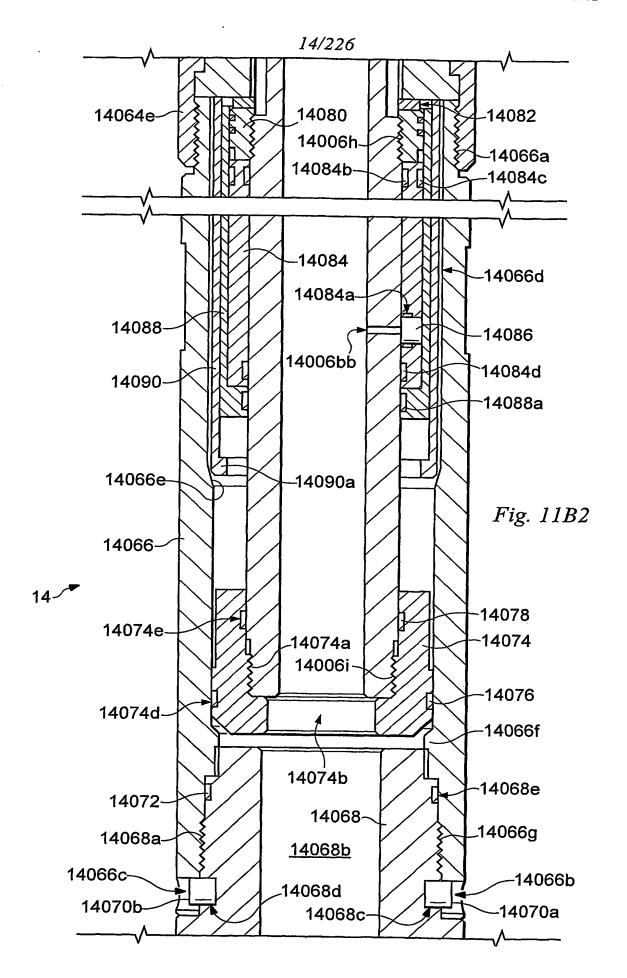




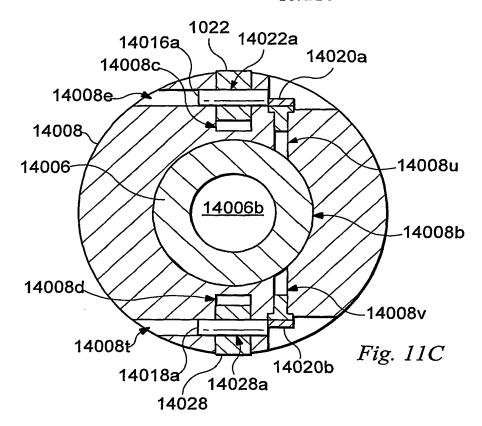


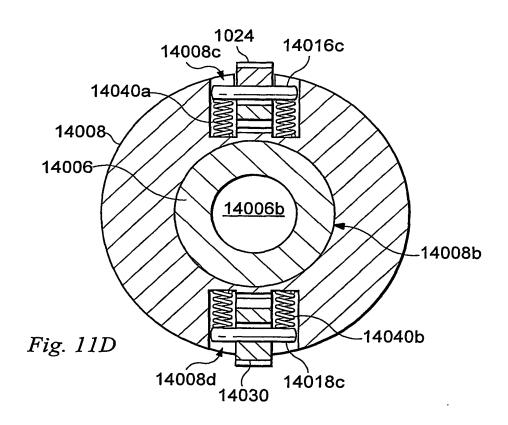


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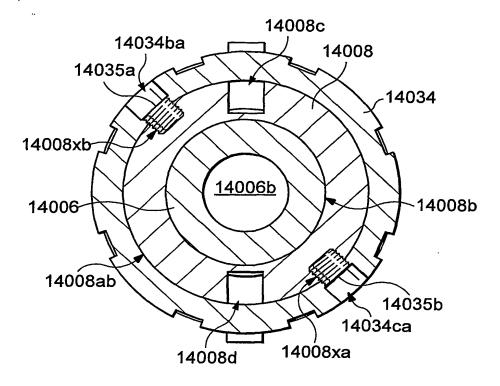


Fig. 11E

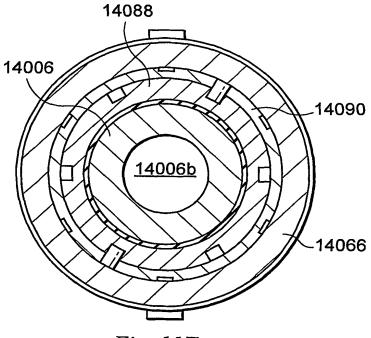
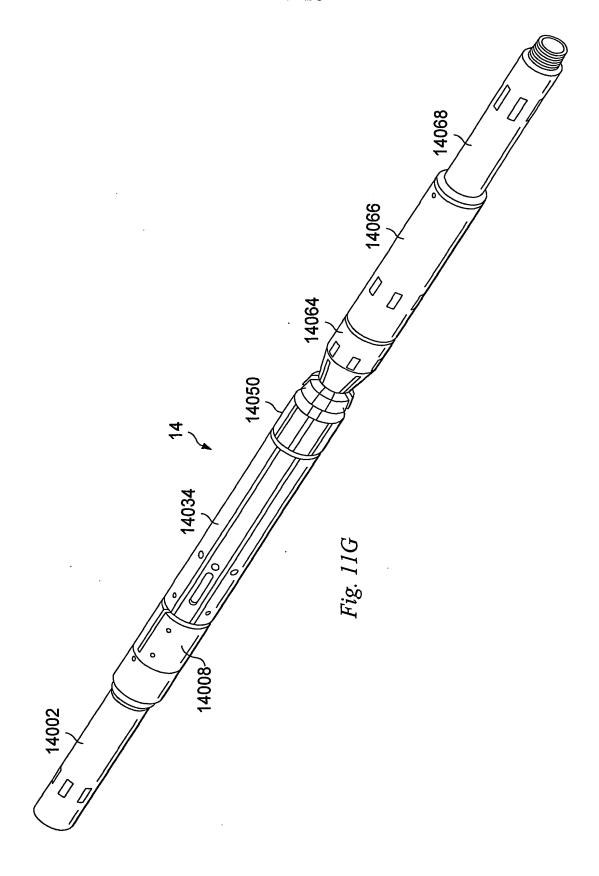


Fig. 11F

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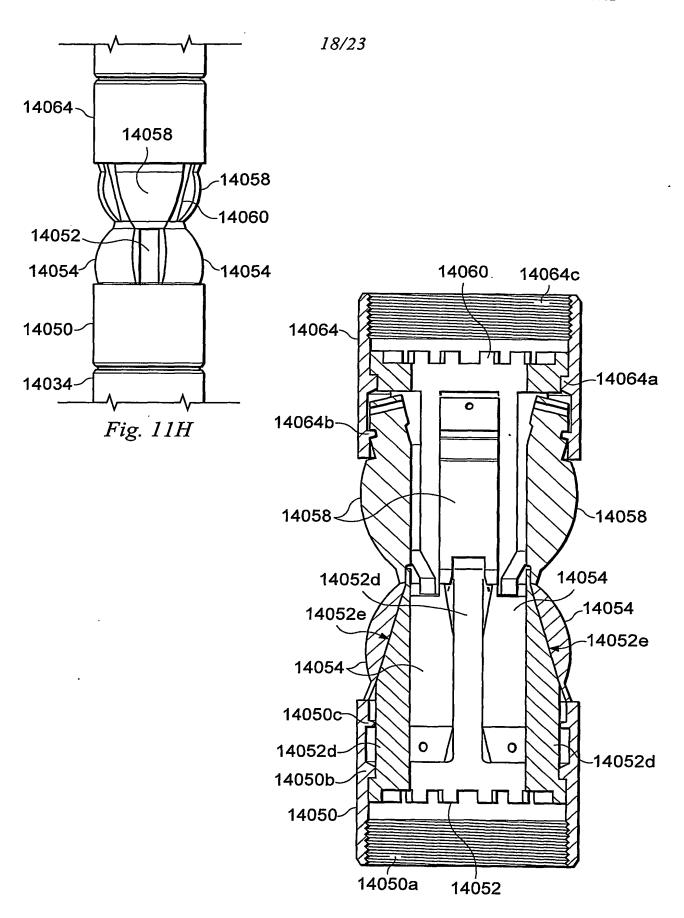
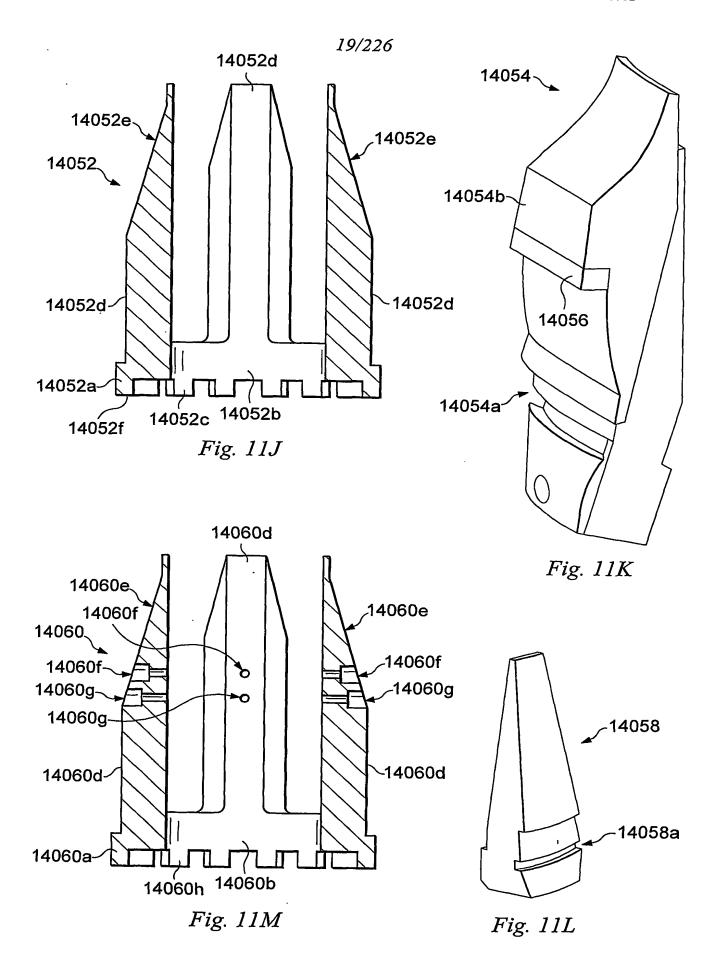
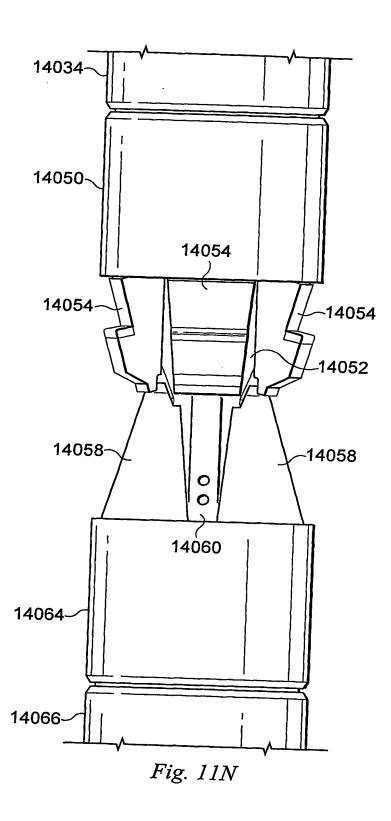


FIG. 11I





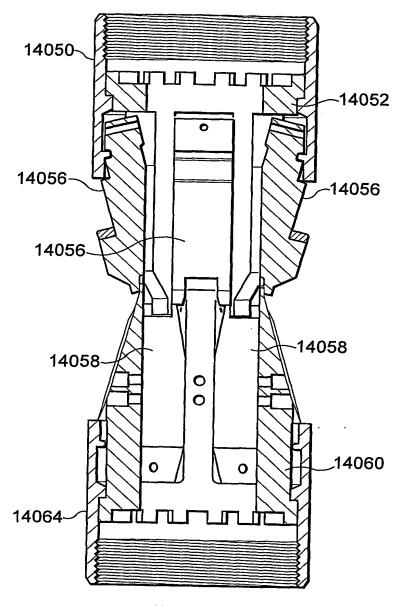
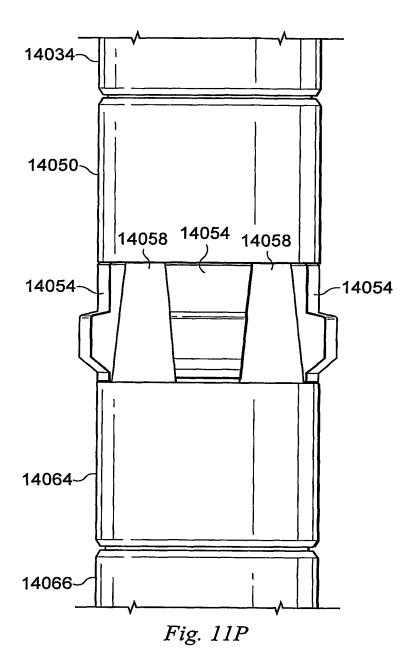


Fig. 110



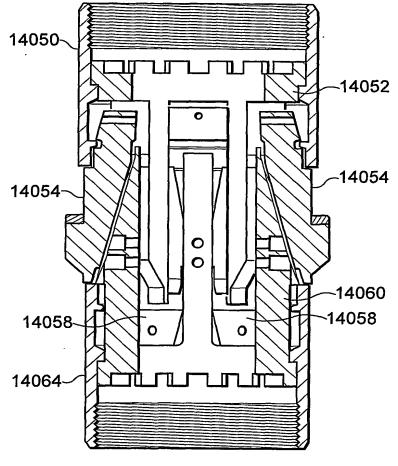
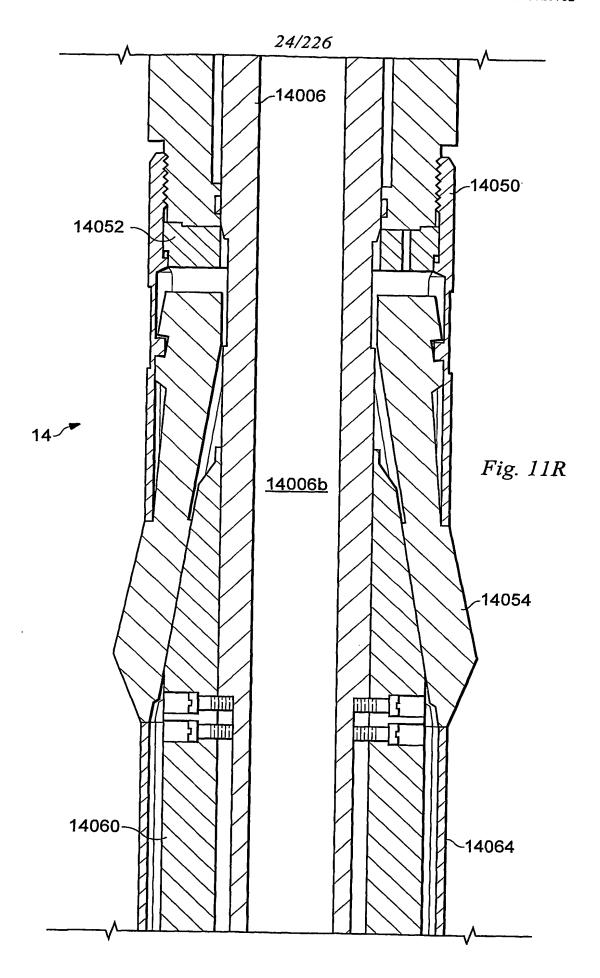


Fig. 11Q



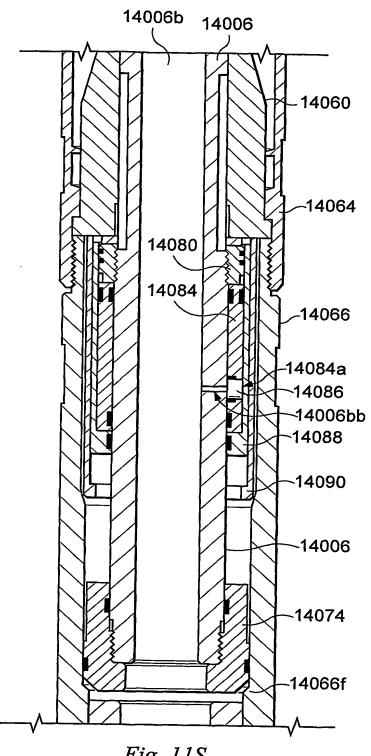


Fig. 11S

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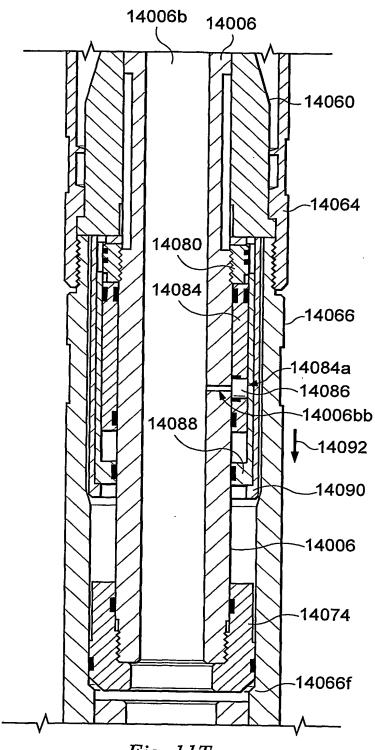
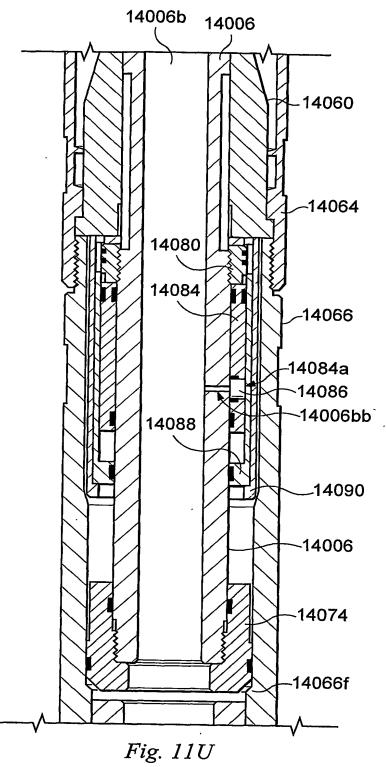


Fig. 11T

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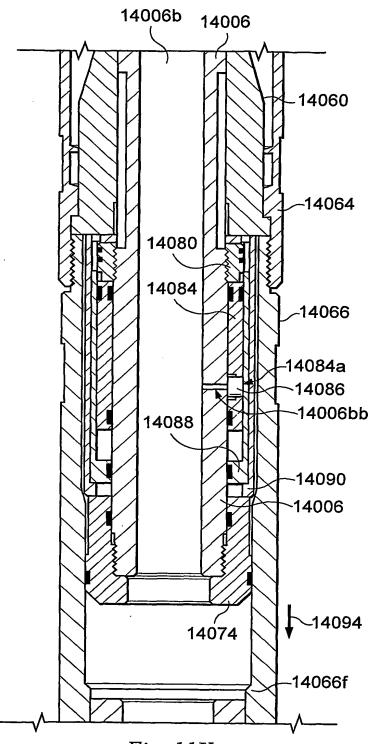
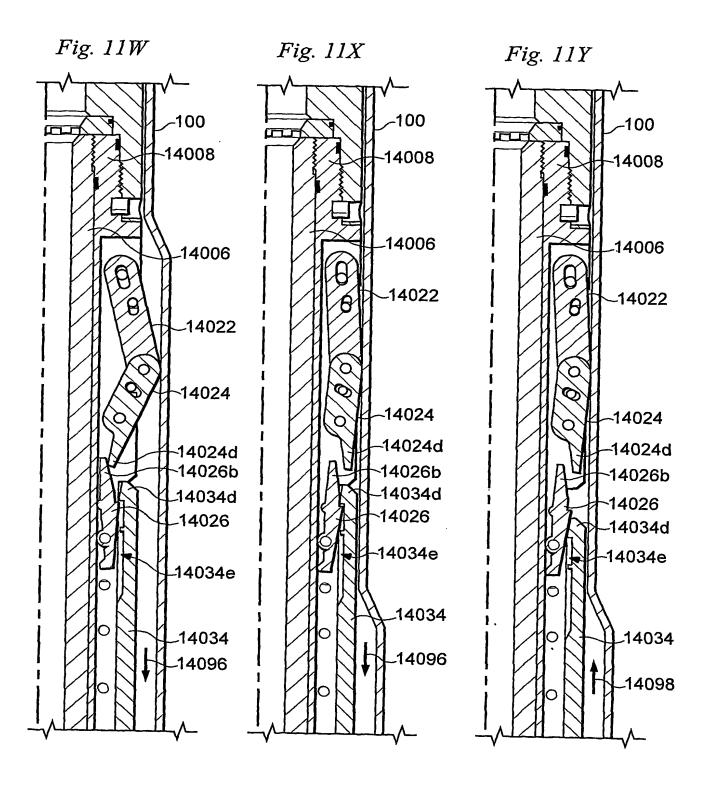
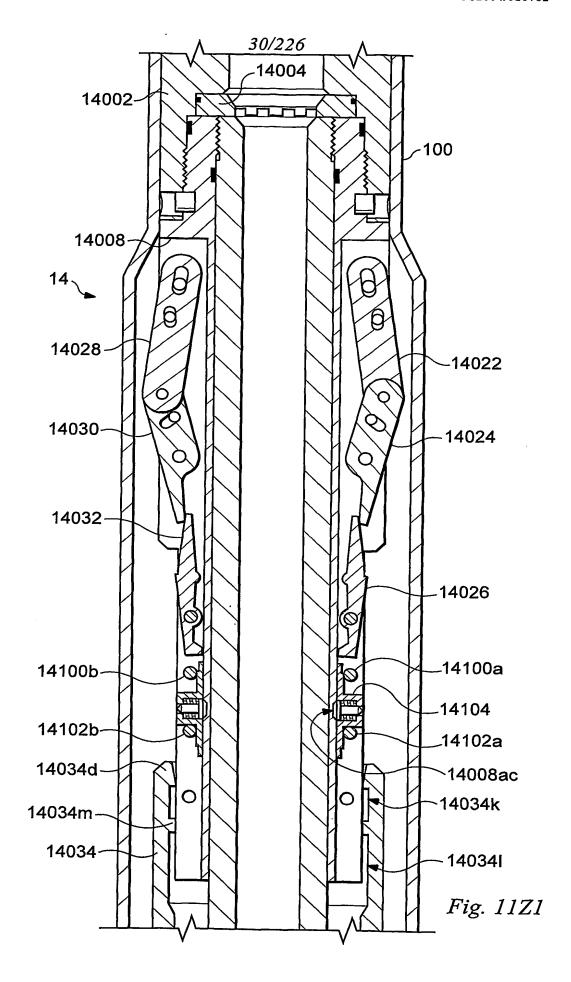


Fig. 11V





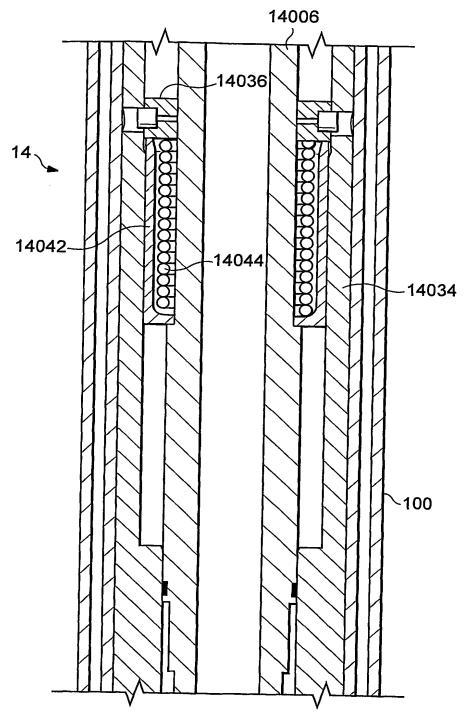


Fig. 11Z2

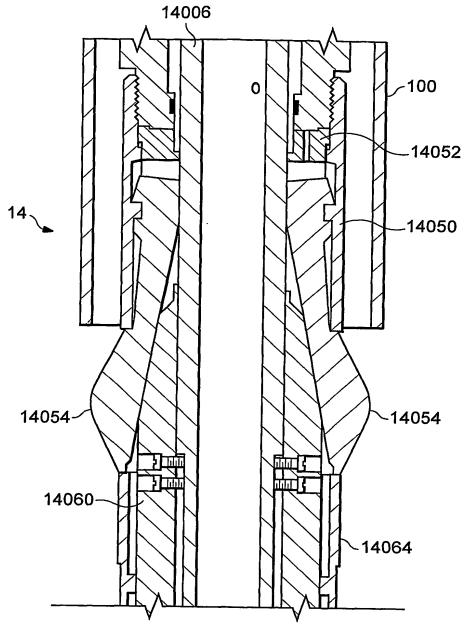


Fig. 11Z3

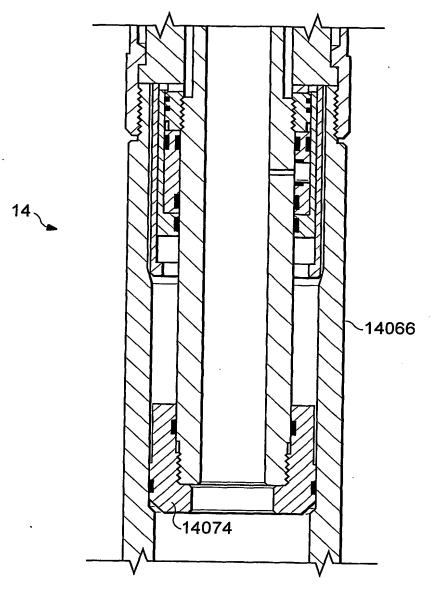


Fig. 11Z4

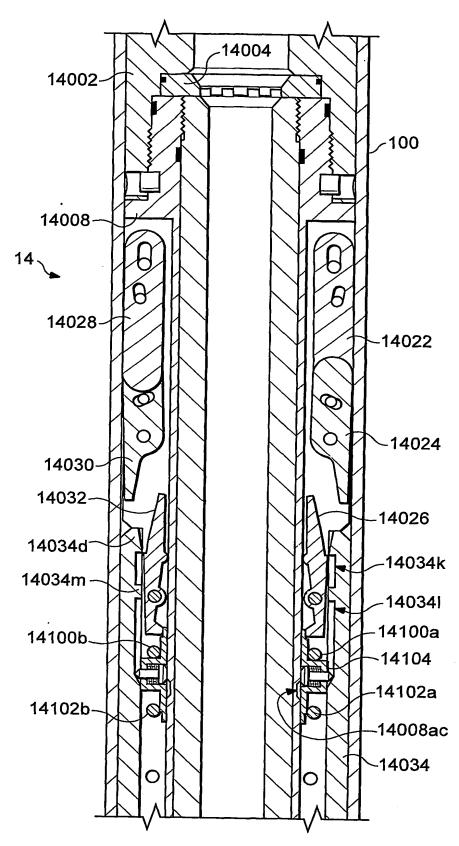


Fig. 11AA1

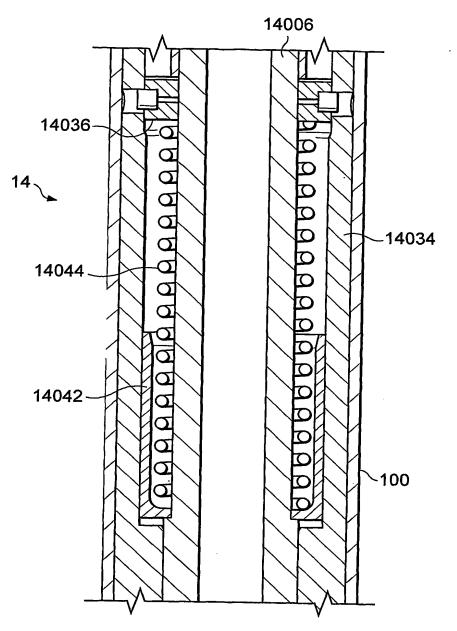


Fig. 11AA2

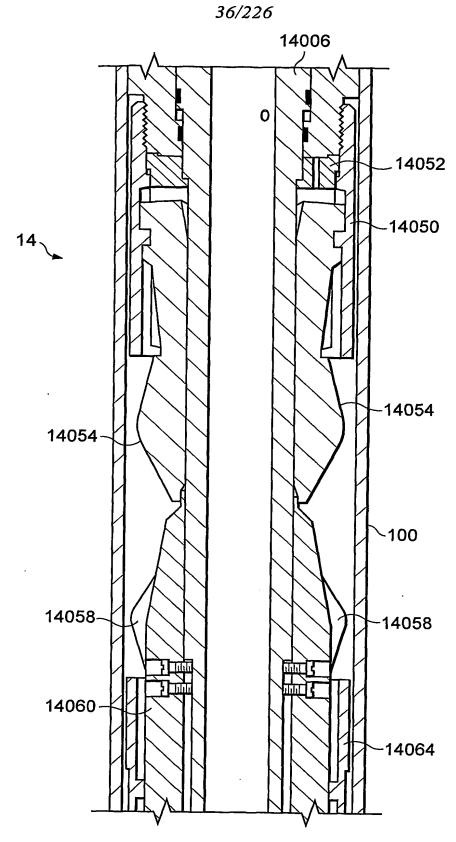


Fig. 11AA3

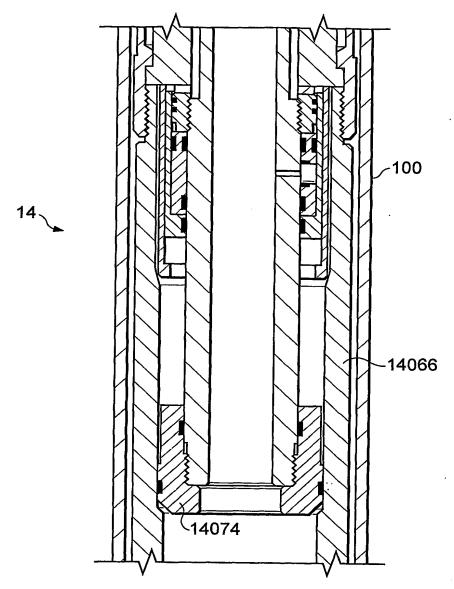


Fig. 11AA4

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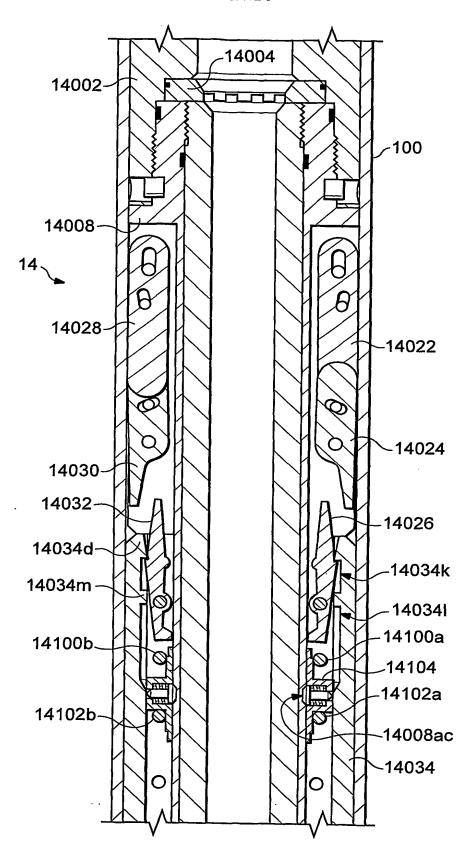


Fig. 11AB1

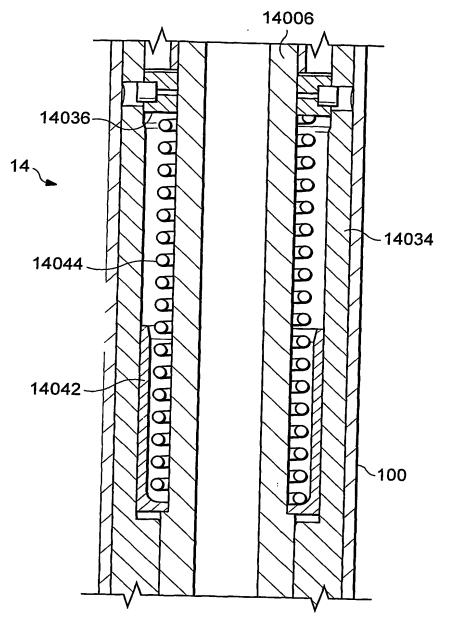


Fig. 11AB2

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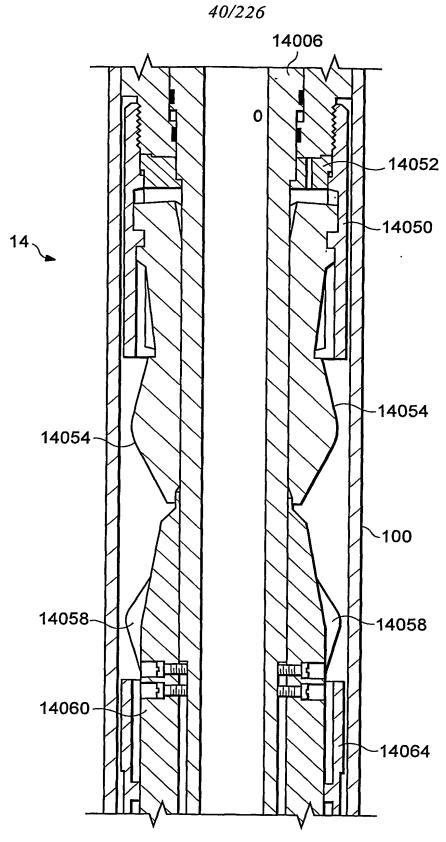


Fig. 11AB3

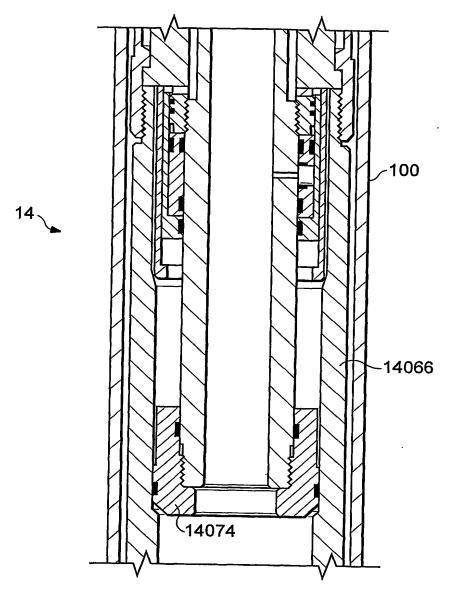
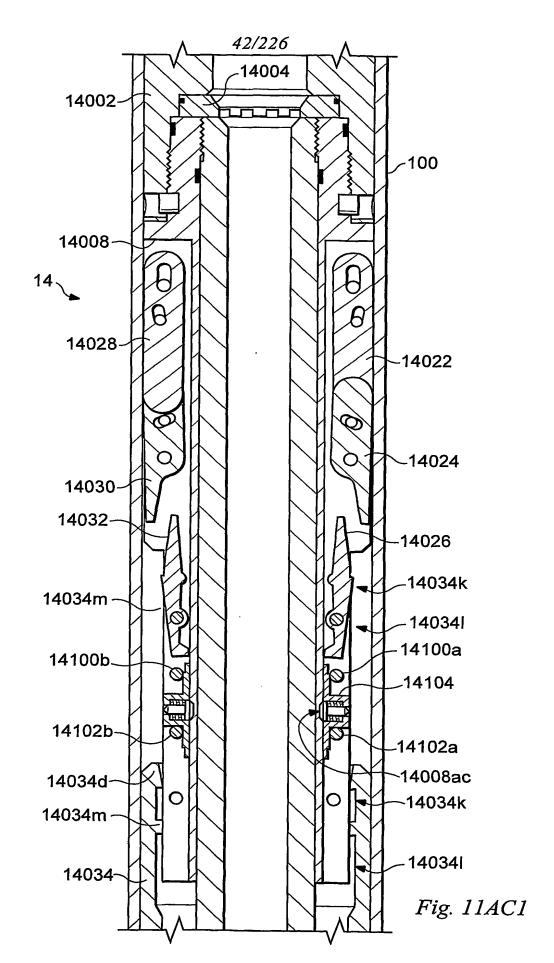


Fig. 11AB4



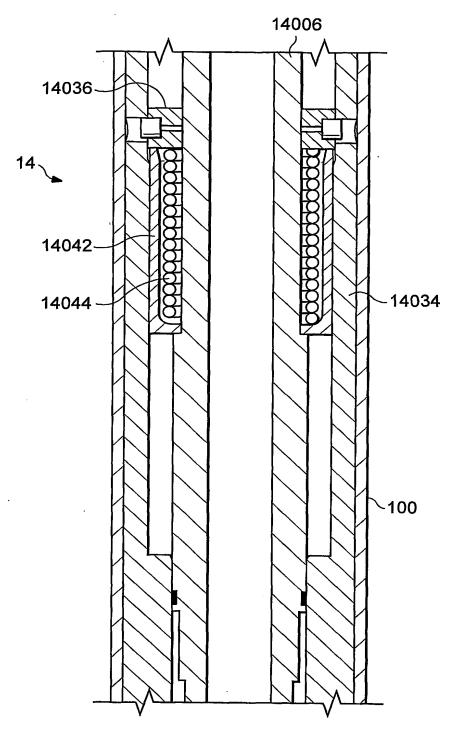


Fig. 11AC2

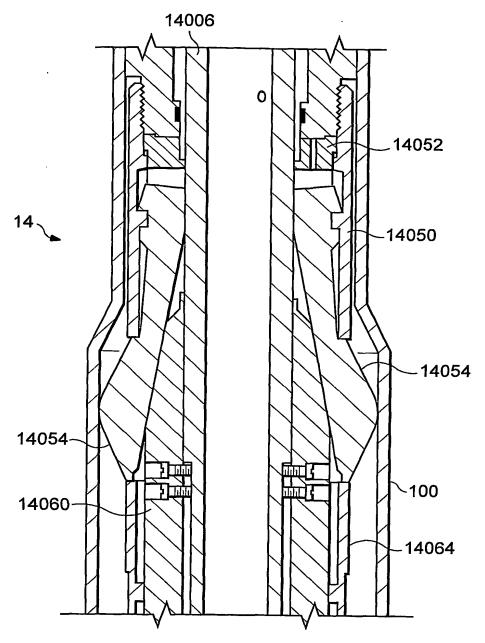


Fig. 11AC3

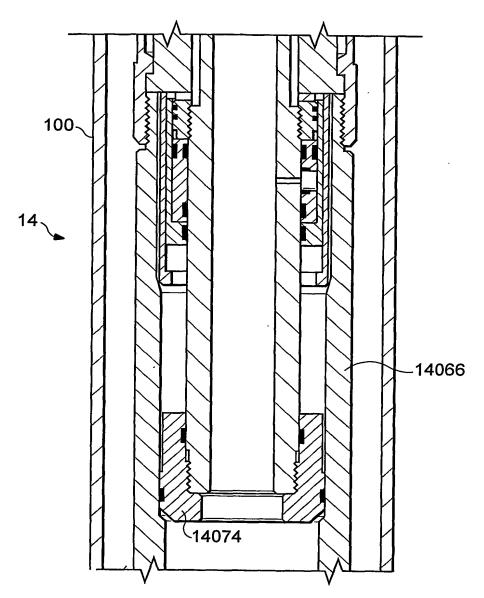


Fig. 11AC4

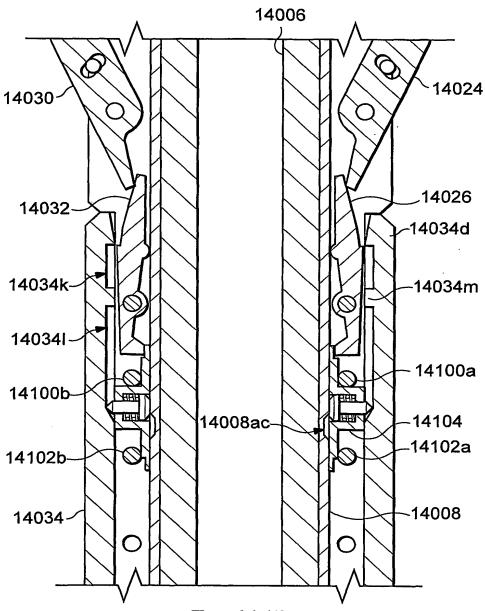


Fig. 11AD

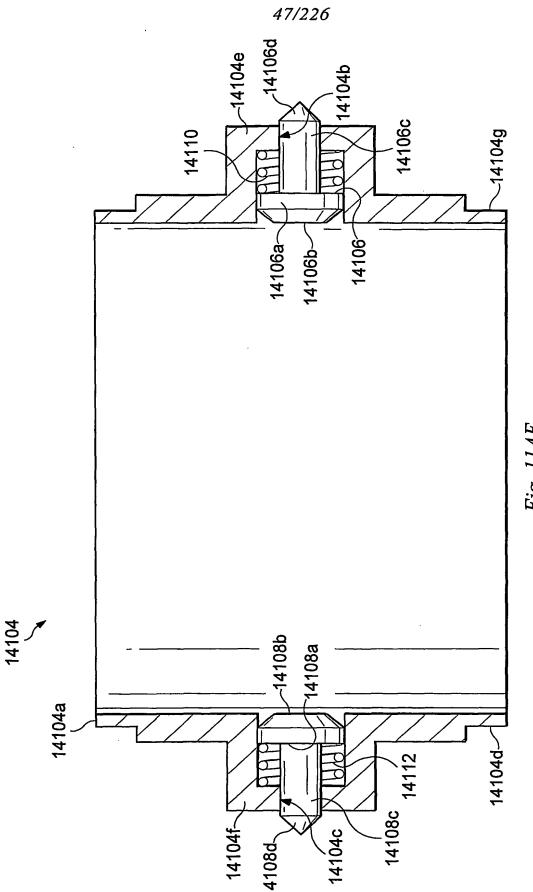


Fig. 11AE

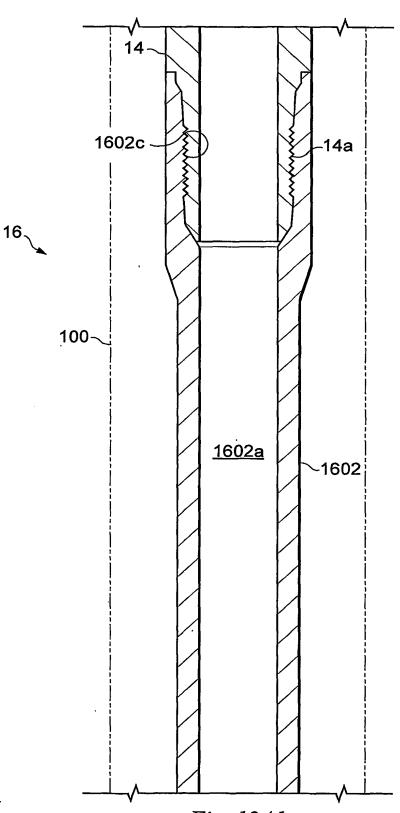


Fig. 12A1

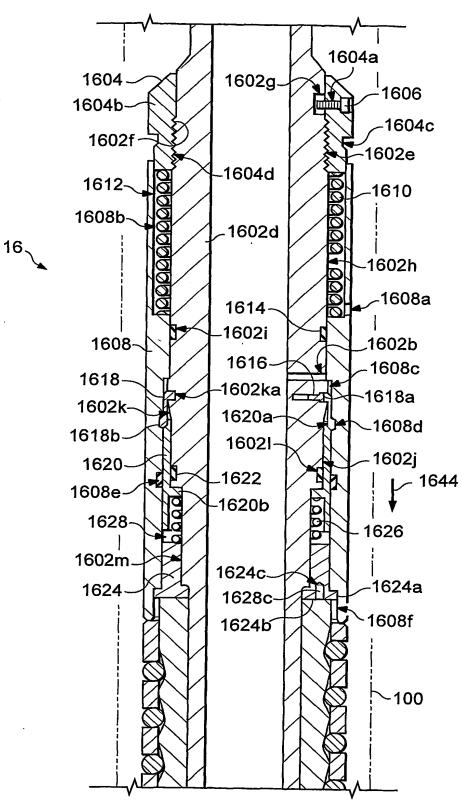


Fig. 12A2

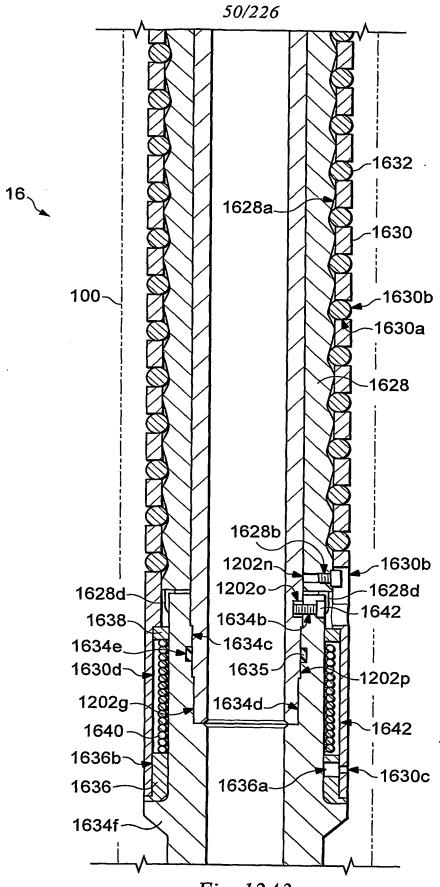


Fig. 12A3



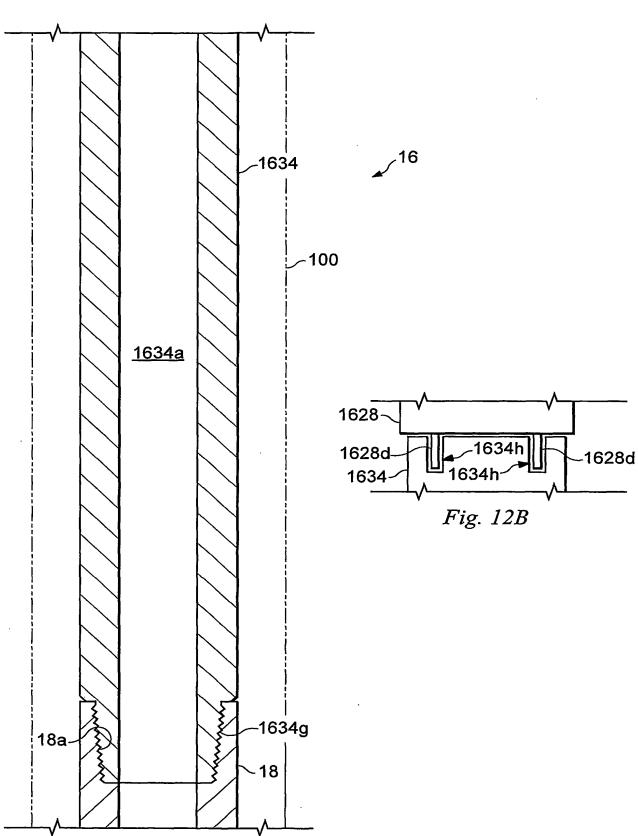


Fig. 12A4

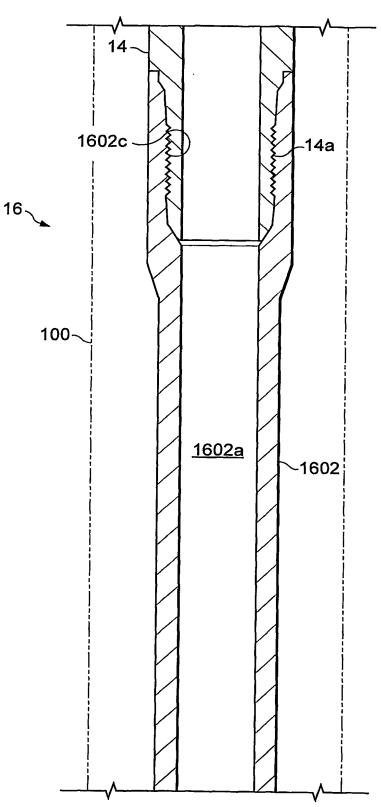


Fig. 12C1

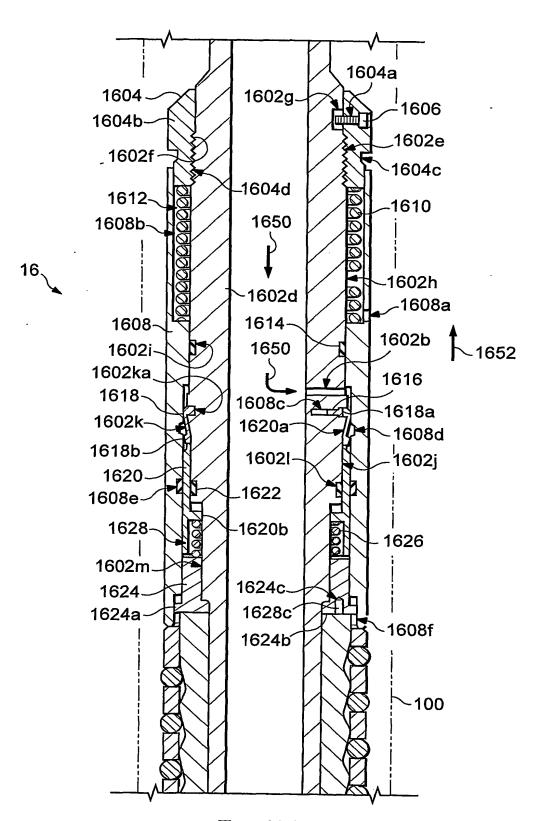


Fig. 12C2

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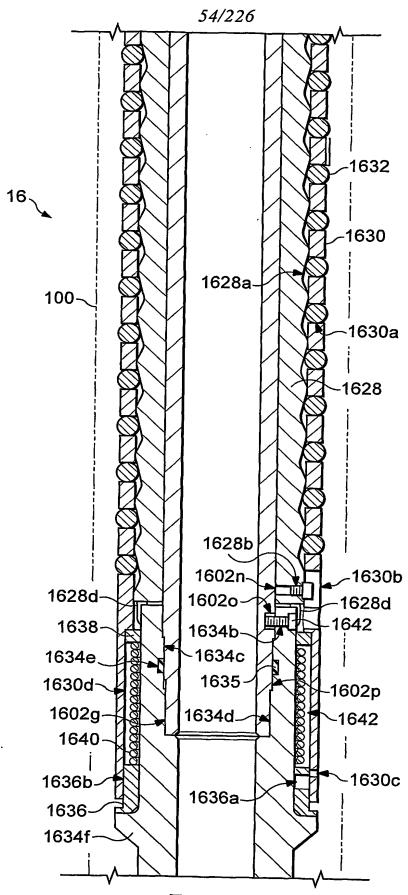
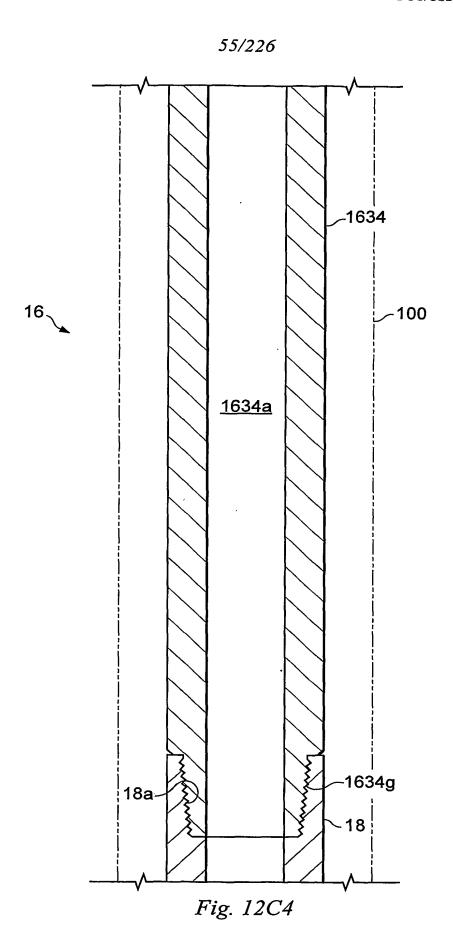


Fig. 12C3



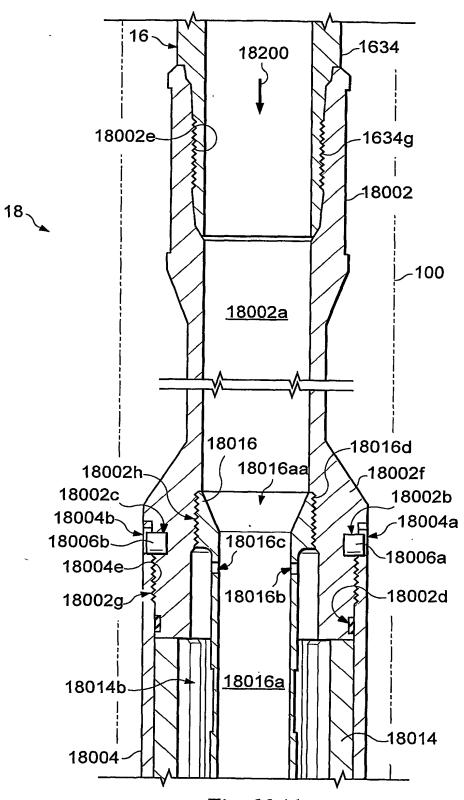
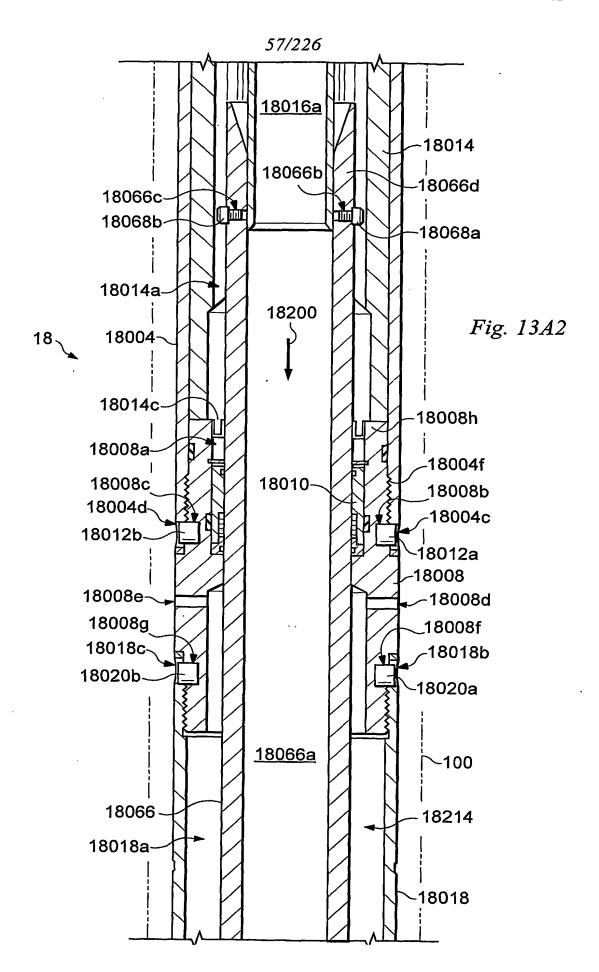


Fig. 13A1

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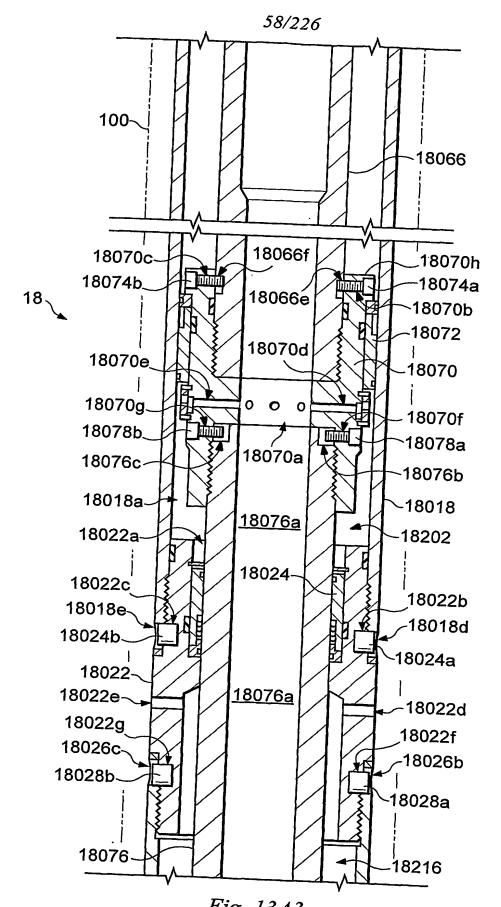


Fig. 13A3

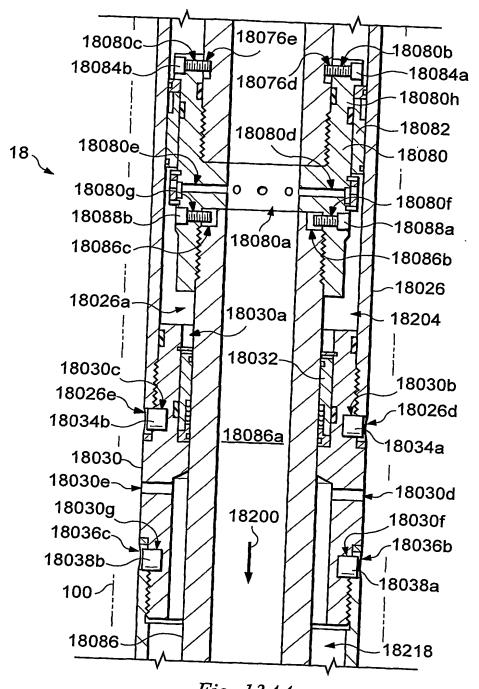


Fig. 13A4

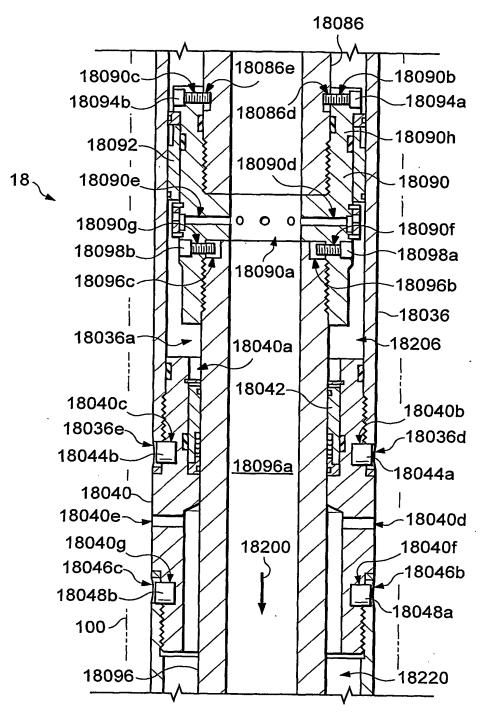
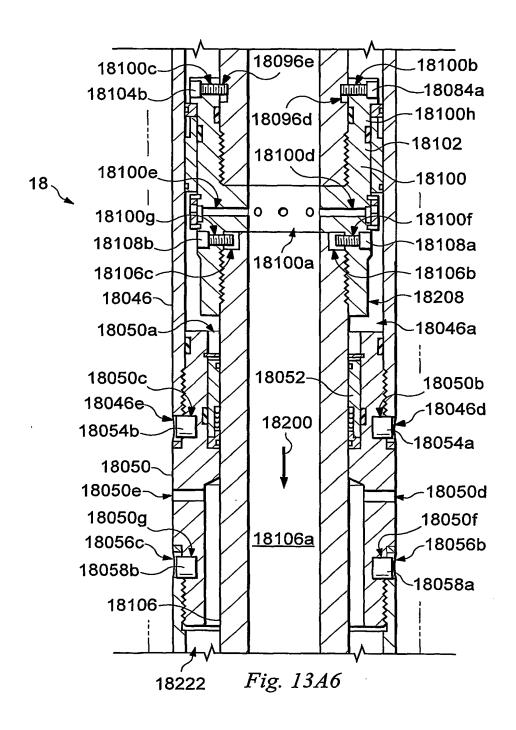
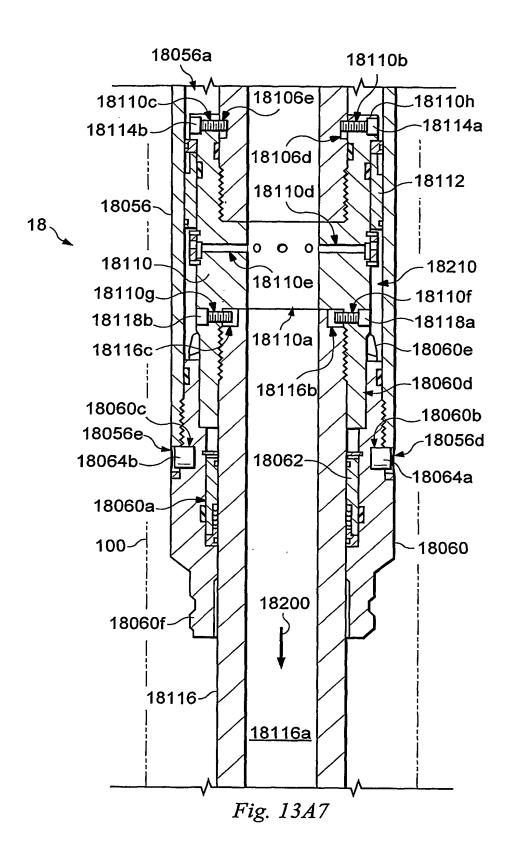
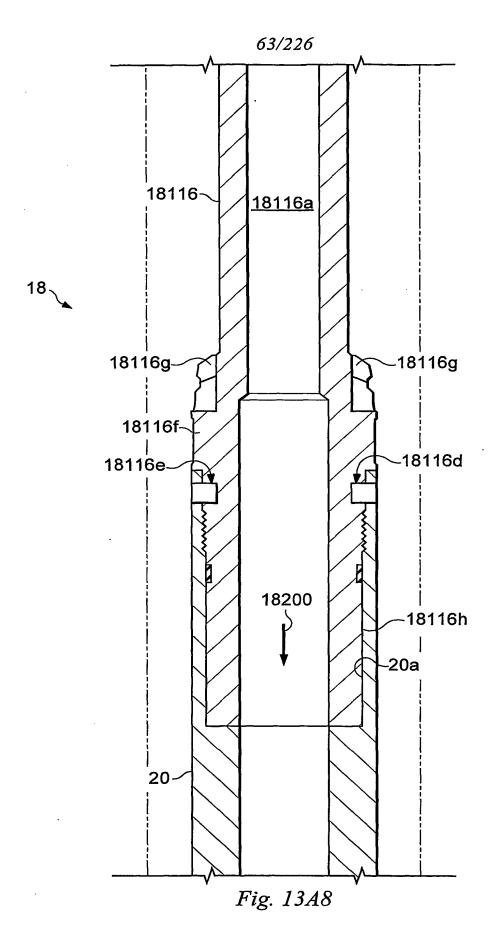


Fig. 13A5







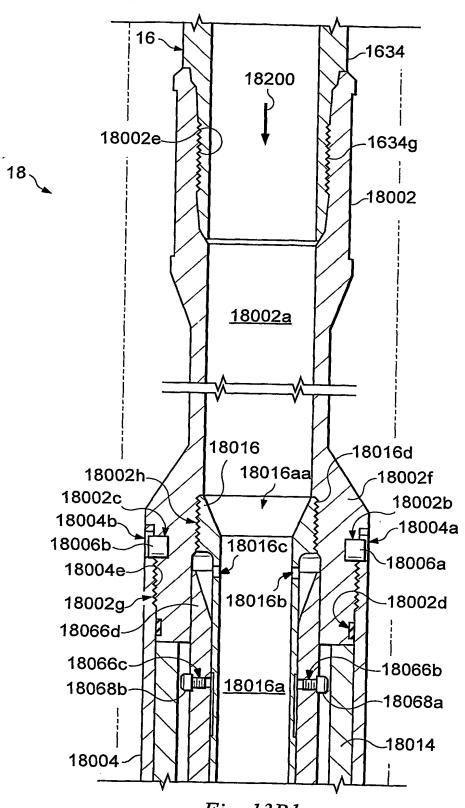
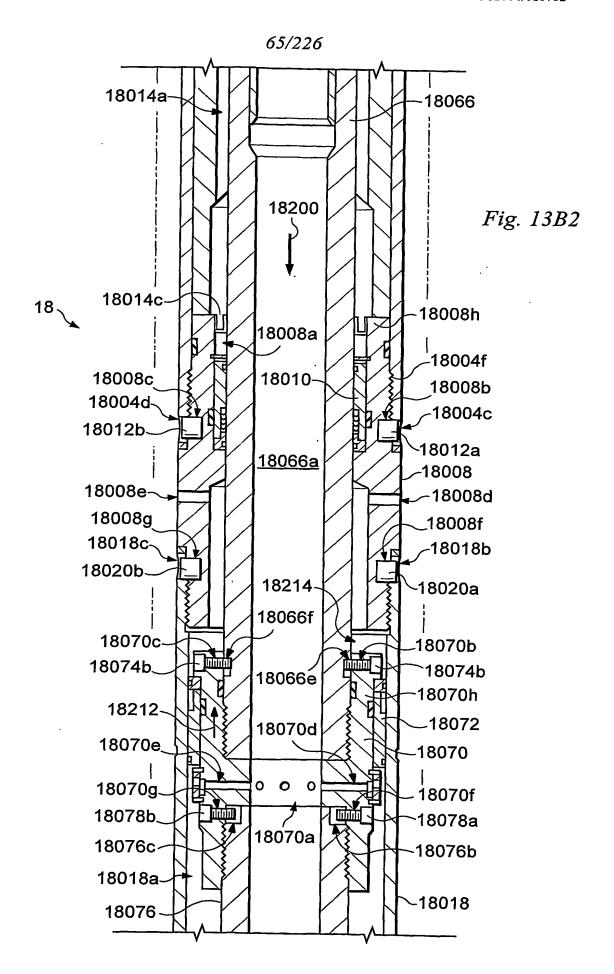


Fig. 13B1

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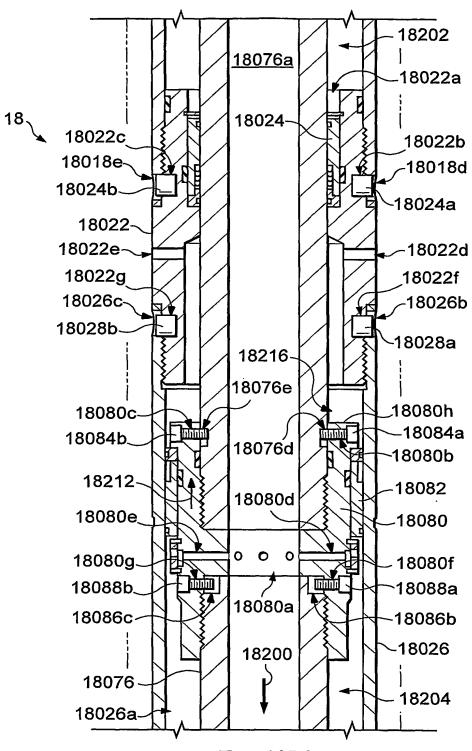


Fig. 13B3

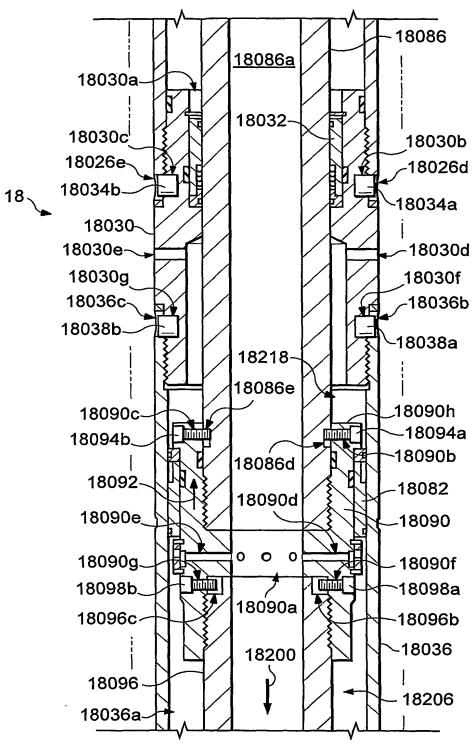


Fig. 13B4

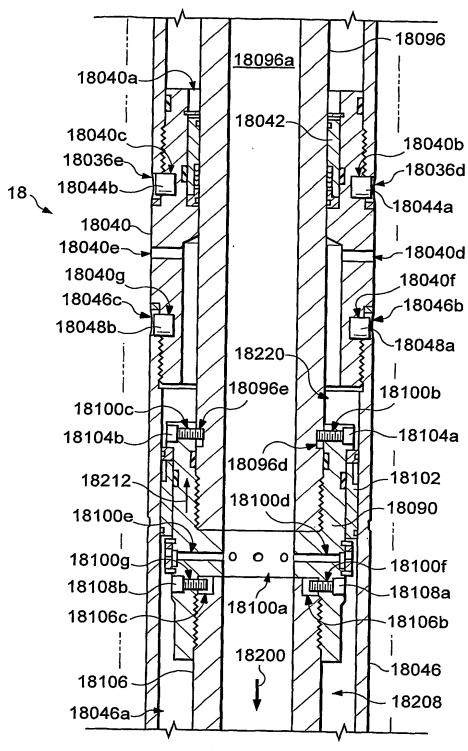
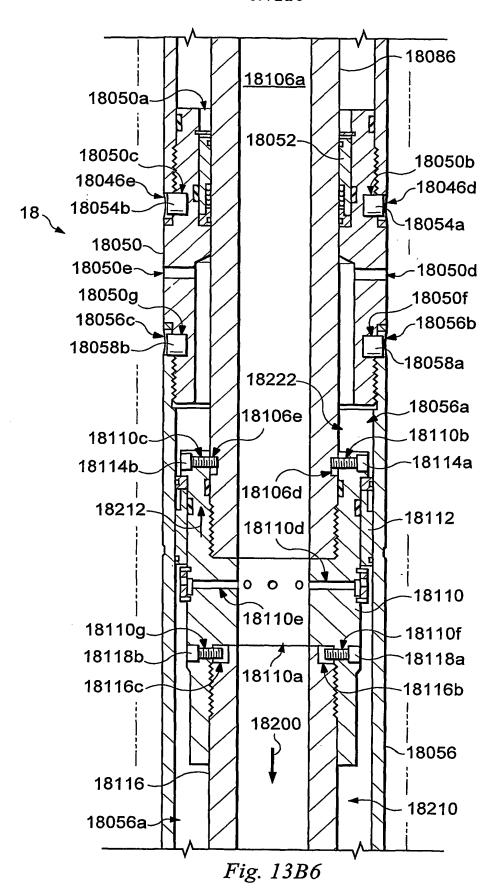
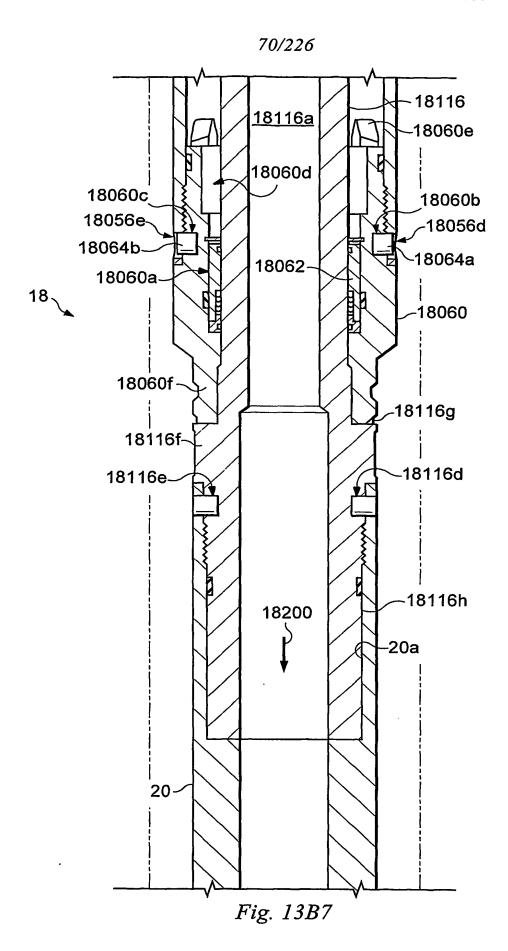
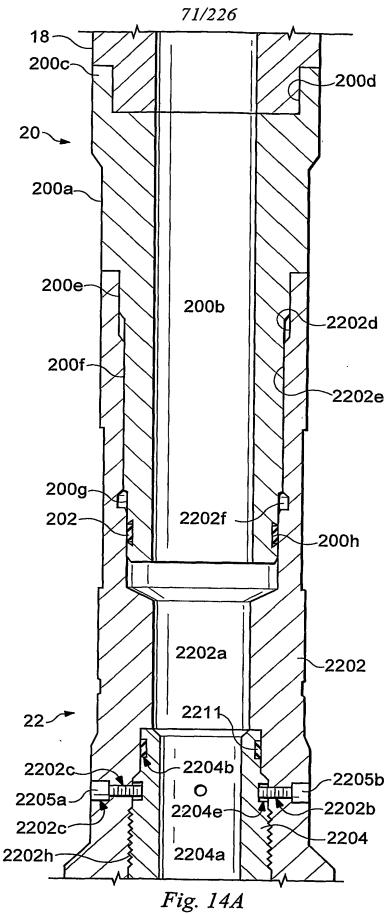


Fig. 13B5

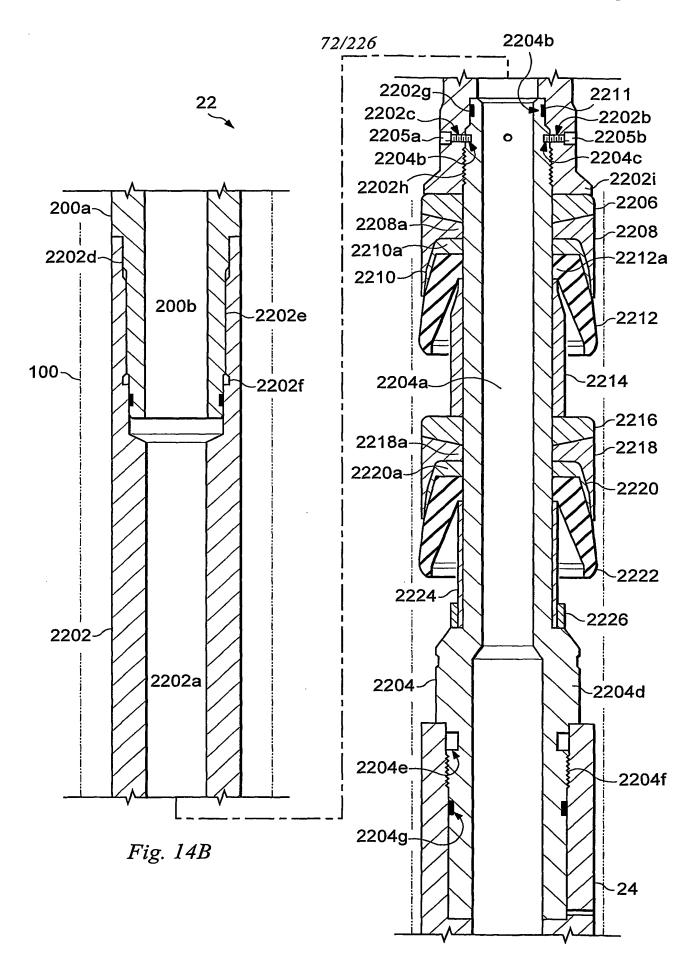
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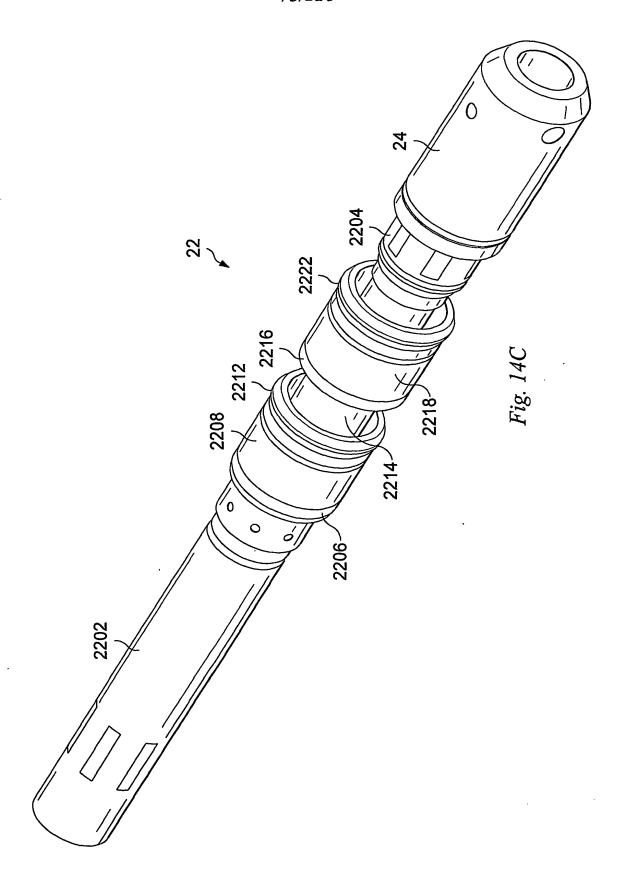


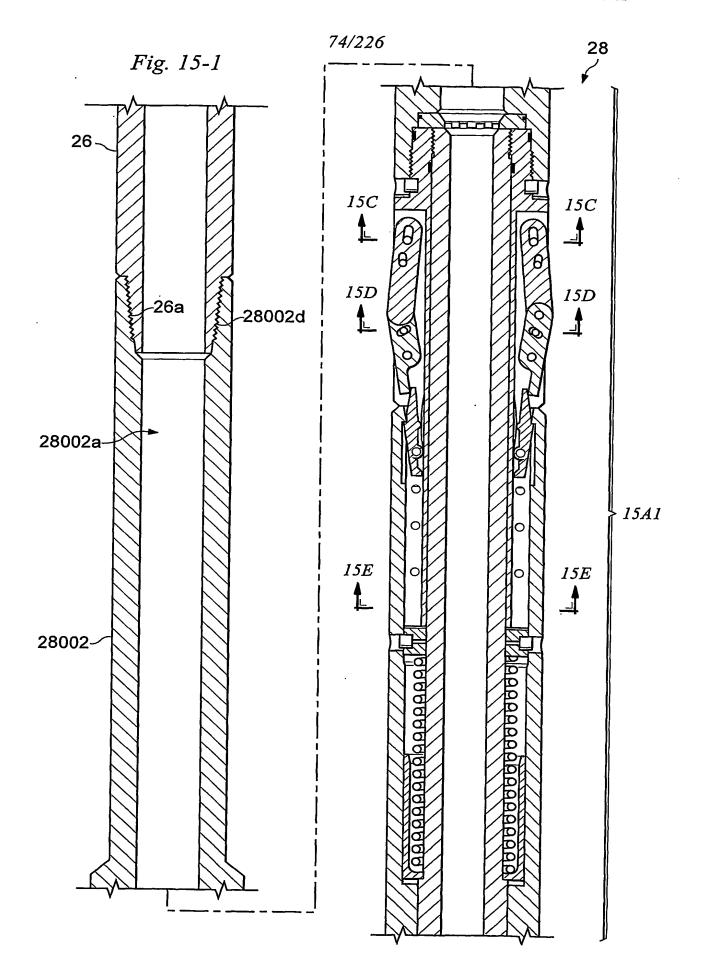


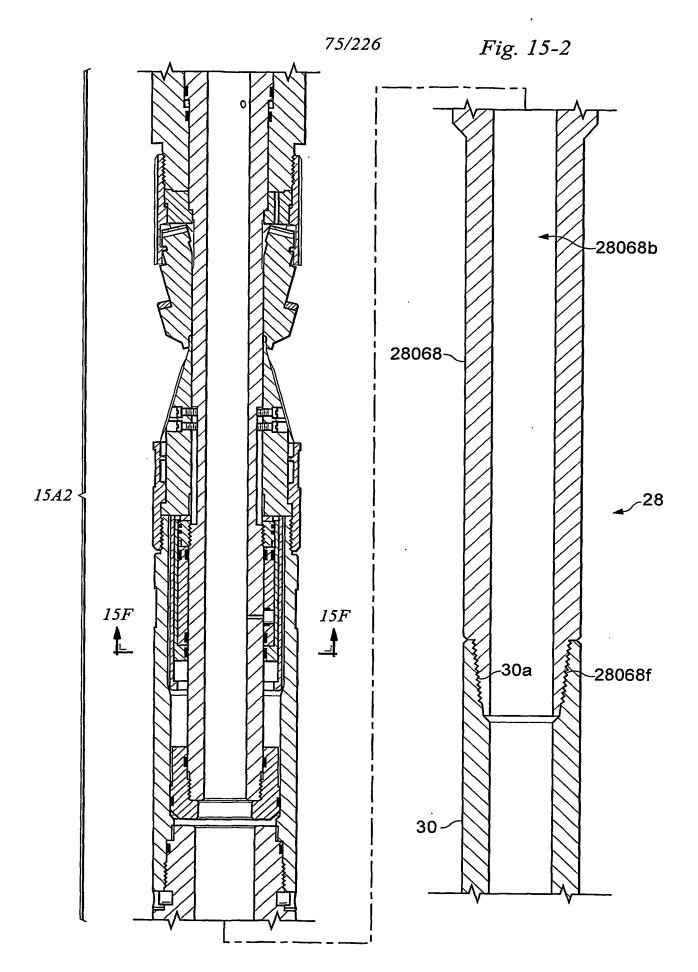
WO 2004/092528

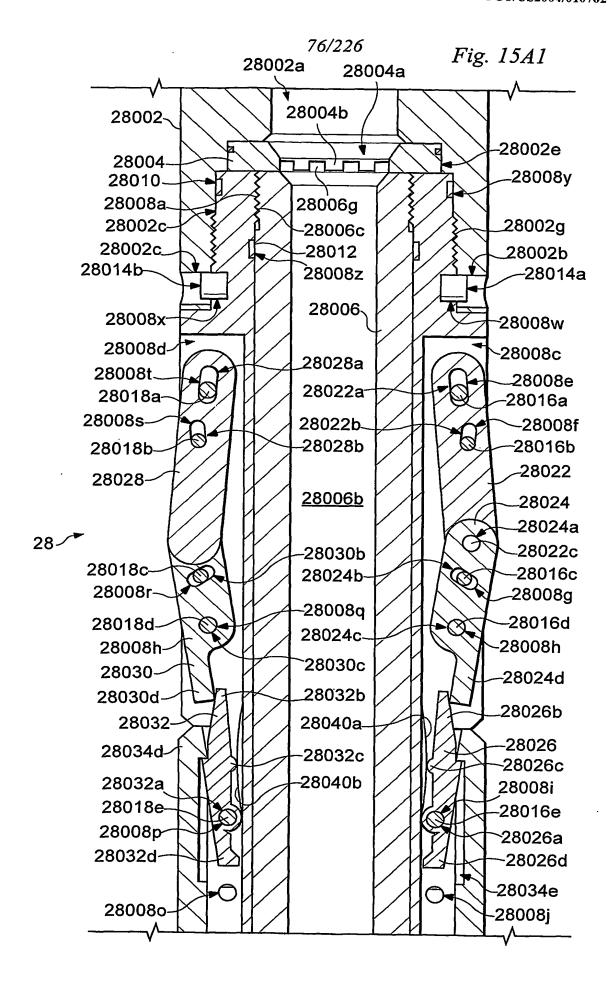


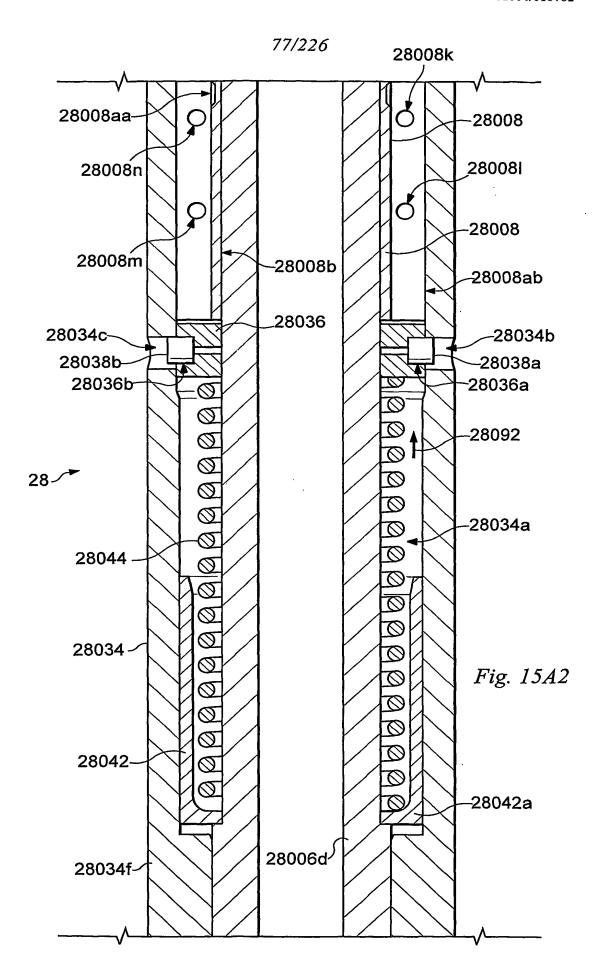
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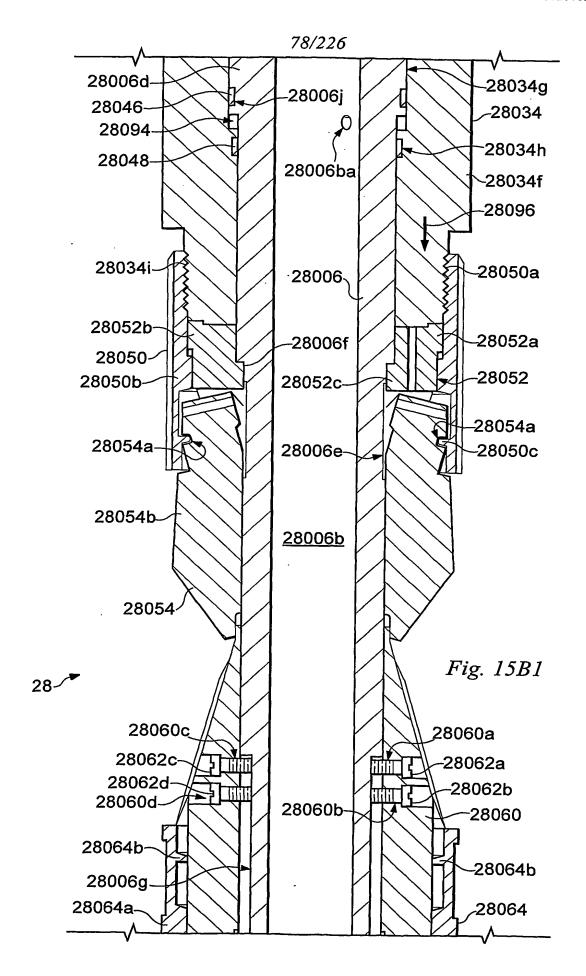


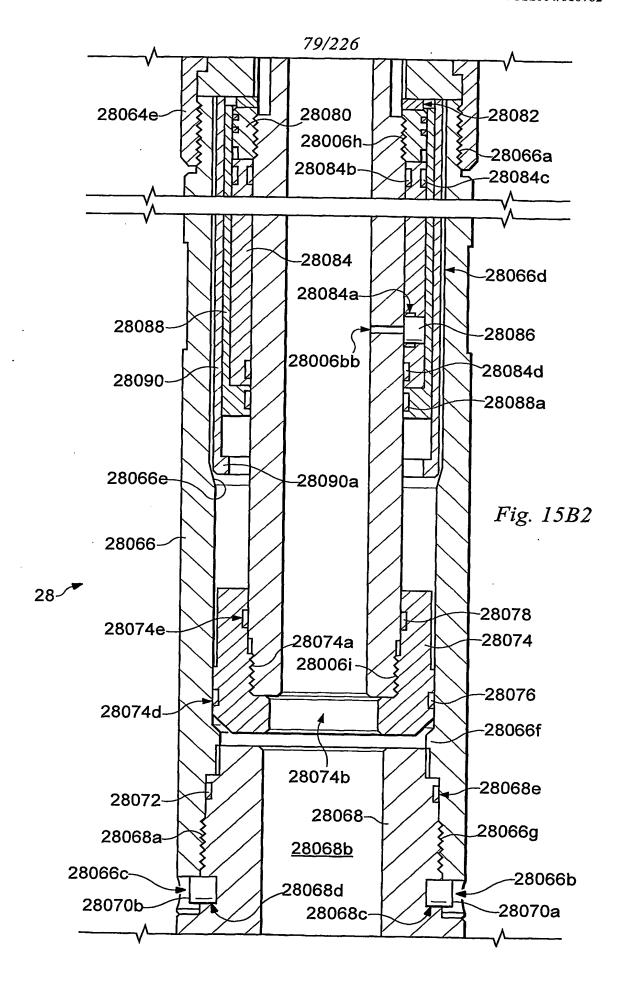




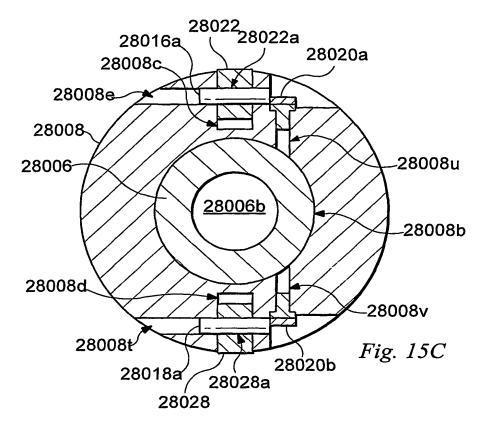


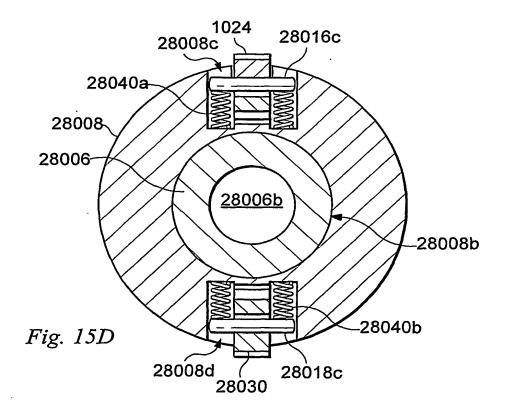






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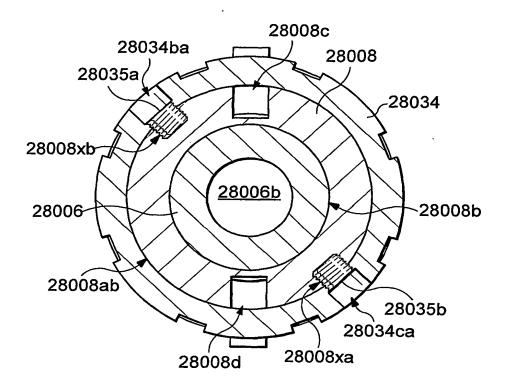


Fig. 15E

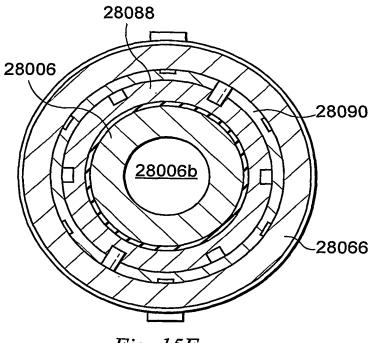
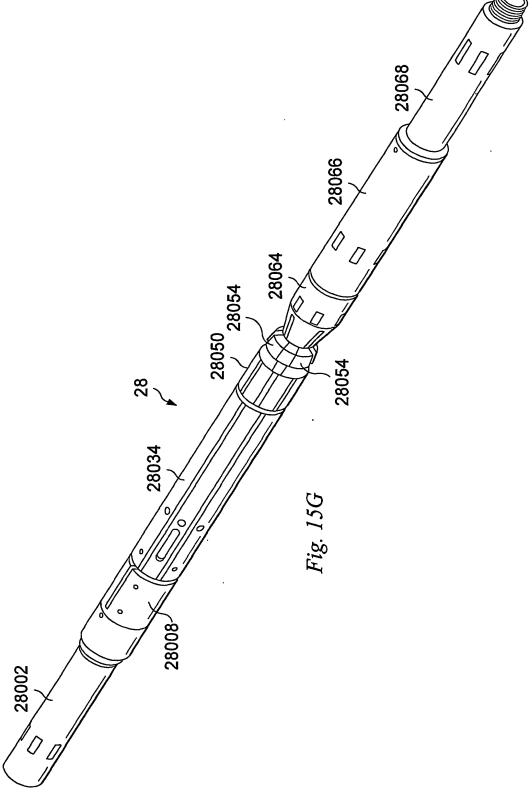


Fig. 15F





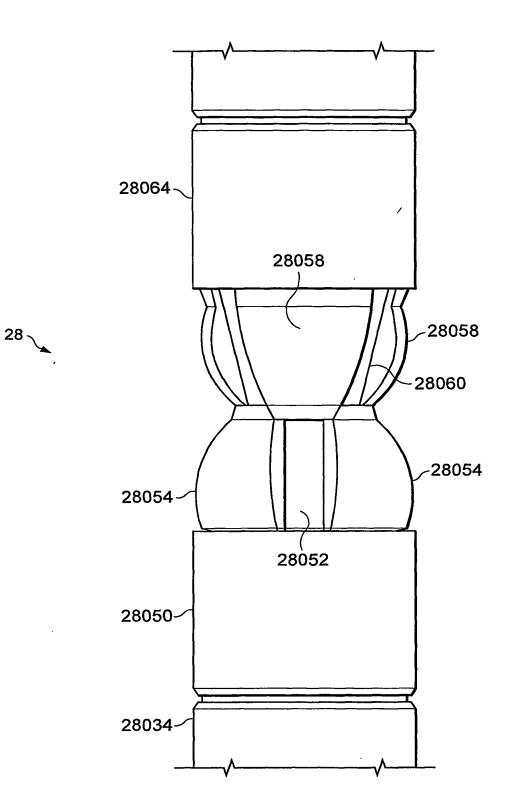


Fig. 15H

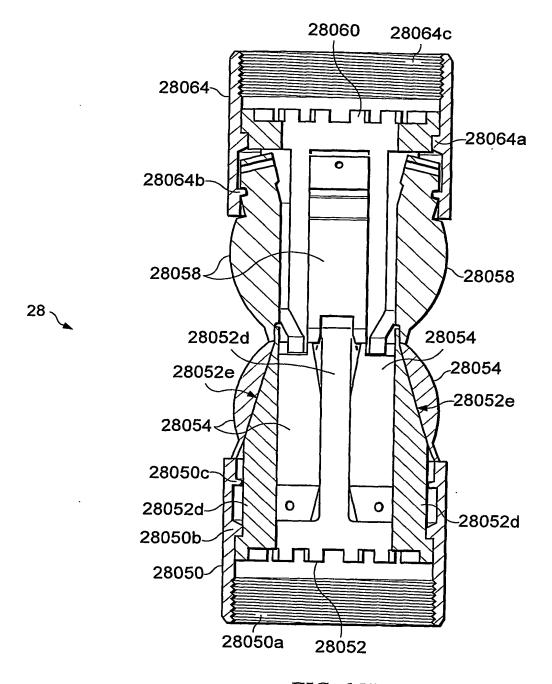
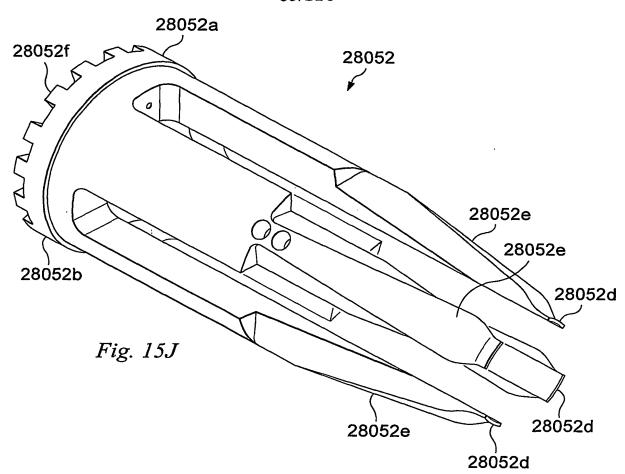
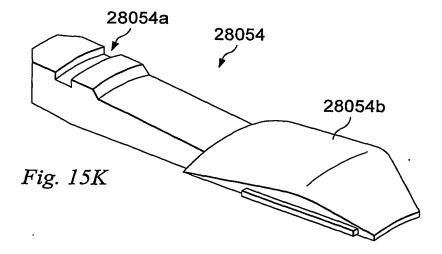
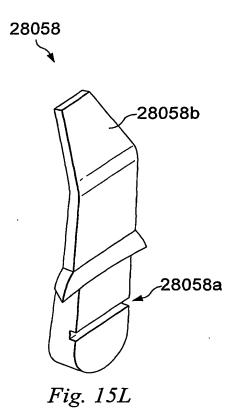


FIG. 15I









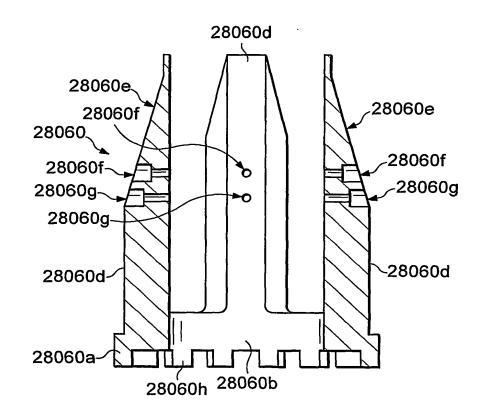
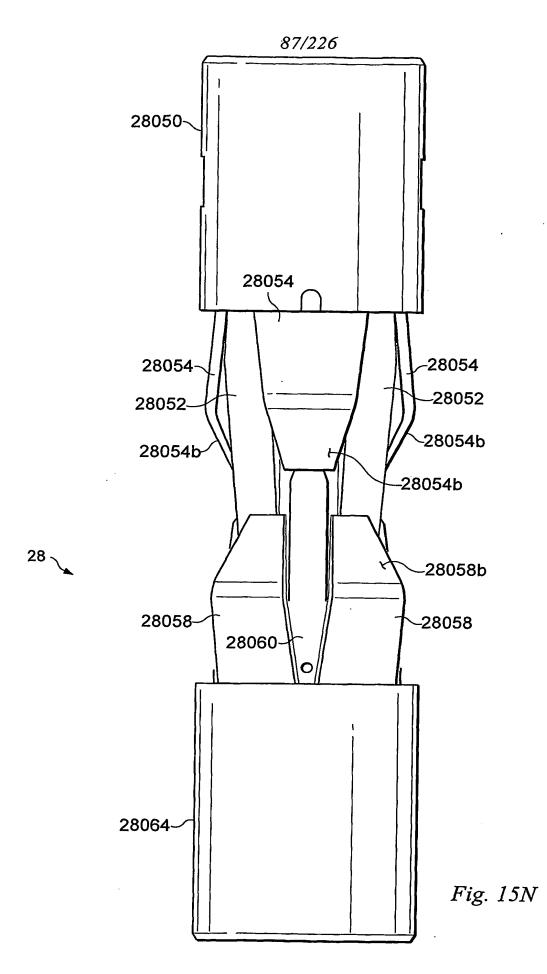


Fig. 15M



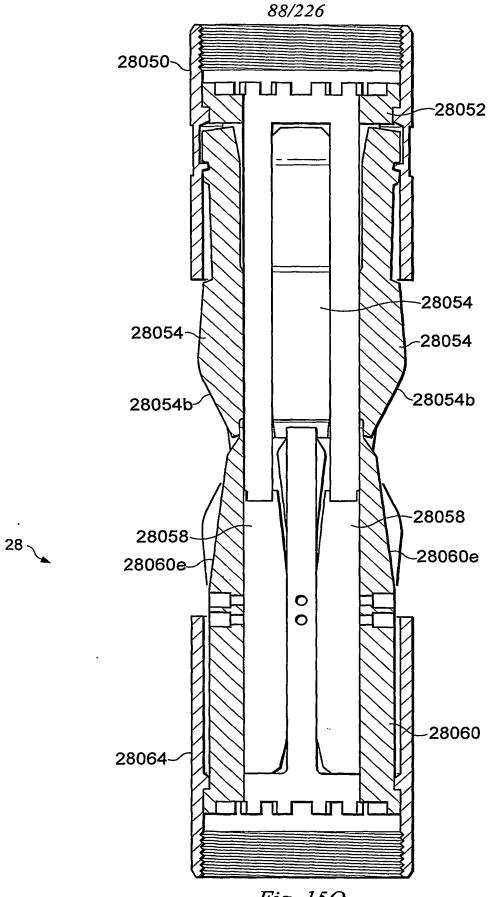
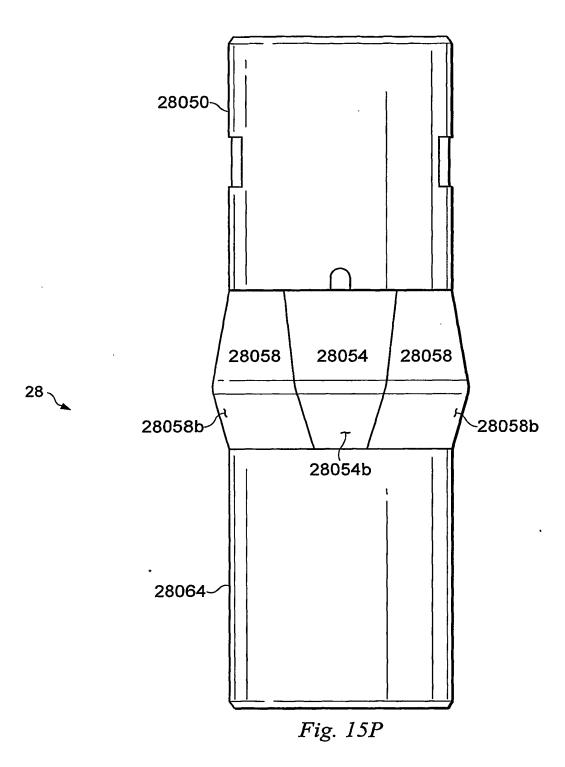
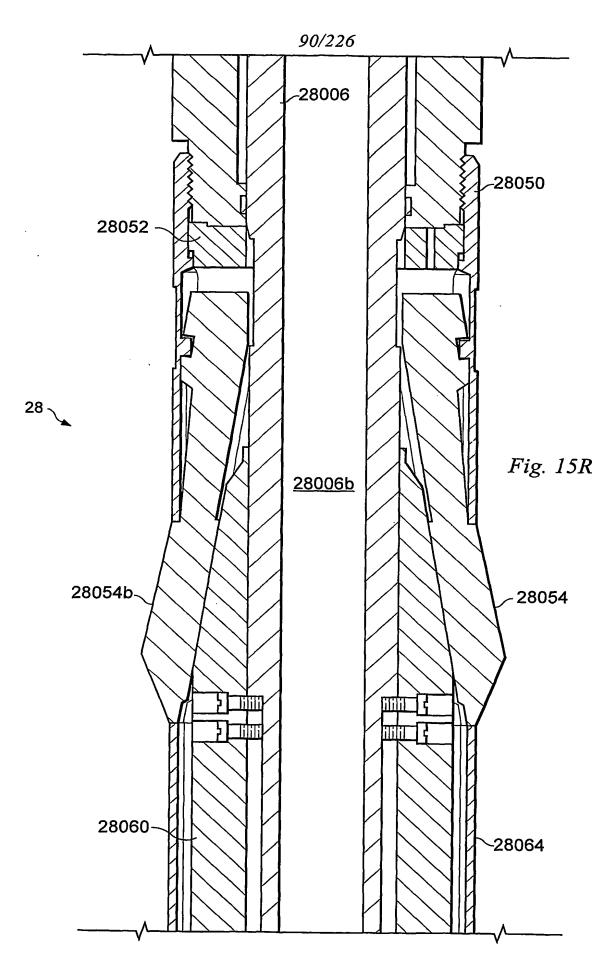


Fig. 150





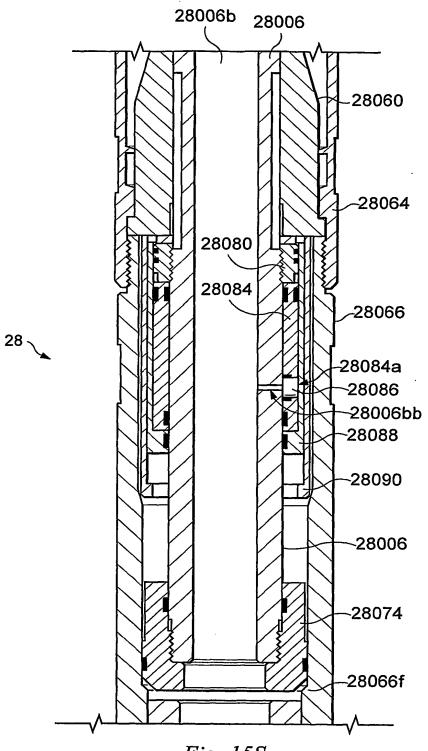


Fig. 15S

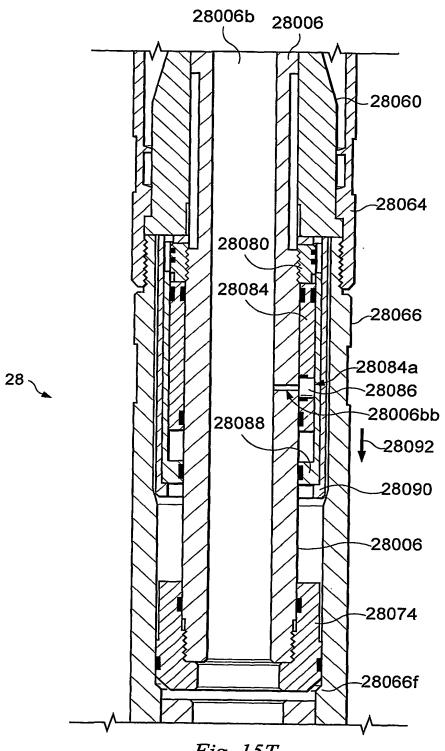


Fig. 15T

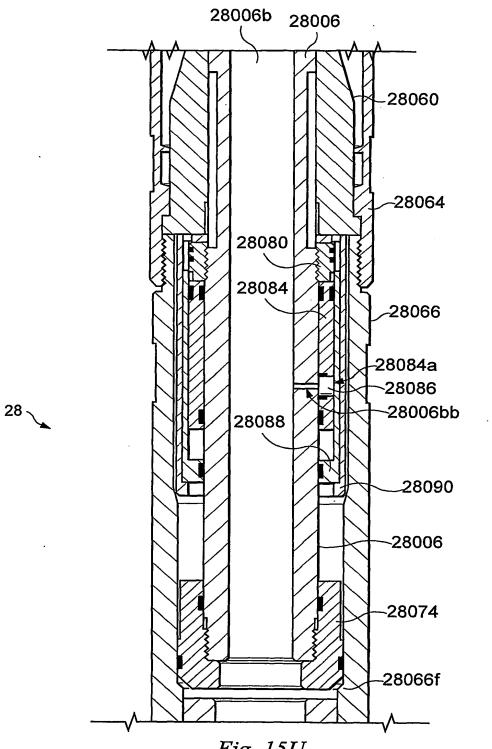
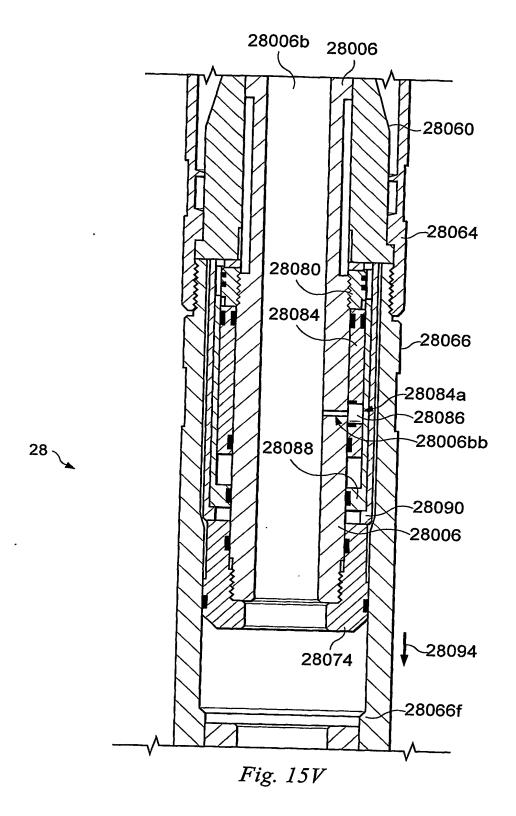
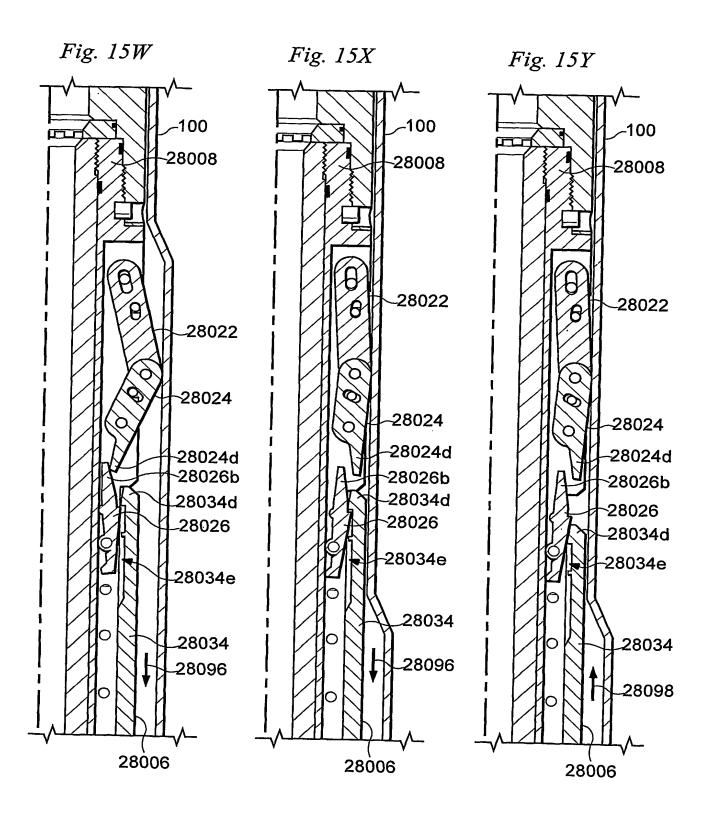
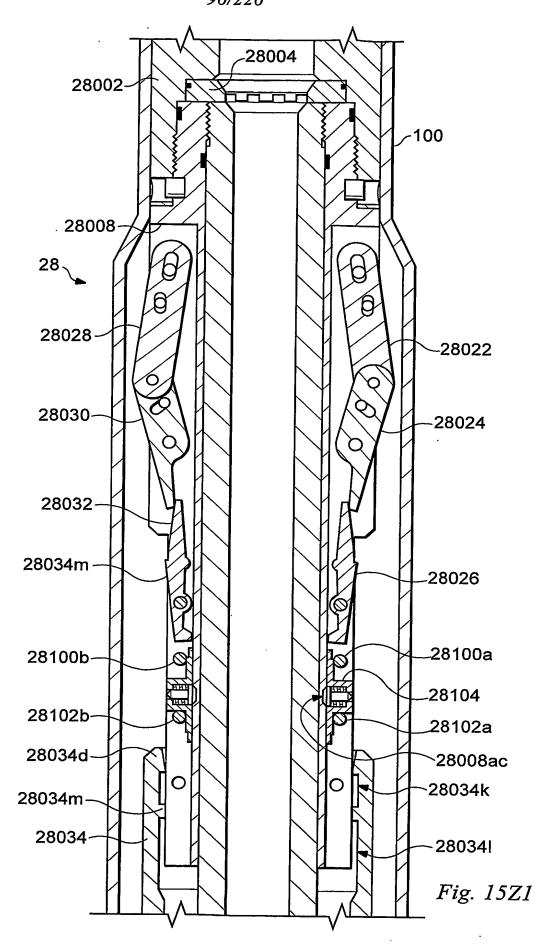


Fig. 15U







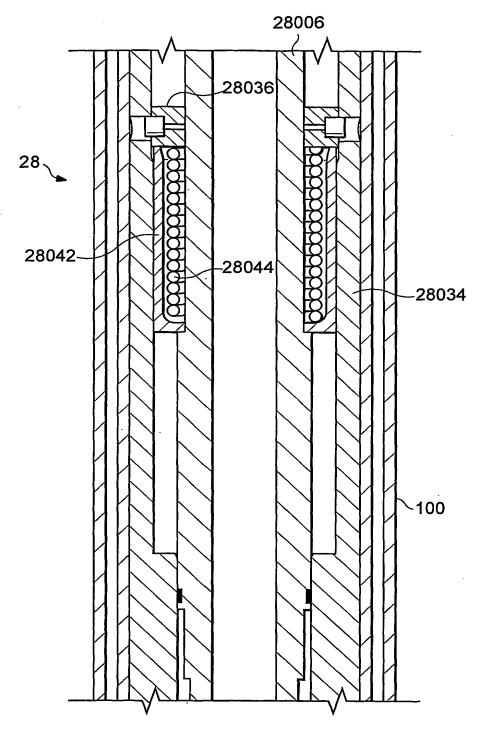


Fig. 15Z2

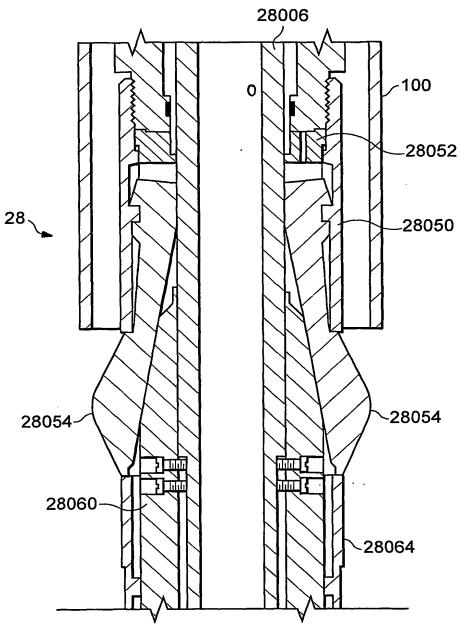


Fig. 15Z3

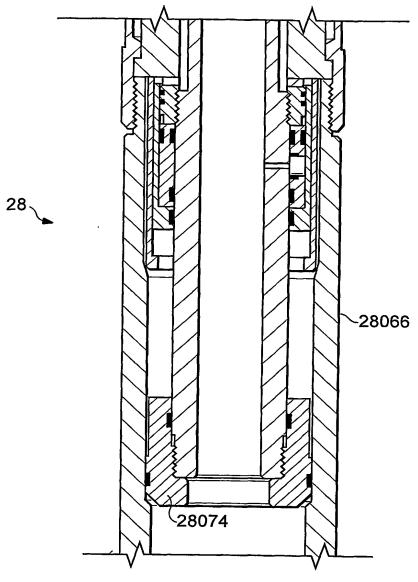


Fig. 15Z4

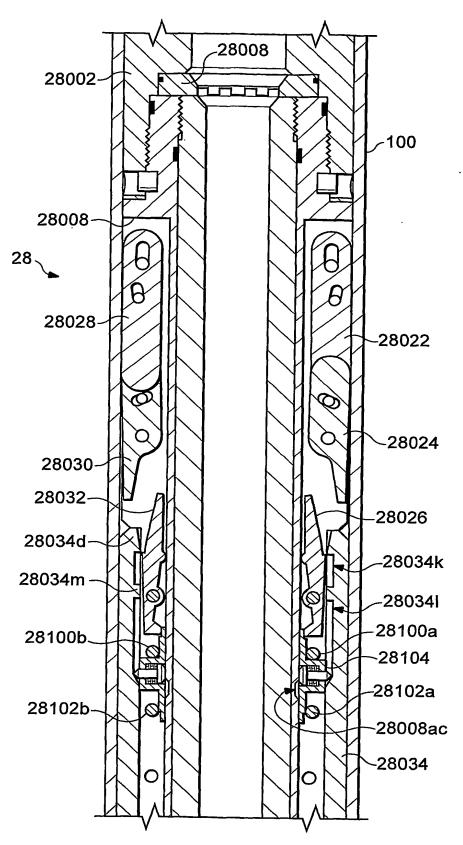


Fig. 15AA1

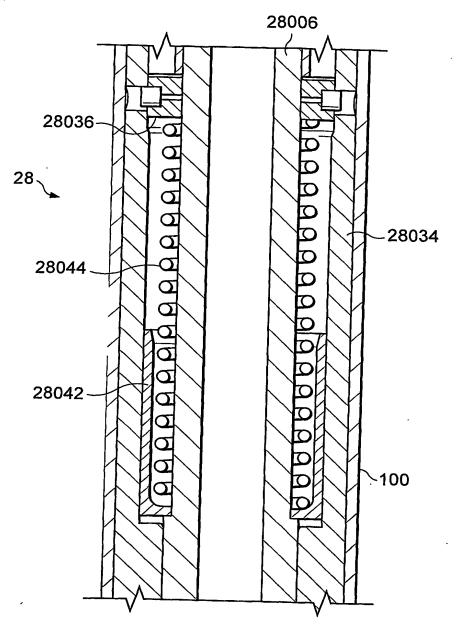


Fig. 15AA2

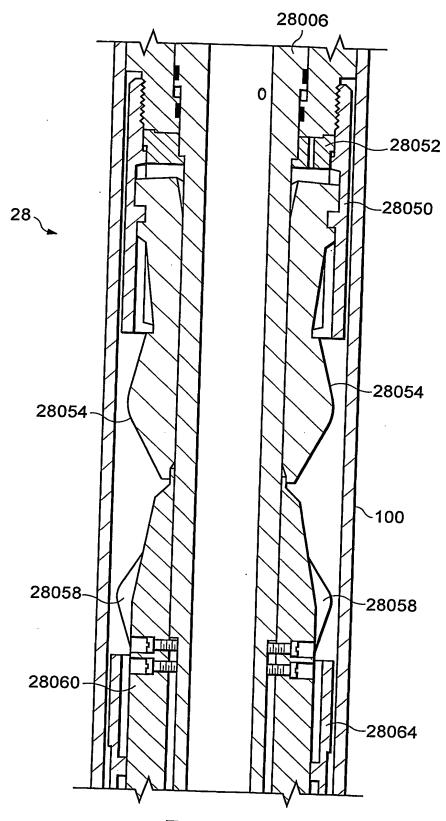


Fig. 15AA3

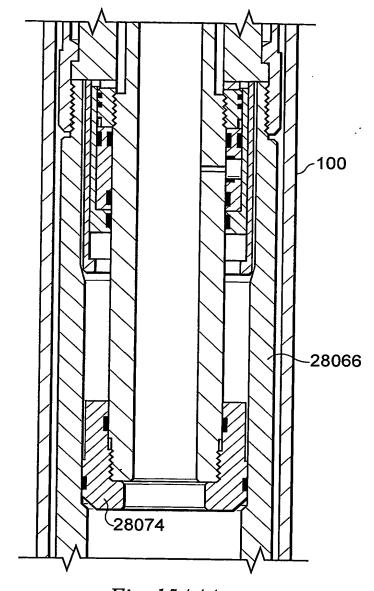


Fig. 15AA4

28 <

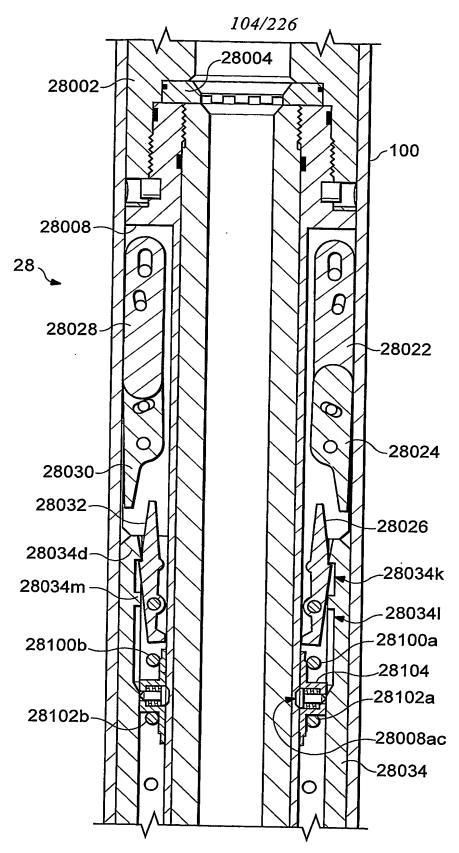


Fig. 15AB1

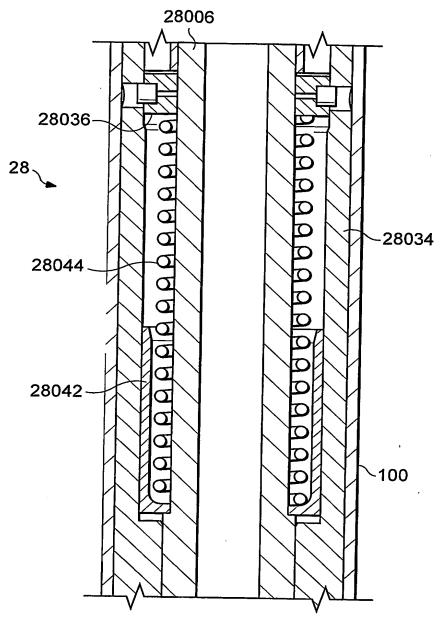


Fig. 15AB2

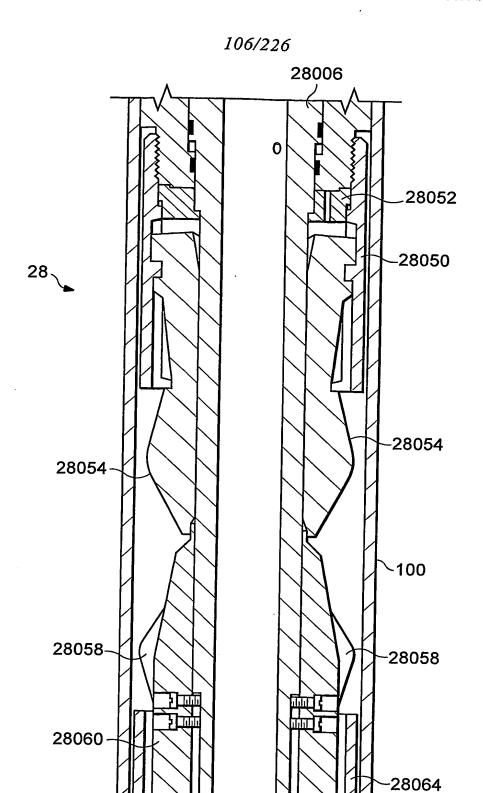


Fig. 15AB3

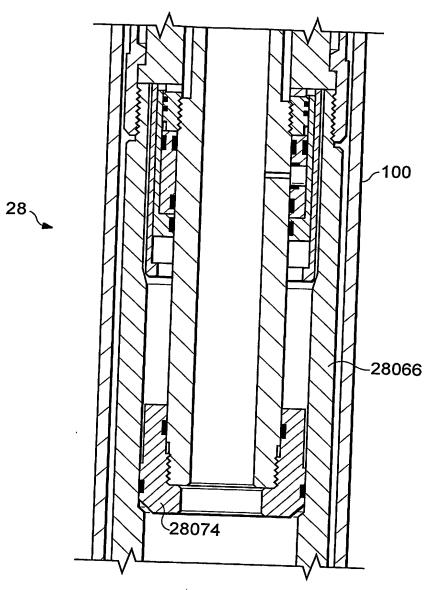
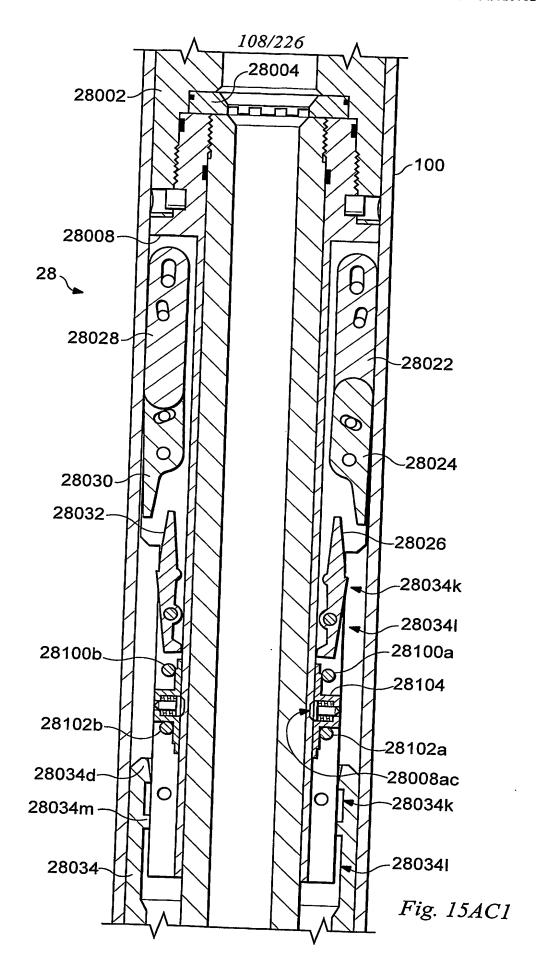


Fig. 15AB4



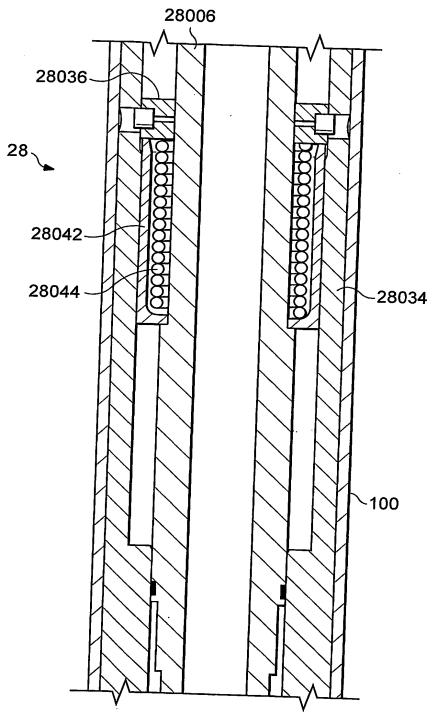


Fig. 15AC2

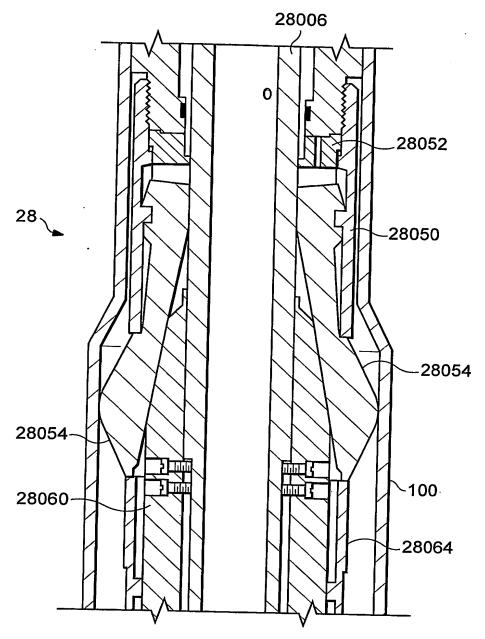


Fig. 15AC3

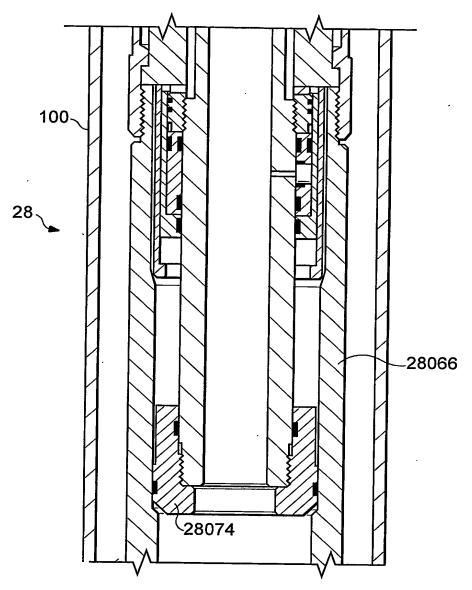


Fig. 15AC4

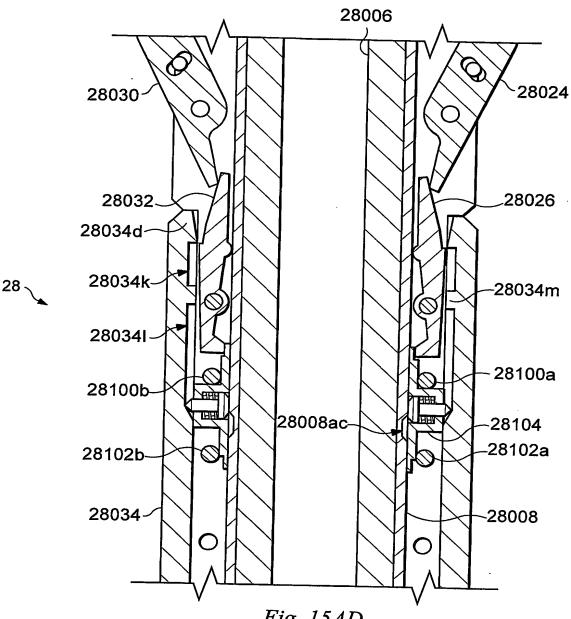
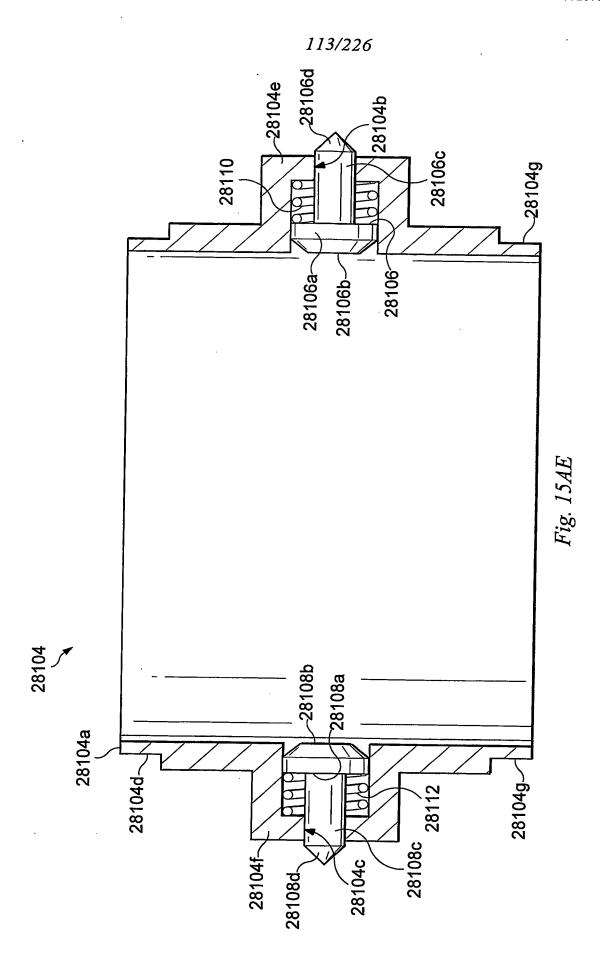
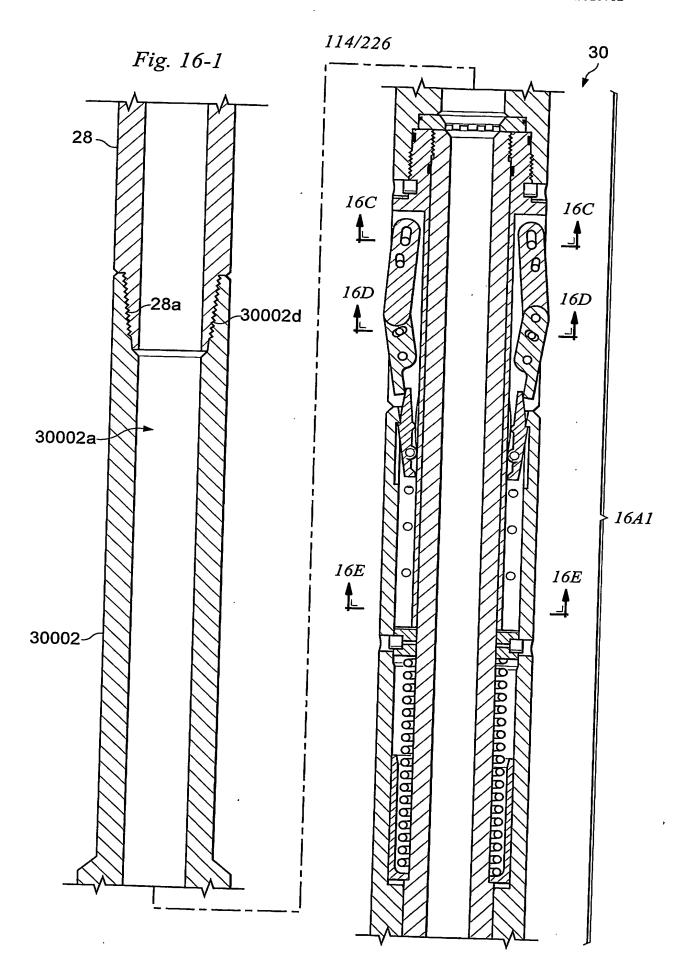
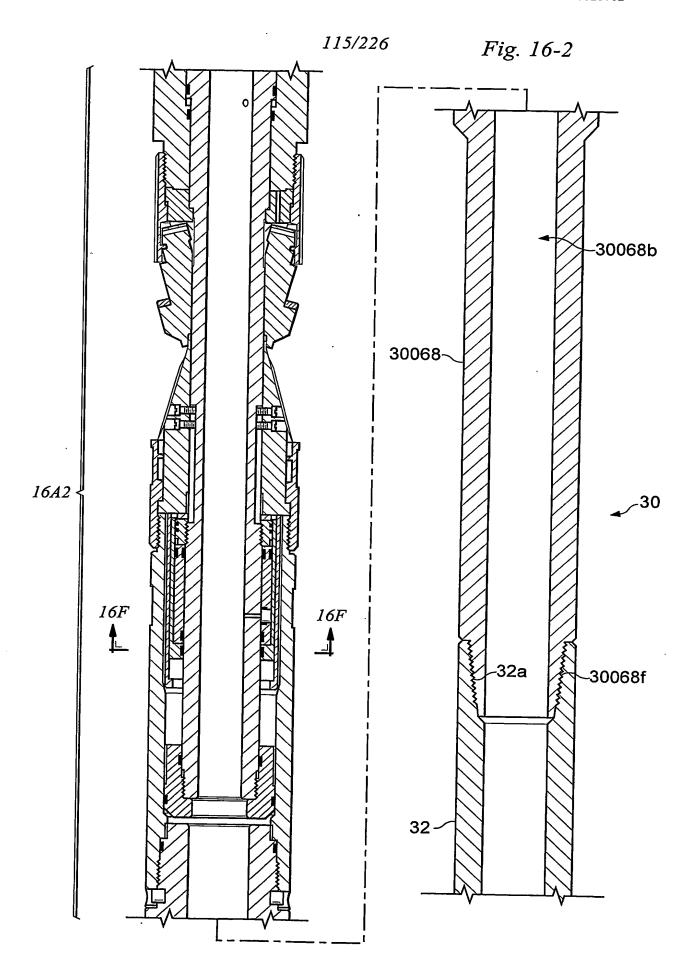


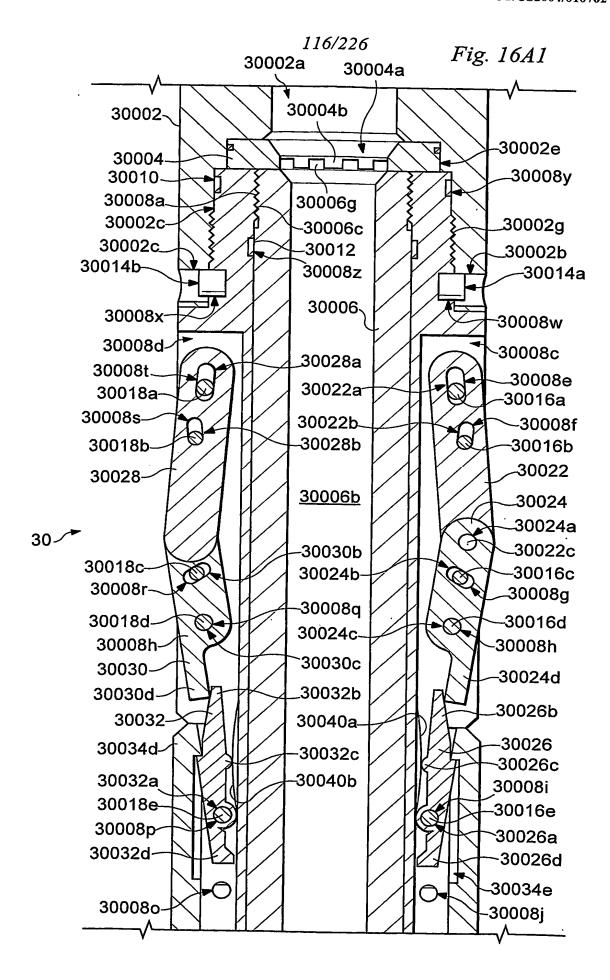
Fig. 15AD

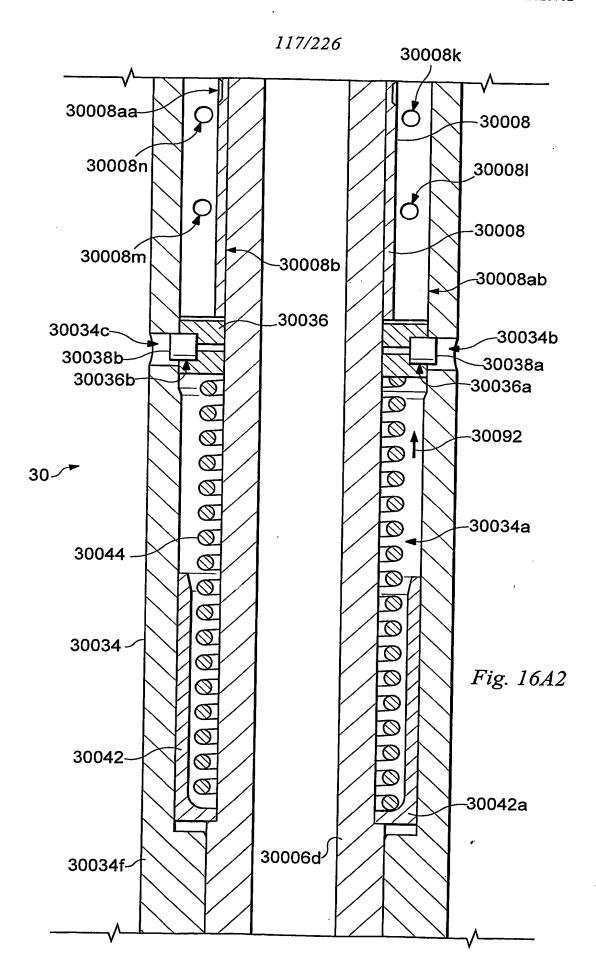




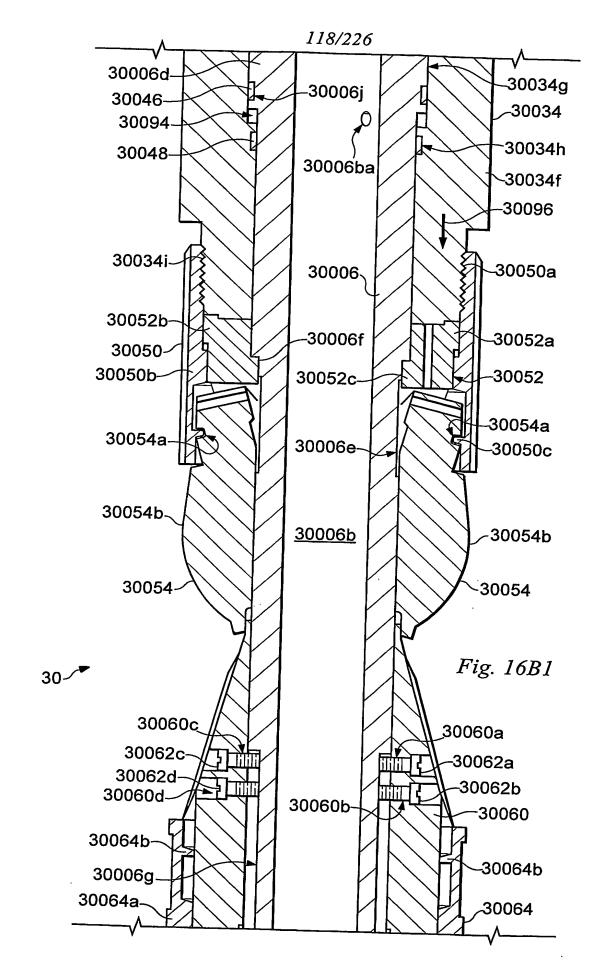


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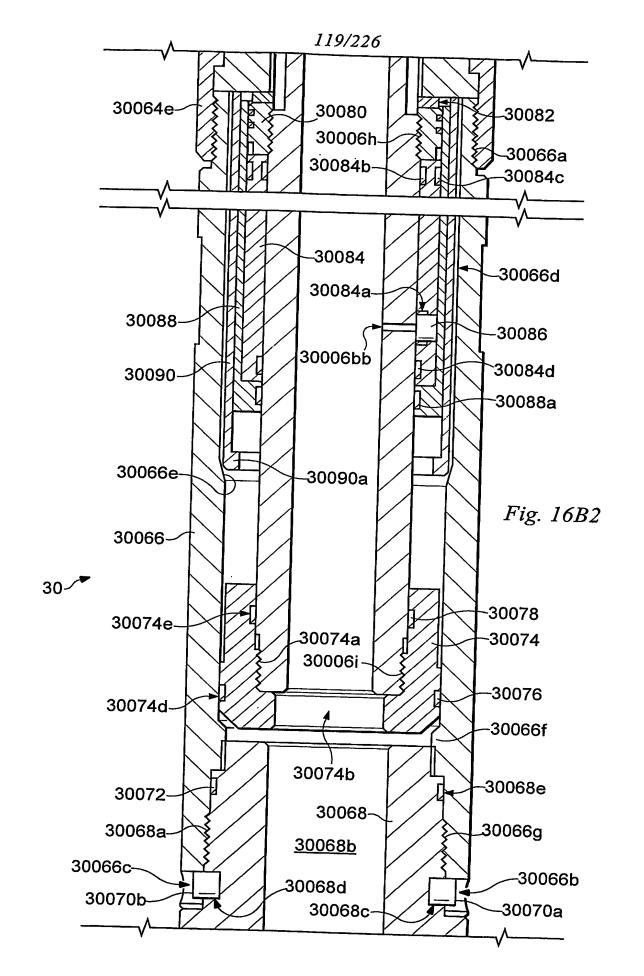




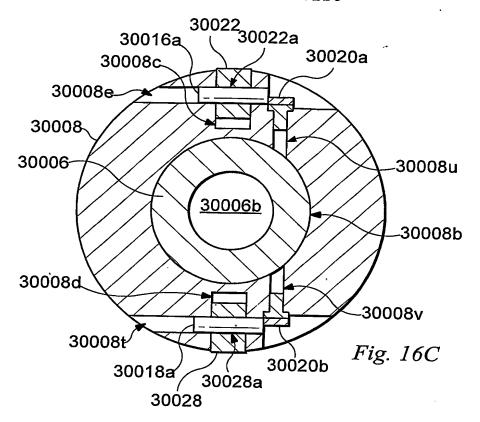
WO 2004/092528 PCT/US2004/010762

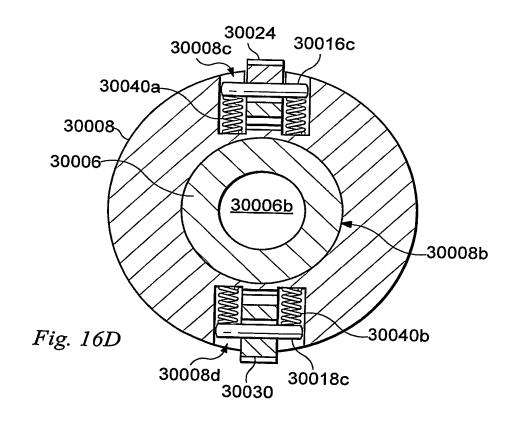


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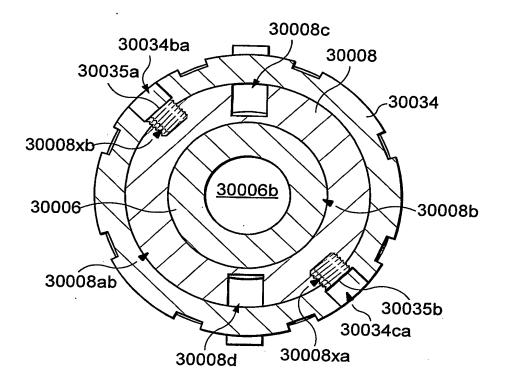


Fig. 16E

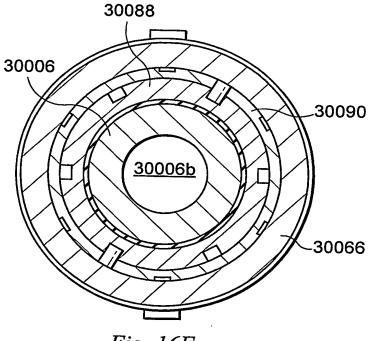
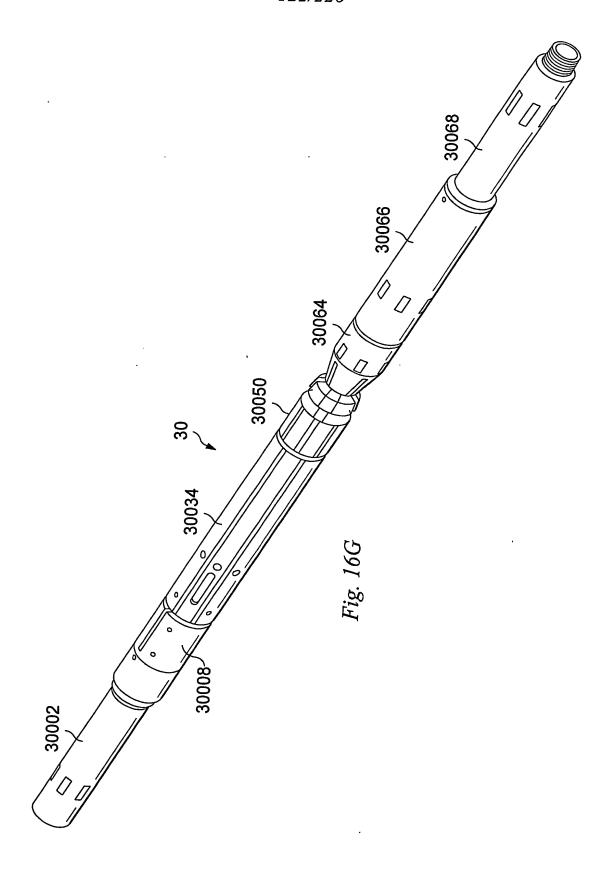


Fig. 16F



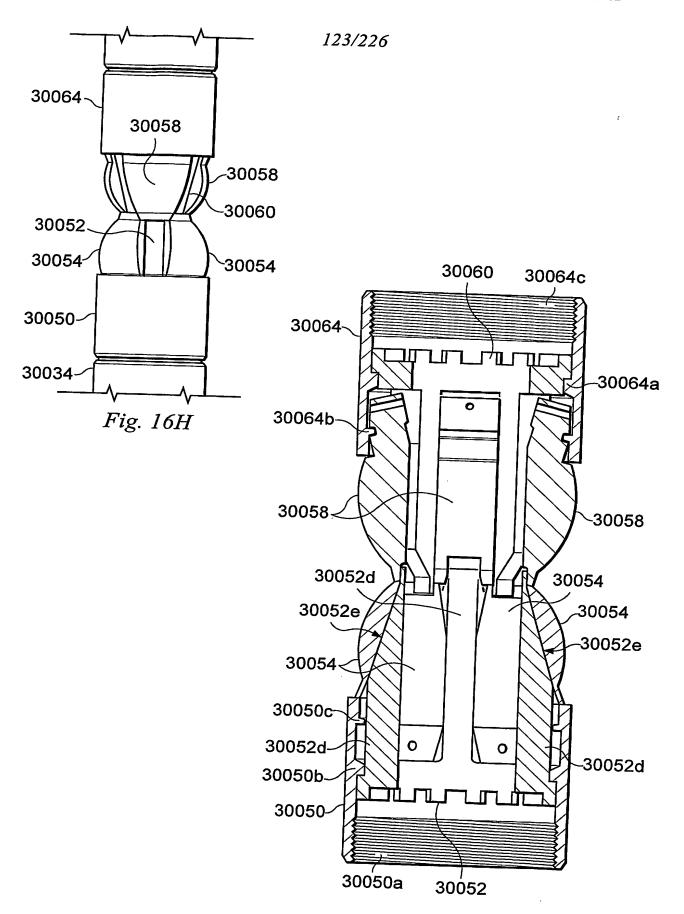
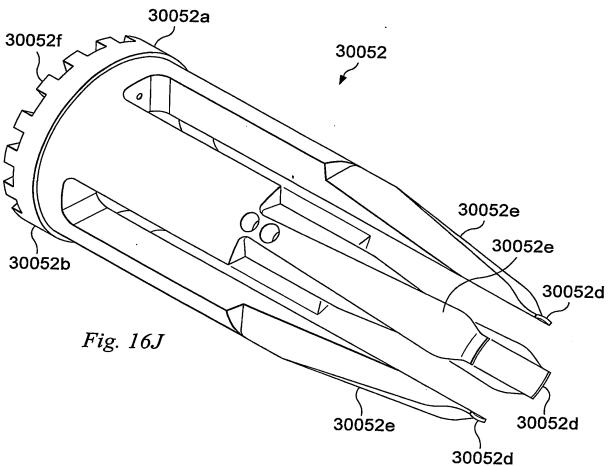
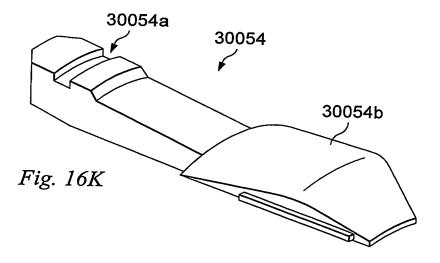


FIG. 16I









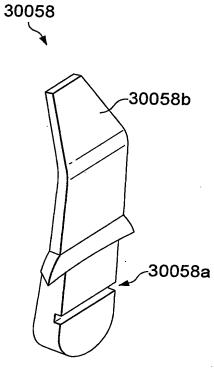


Fig. 16L

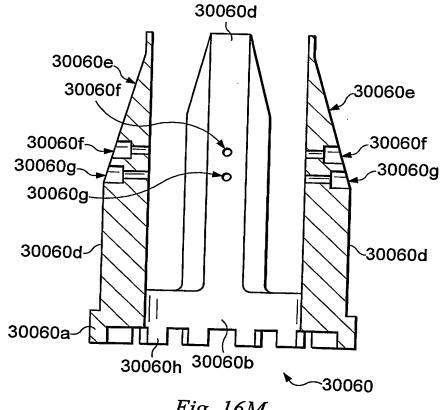
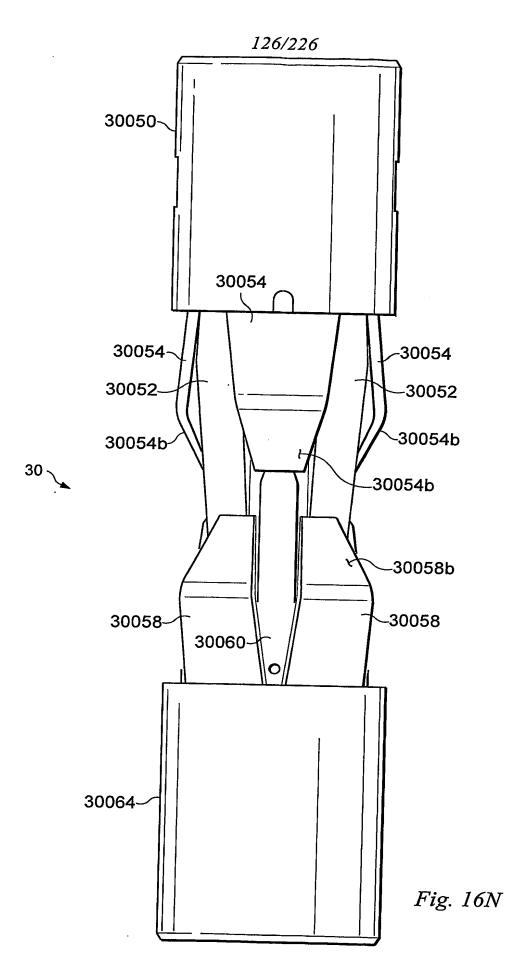


Fig. 16M



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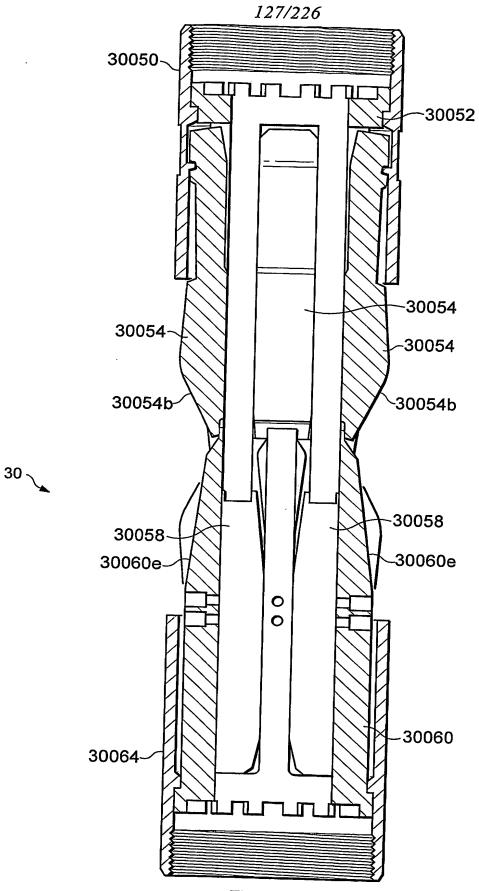
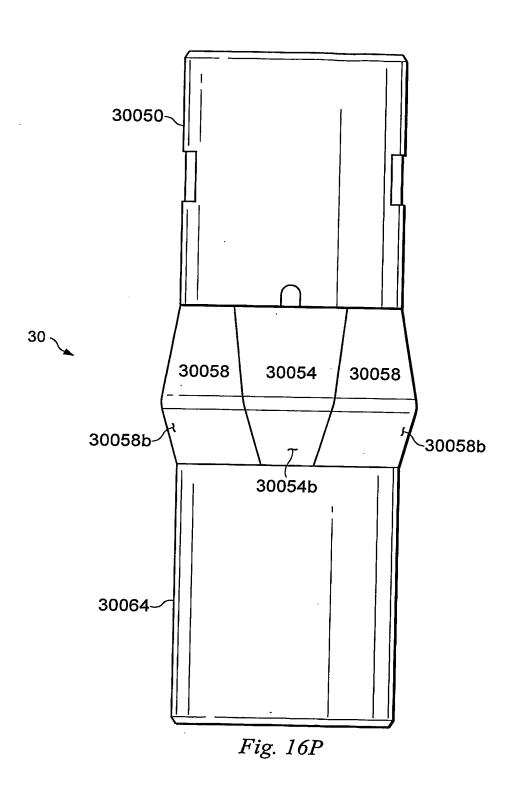
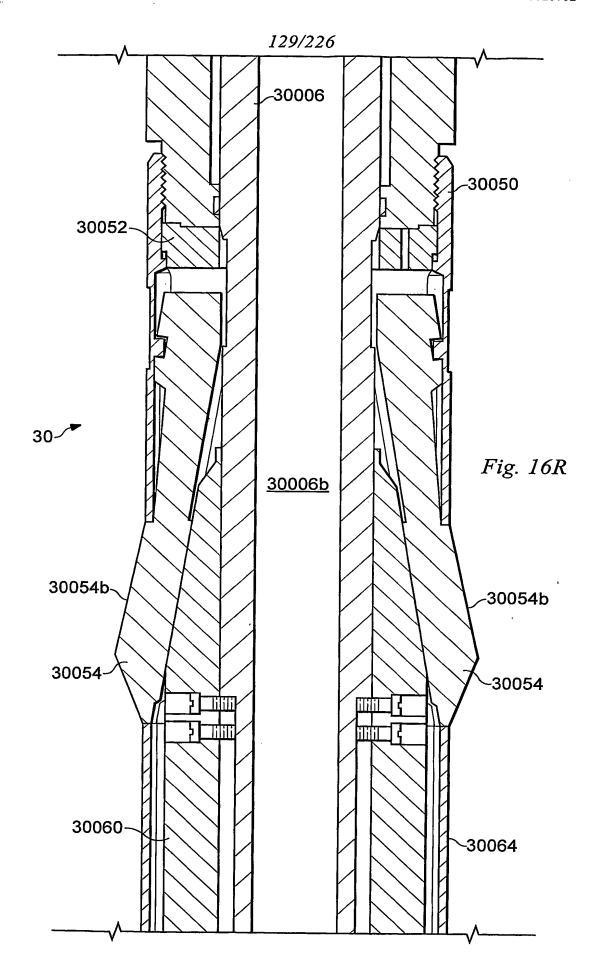


Fig. 160





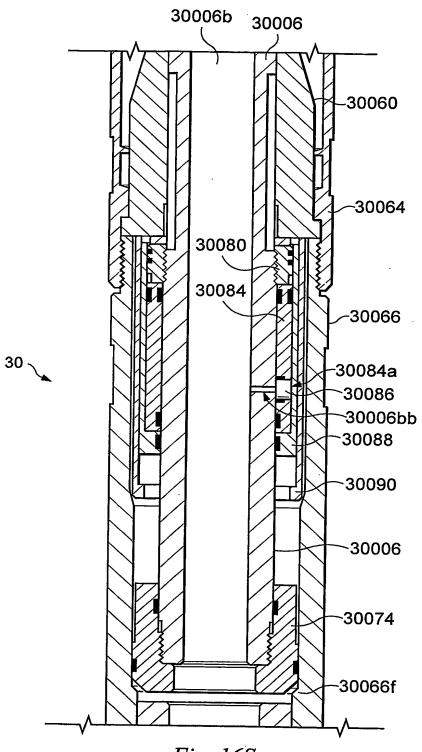


Fig. 16S

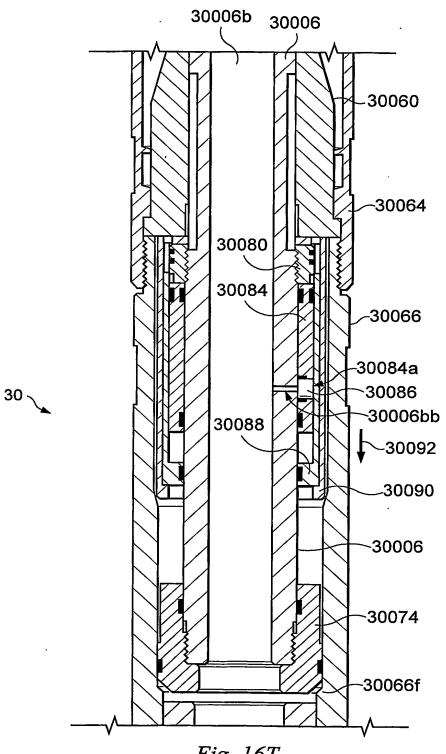


Fig. 16T

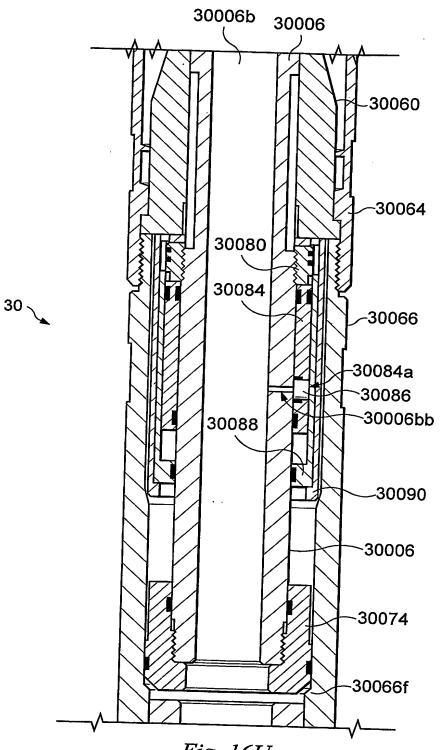


Fig. 16U

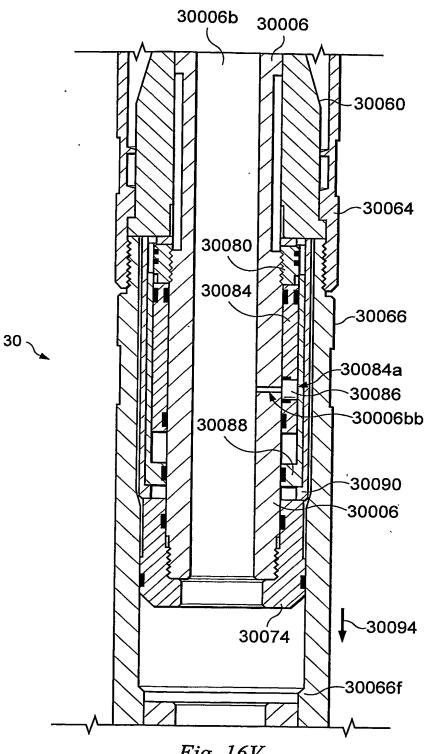
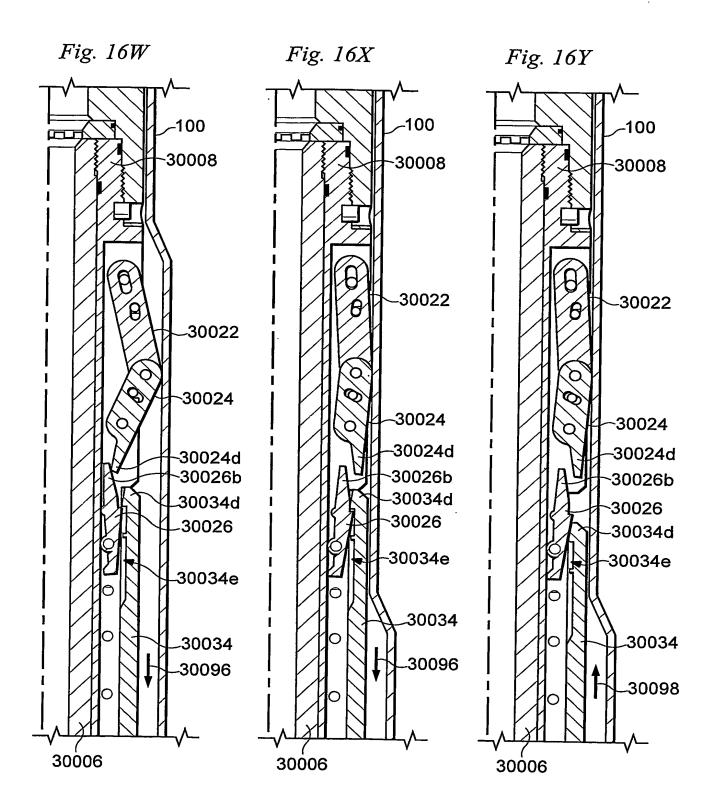
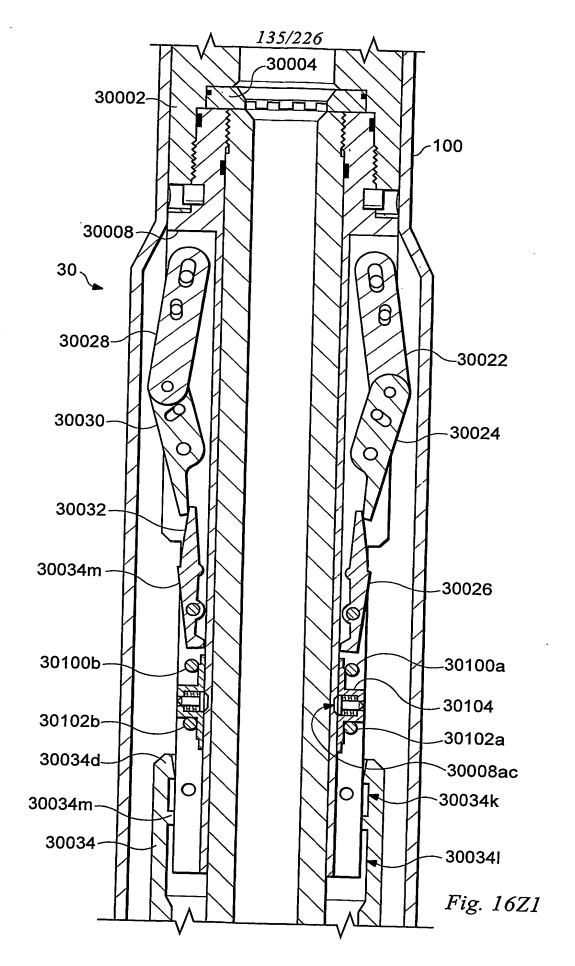


Fig. 16V



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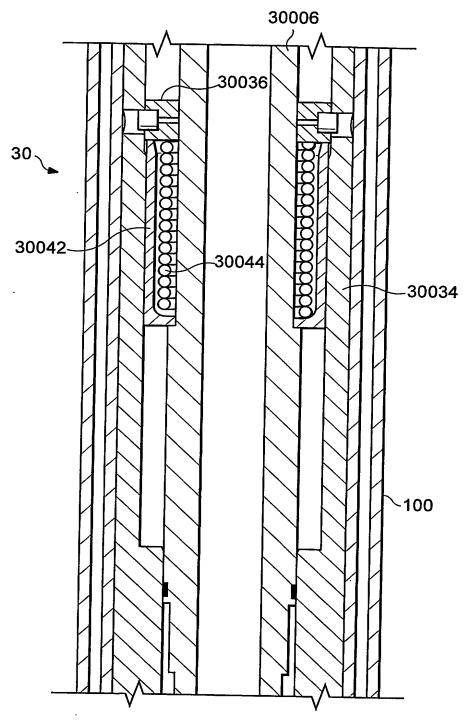


Fig. 16Z2

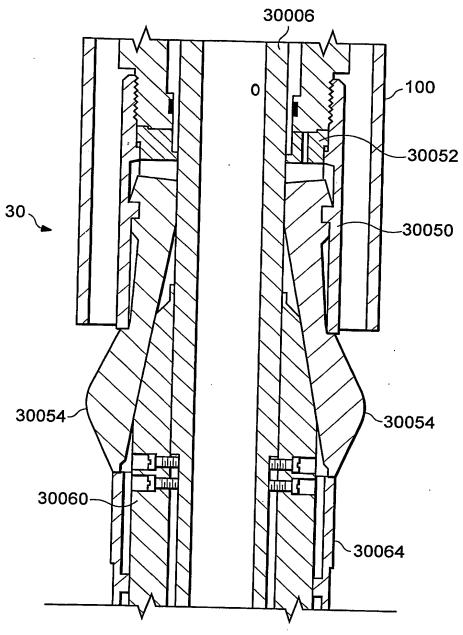


Fig. 16Z3

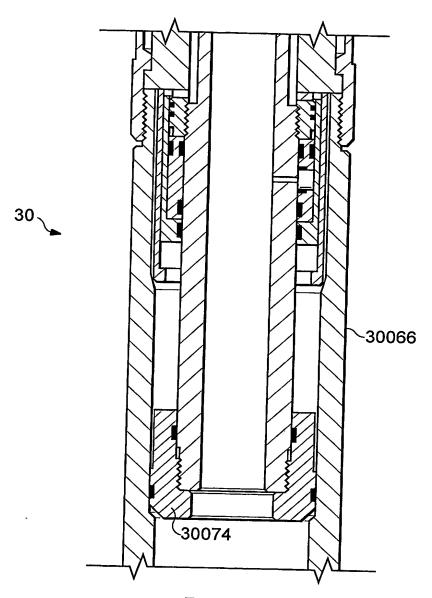


Fig. 16Z4

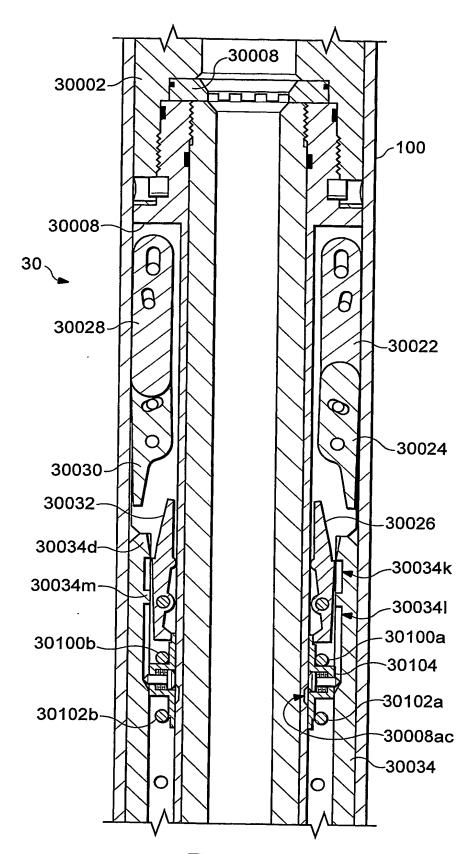


Fig. 16AA1

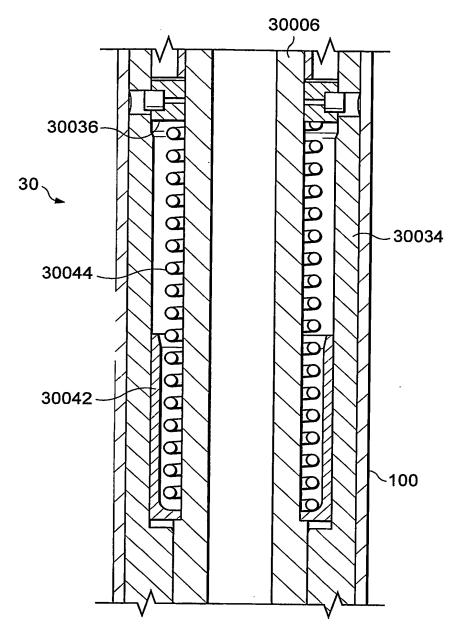


Fig. 16AA2

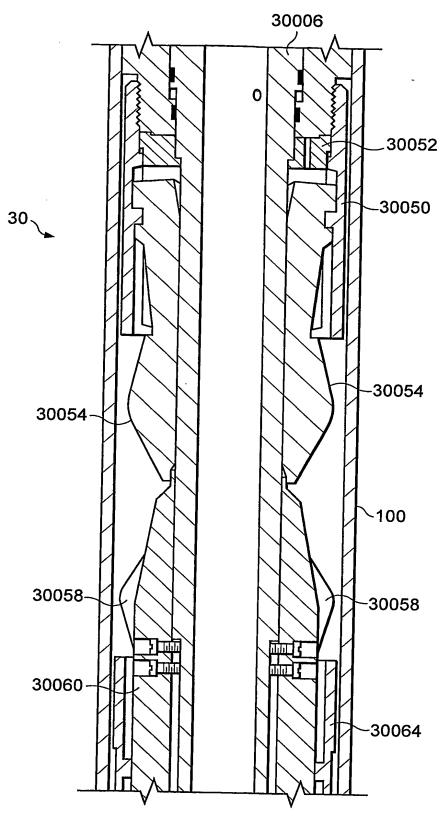


Fig. 16AA3

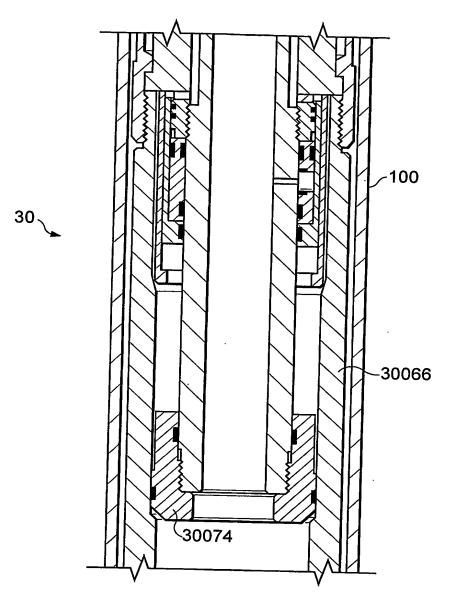


Fig. 16AA4

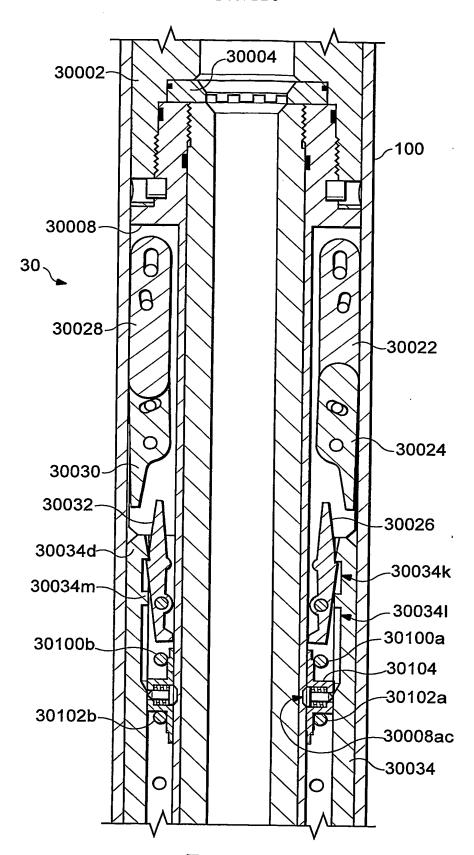


Fig. 16AB1

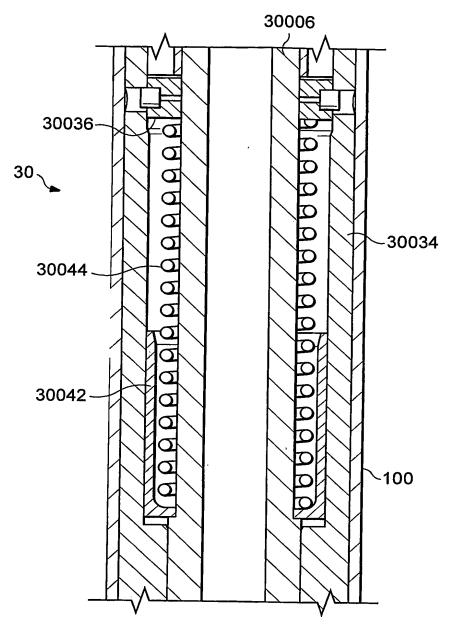


Fig. 16AB2

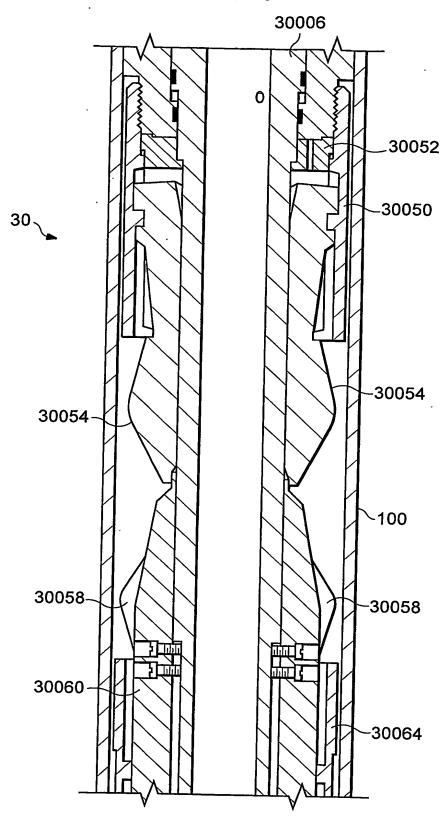


Fig. 16AB3

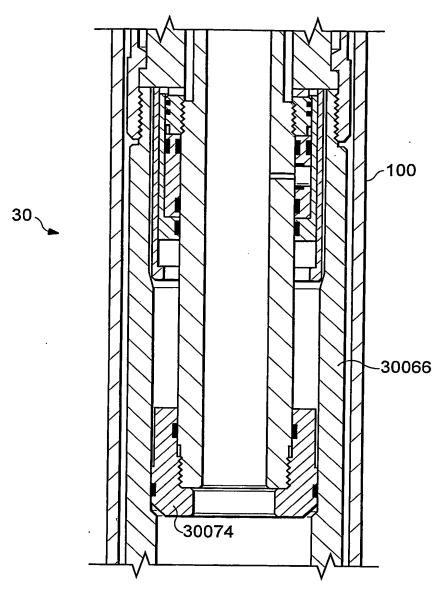
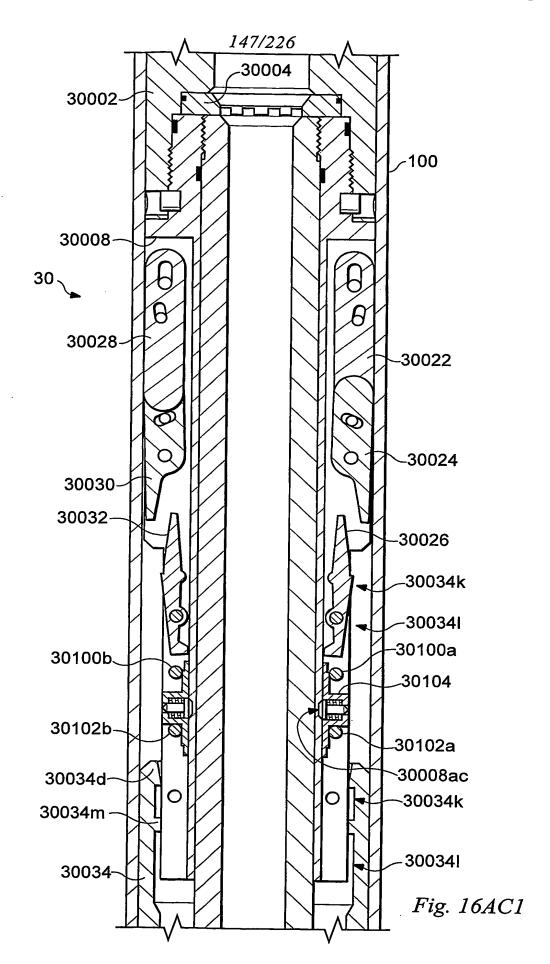


Fig. 16AB4

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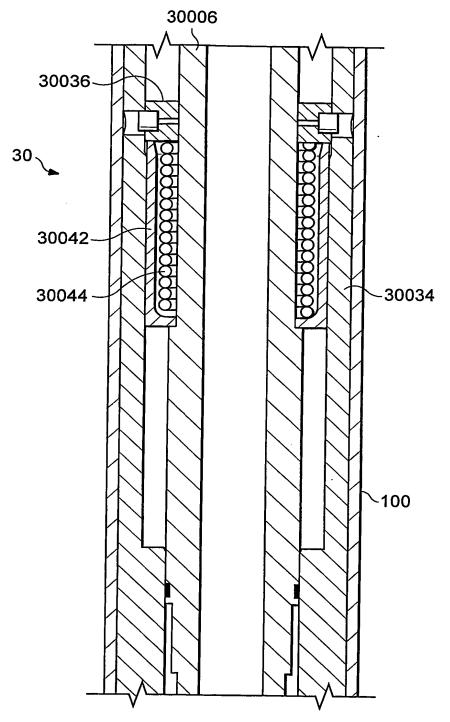


Fig. 16AC2

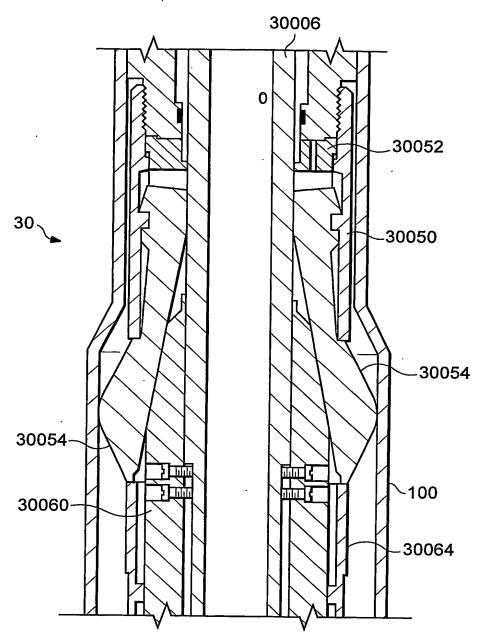


Fig. 16AC3

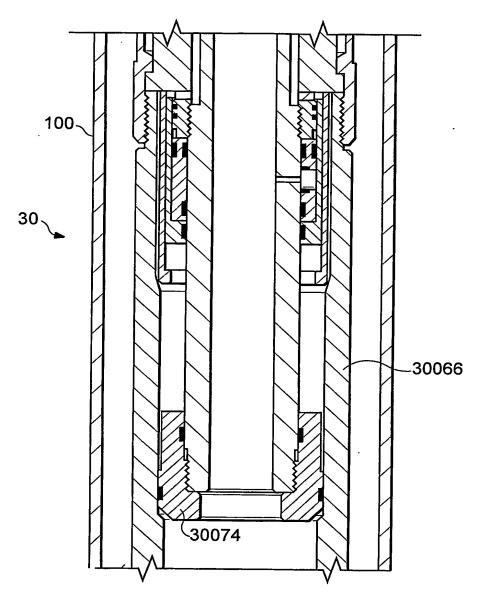


Fig. 16AC4

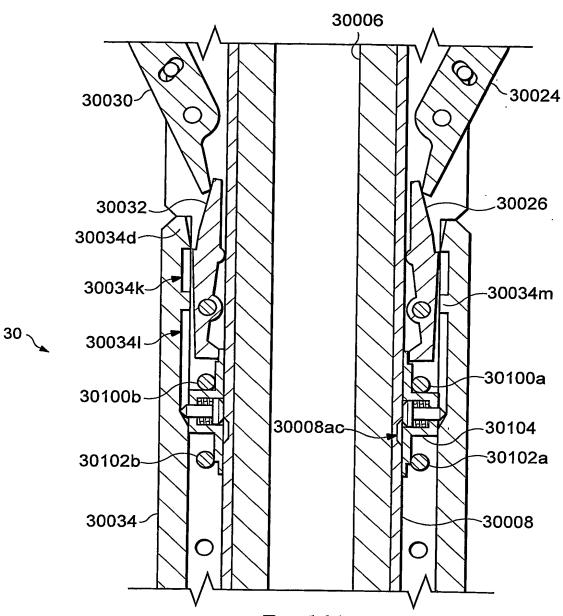
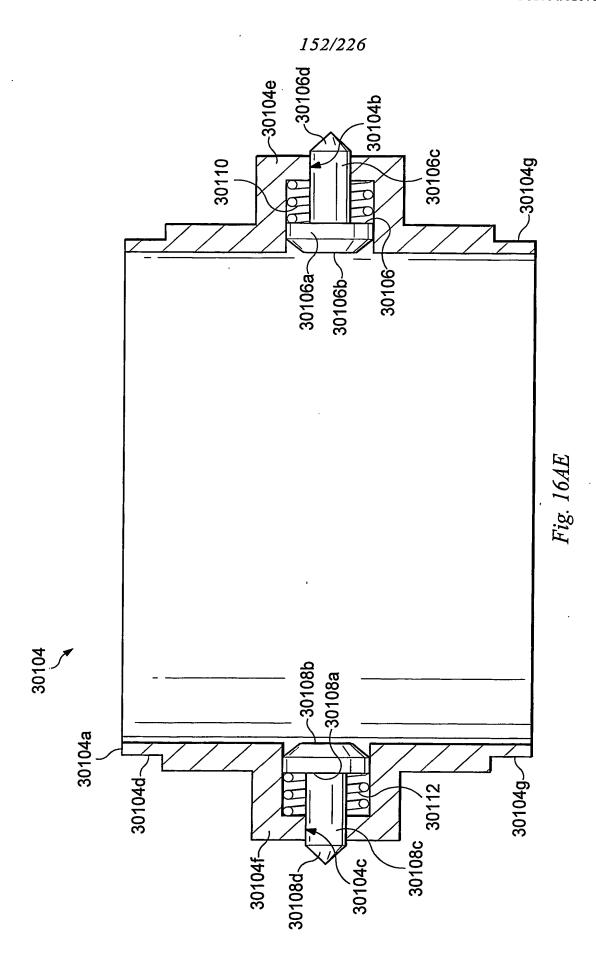


Fig. 16AD





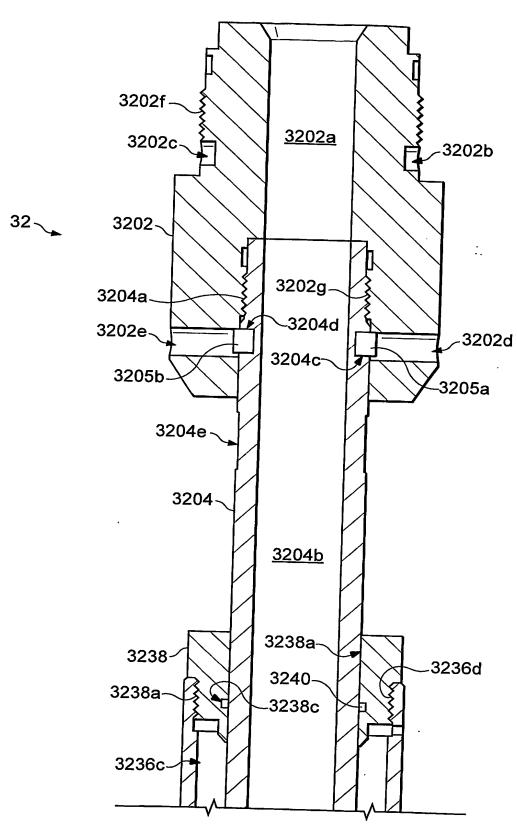


Fig. 17A

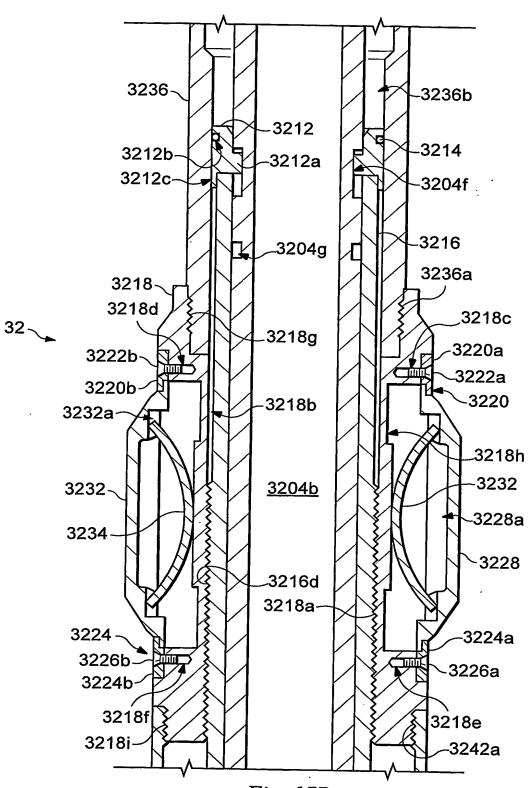
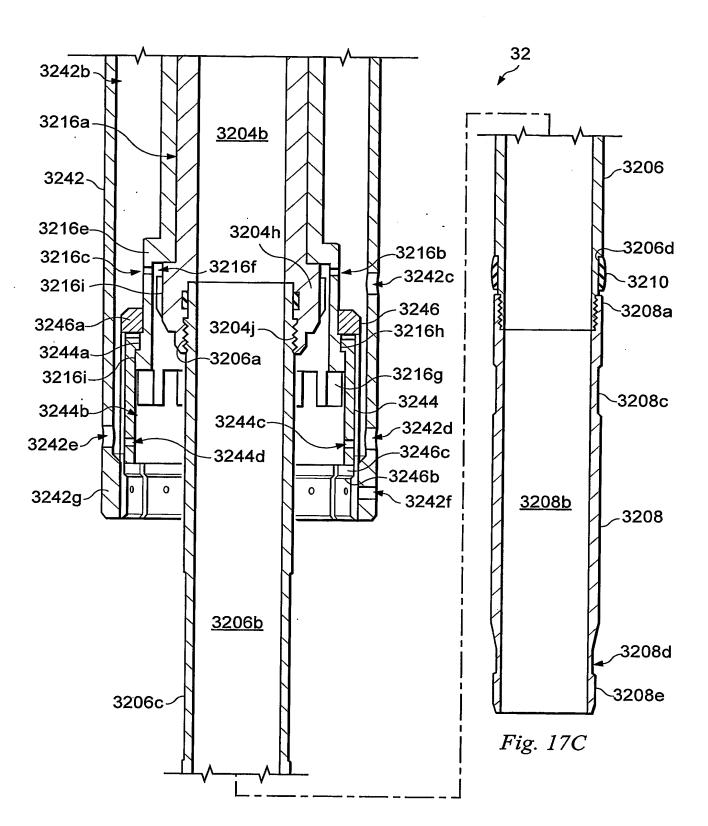


Fig. 17B



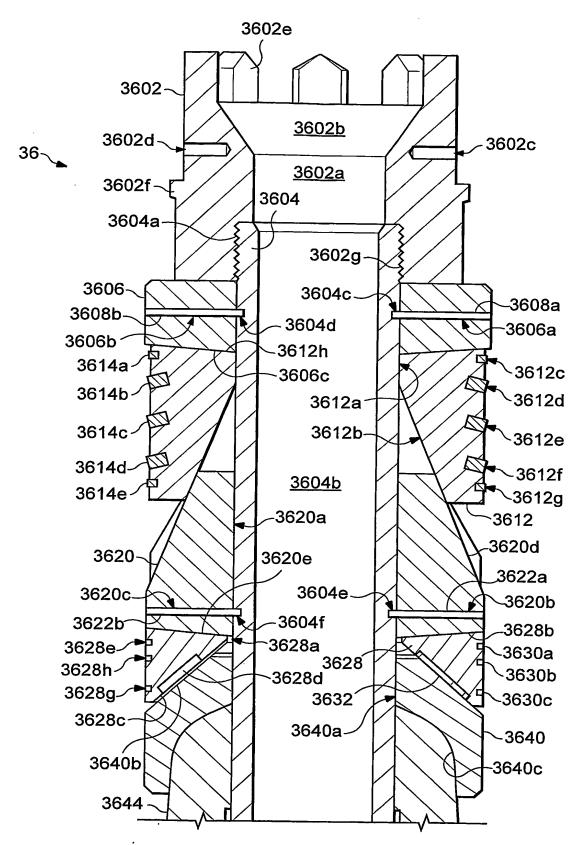


Fig. 18-1

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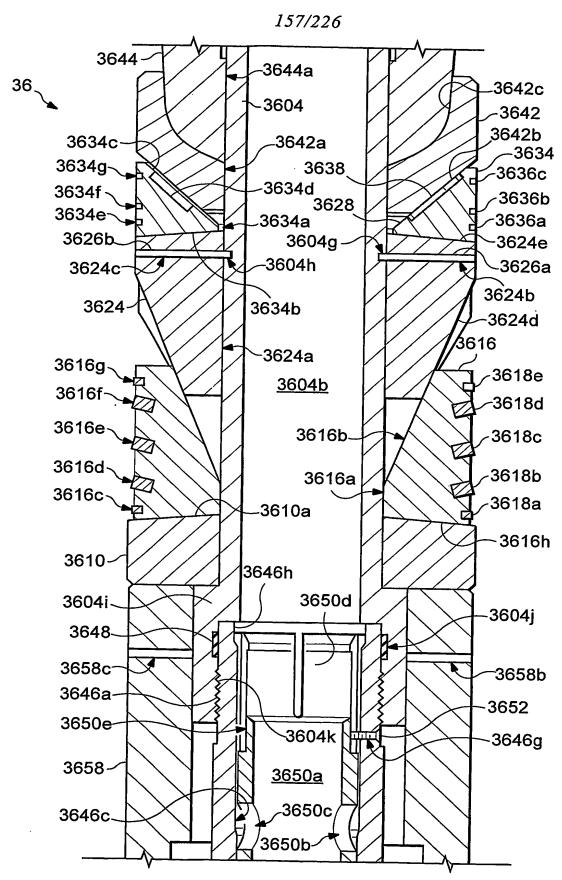


Fig. 18-2

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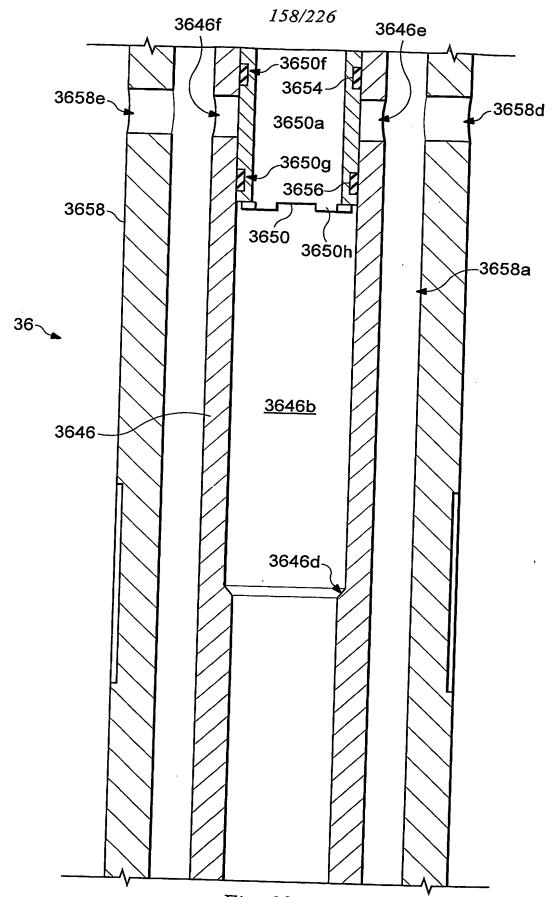
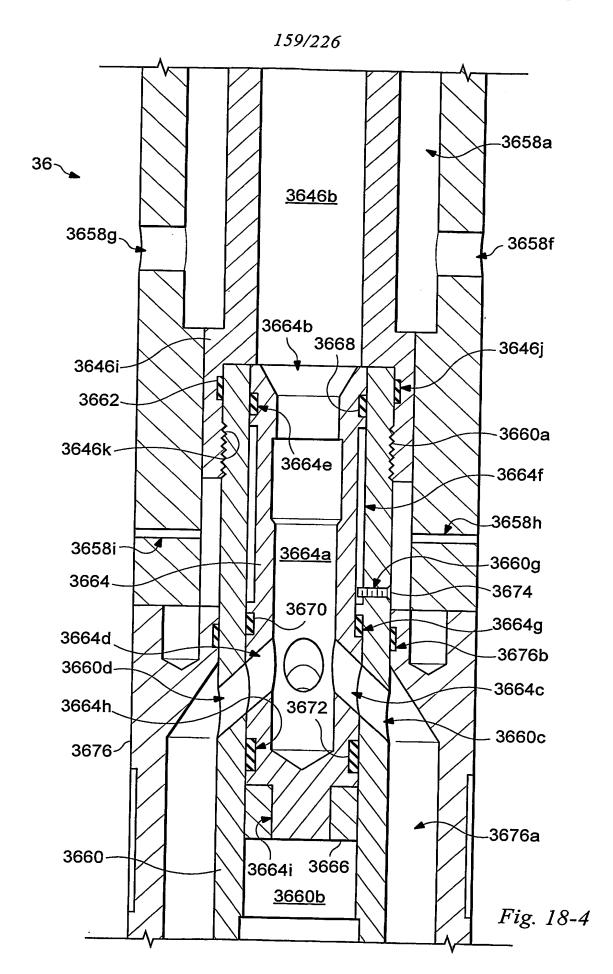
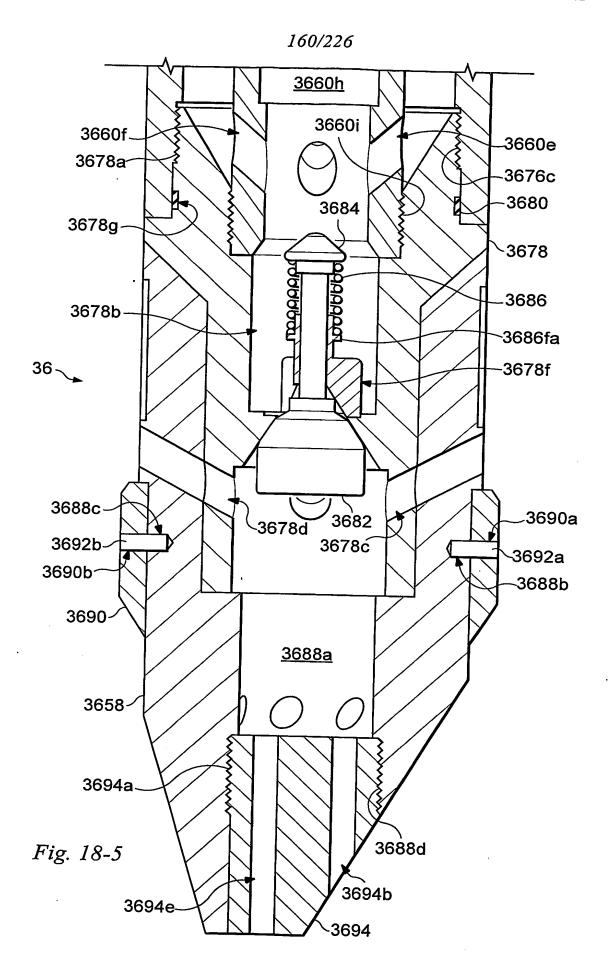


Fig. 18-3

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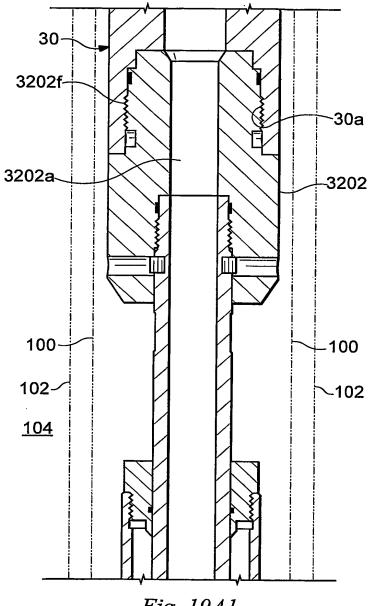


Fig. 19A1

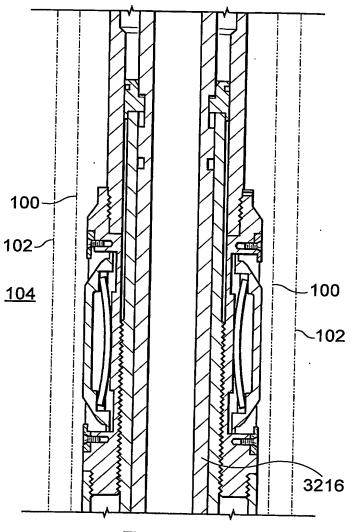


Fig. 19A2

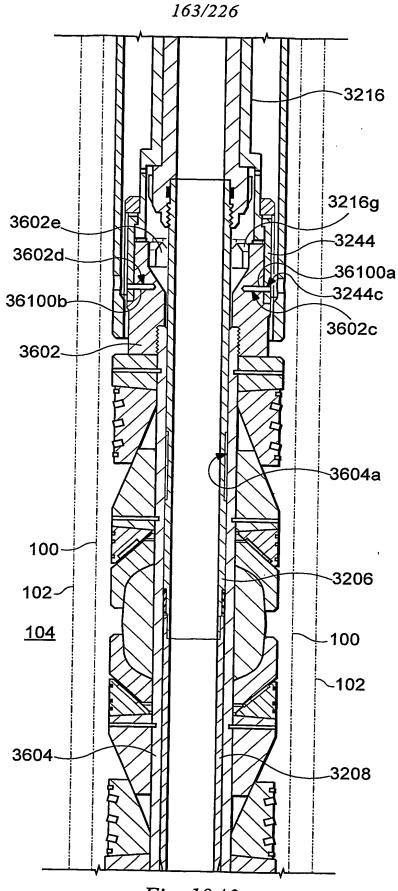


Fig. 19A3

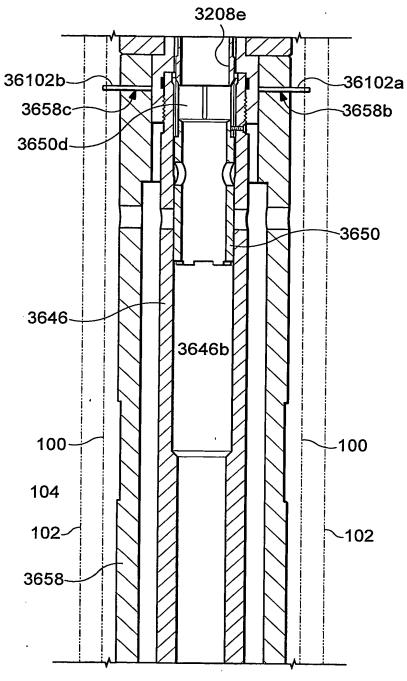
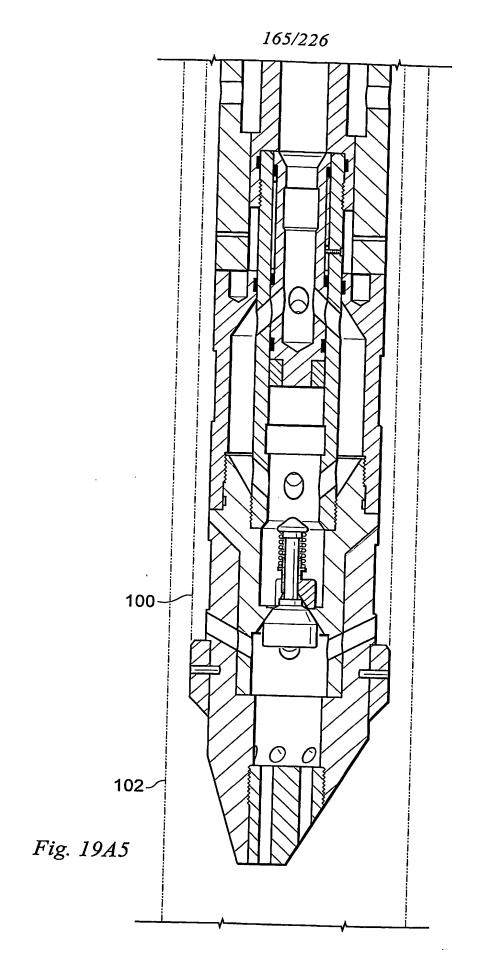


Fig. 19A4



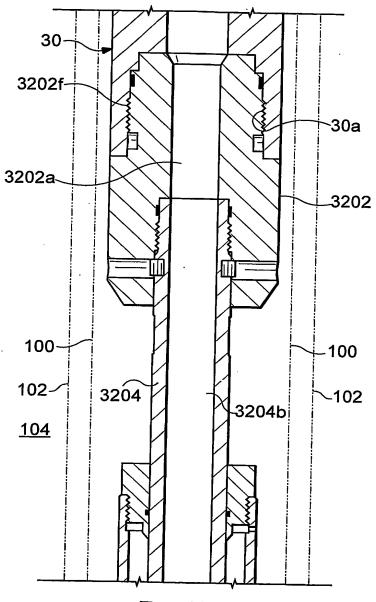


Fig. 19B1

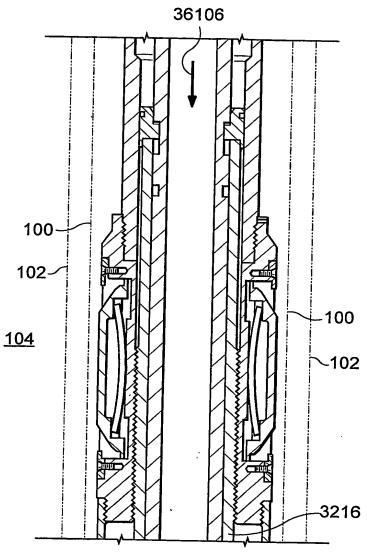


Fig. 19B2

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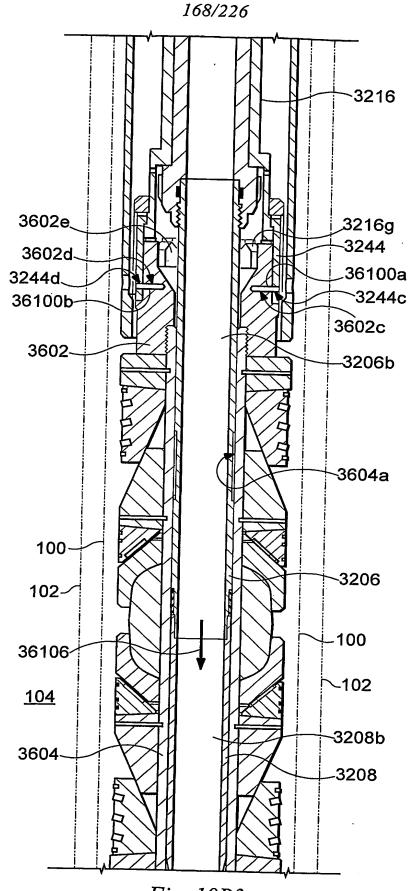


Fig. 19B3

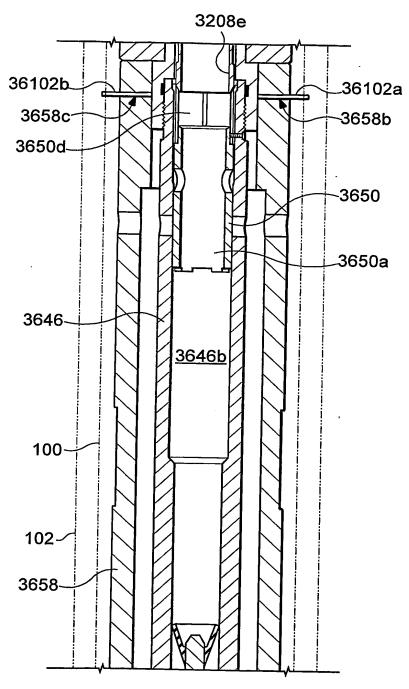
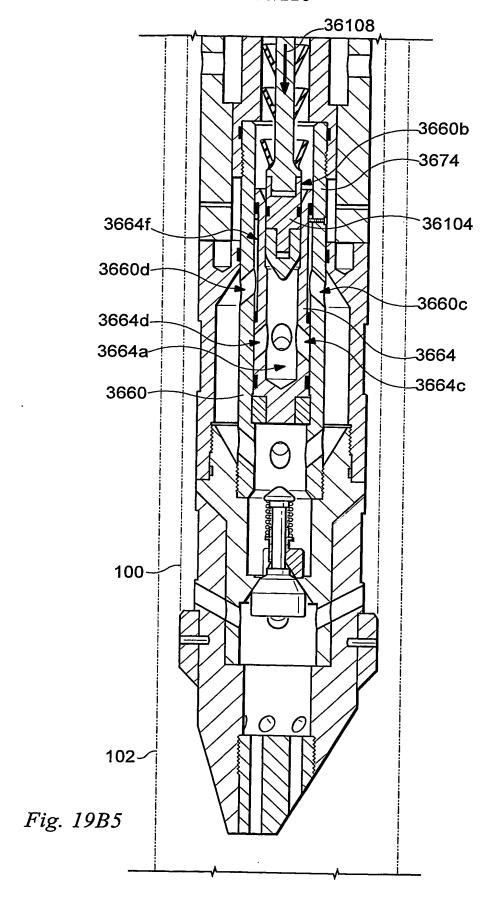


Fig. 19B4





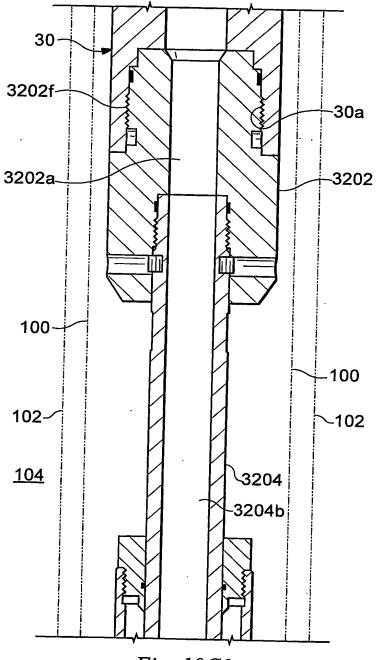


Fig. 19C1

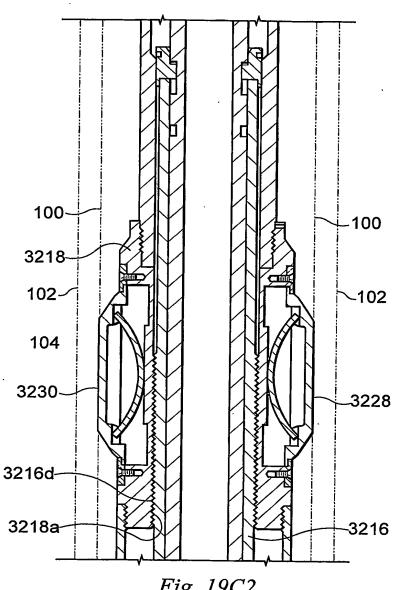


Fig. 19C2

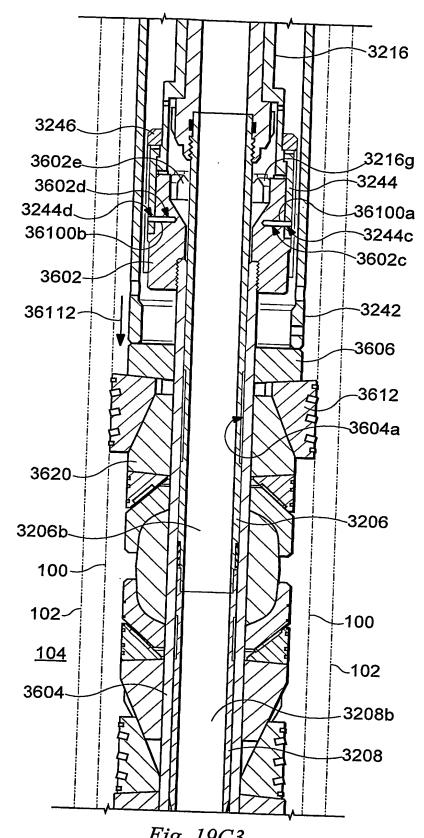


Fig. 19C3

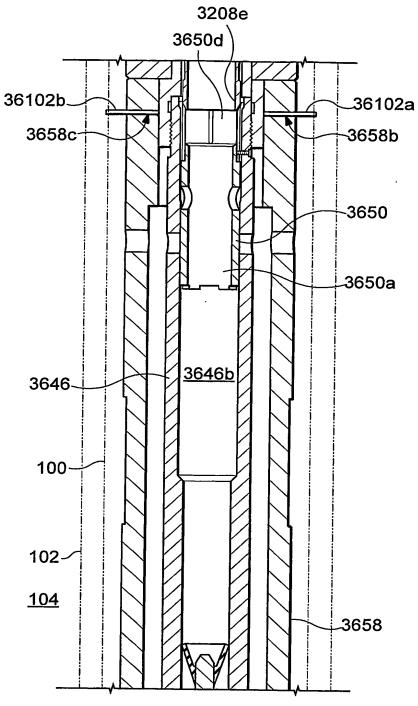
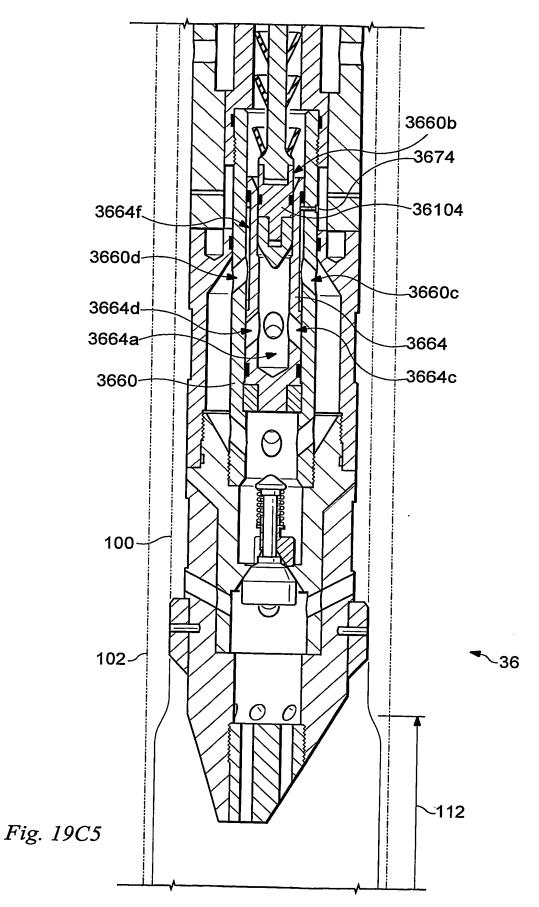


Fig. 19C4





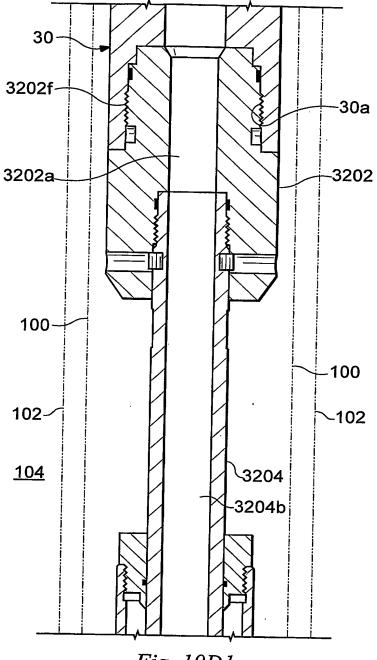


Fig. 19D1

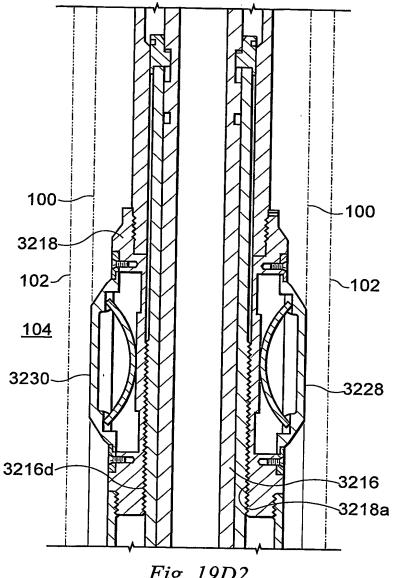


Fig. 19D2

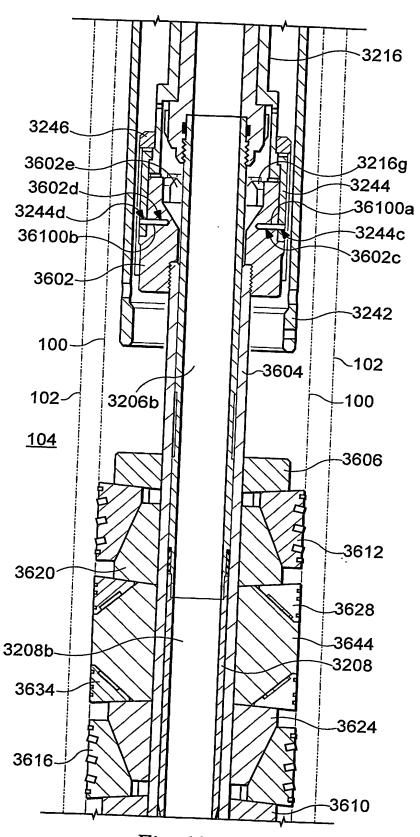


Fig. 19D3

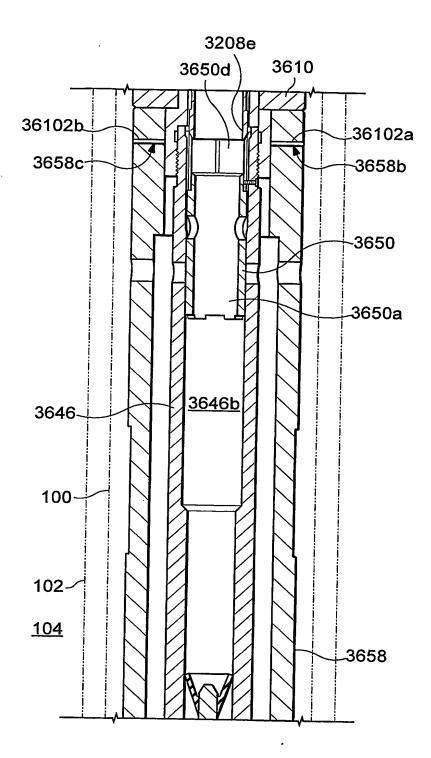
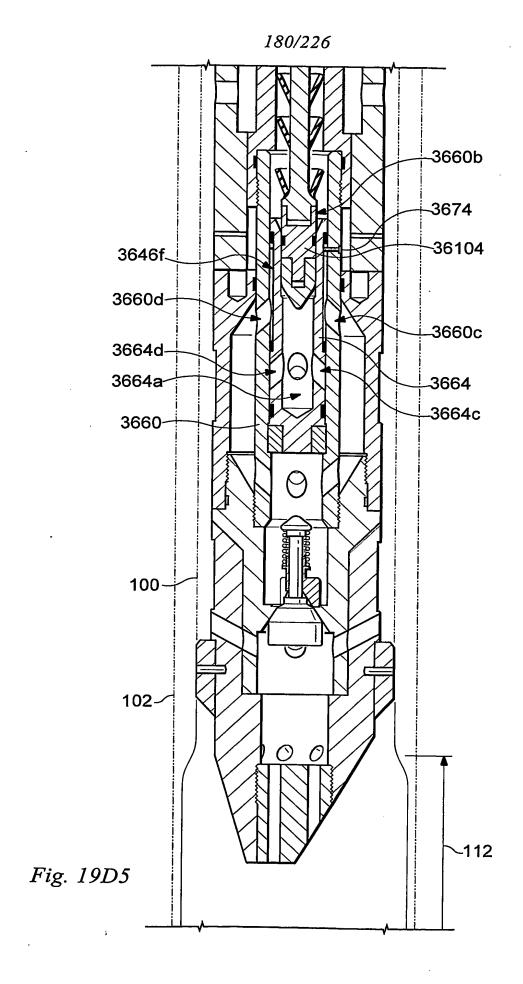


Fig. 19D4

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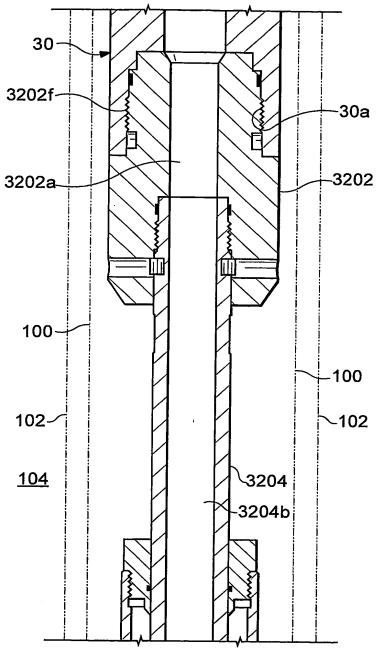


Fig. 19E1

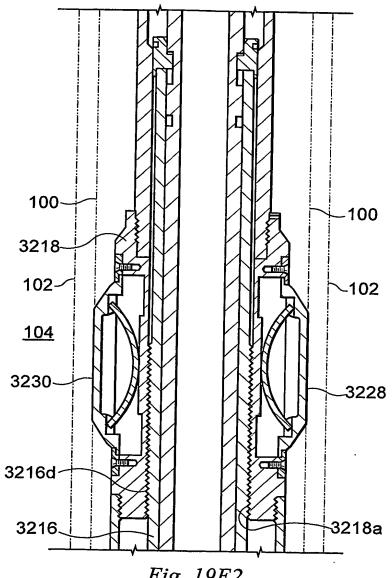


Fig. 19E2

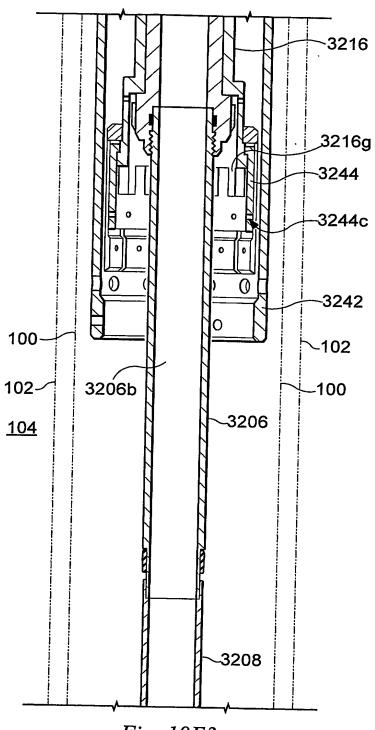


Fig. 19E3

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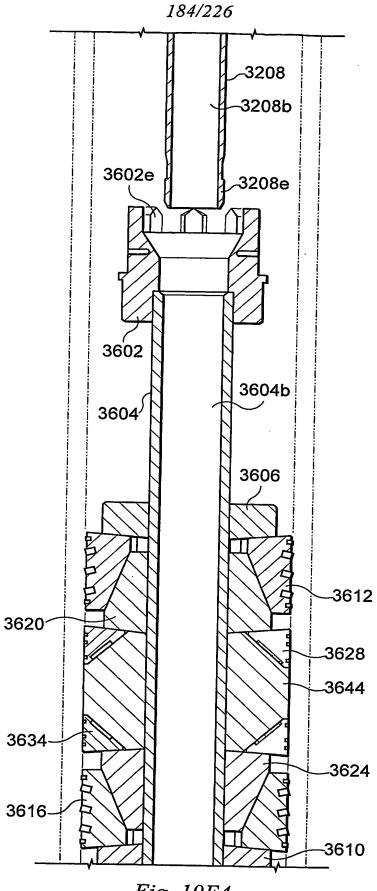


Fig. 19E4

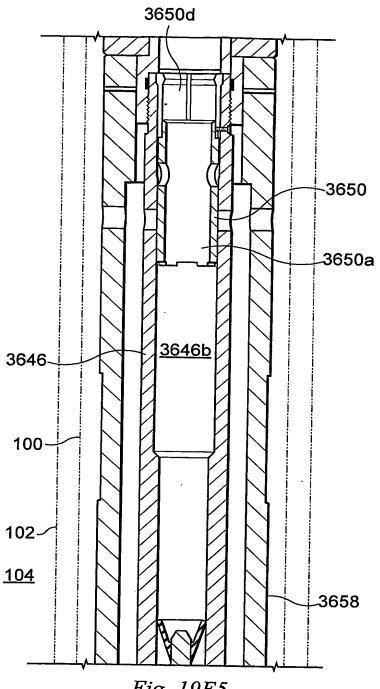
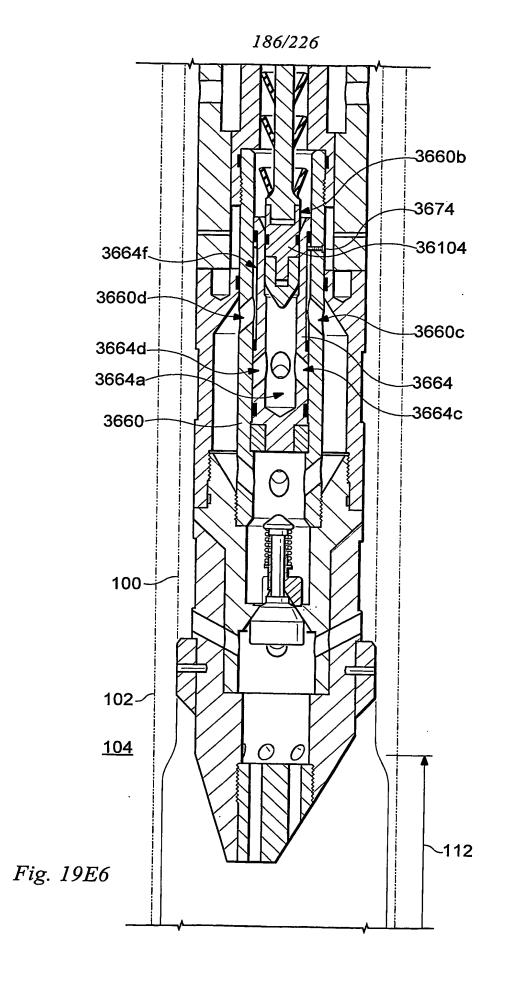


Fig. 19E5

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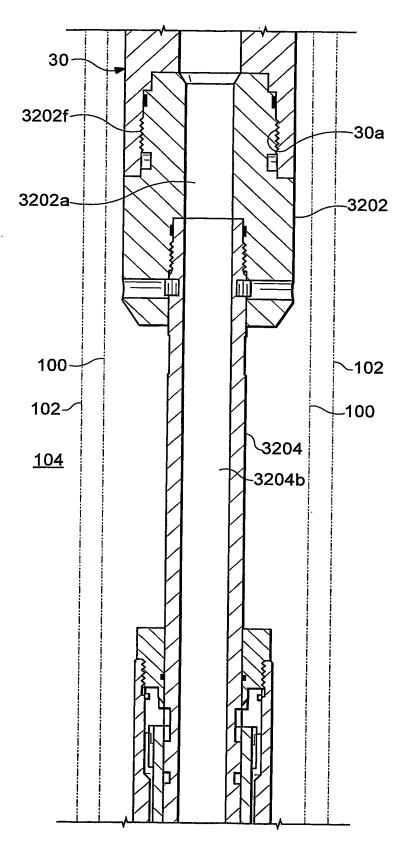


Fig. 19F1

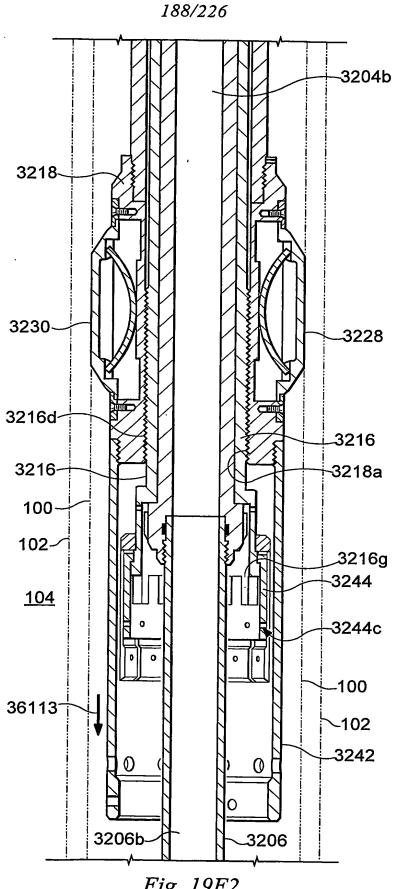
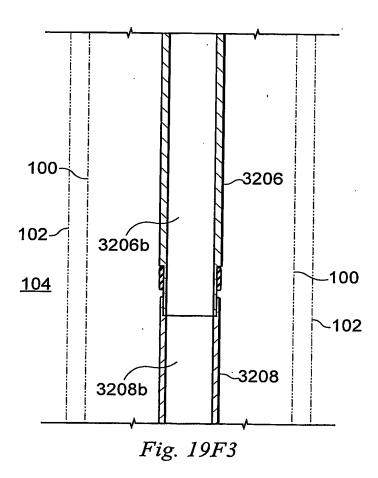


Fig. 19F2



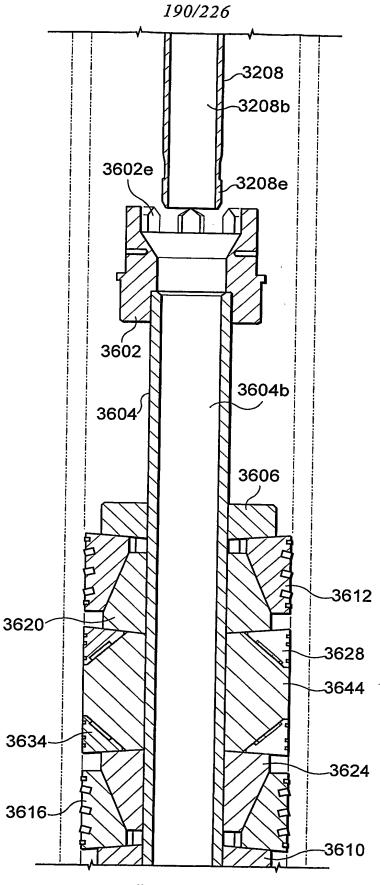


Fig. 19F4

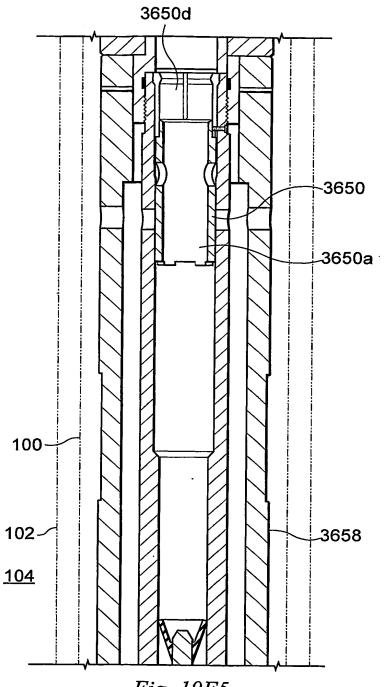
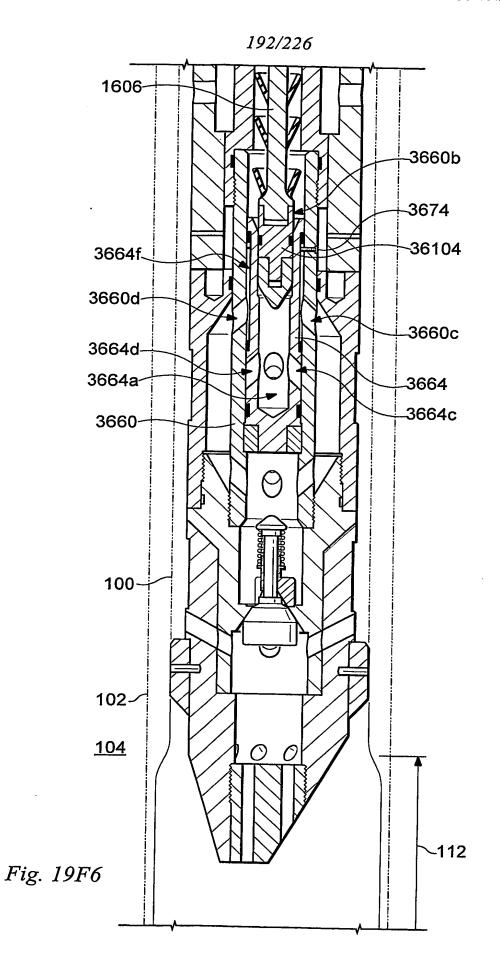


Fig. 19F5

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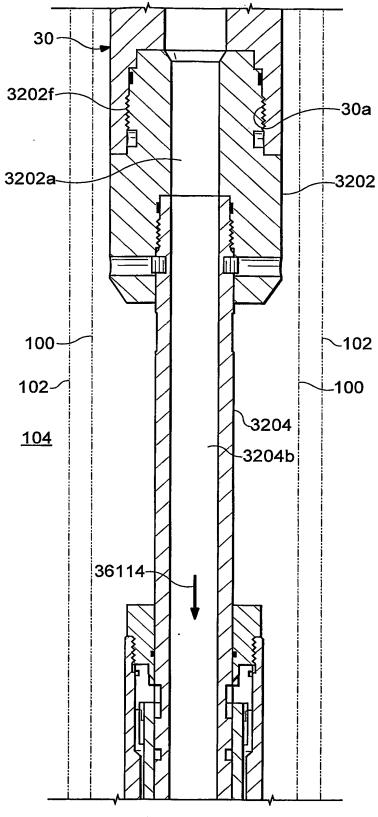


Fig. 19G1

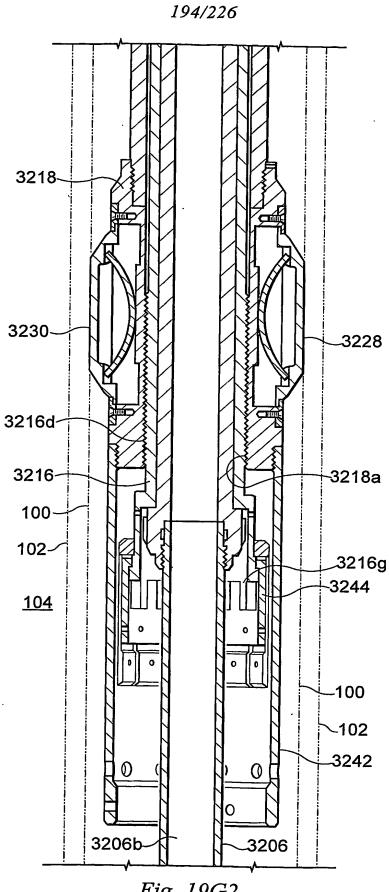
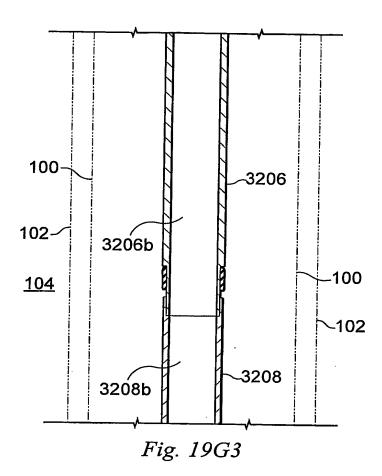
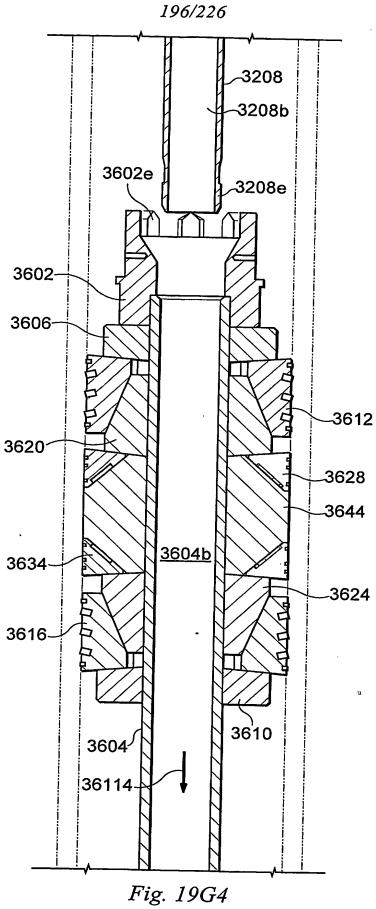
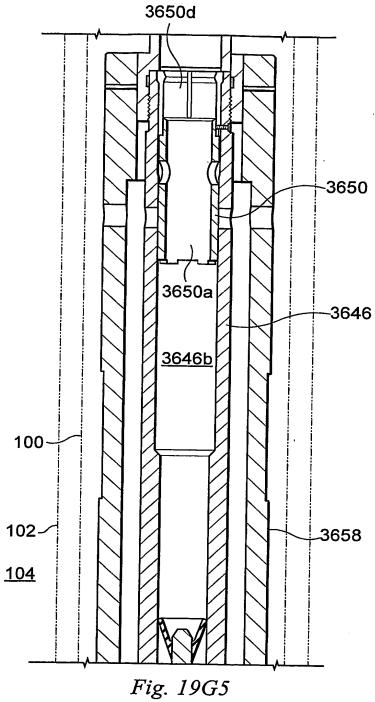


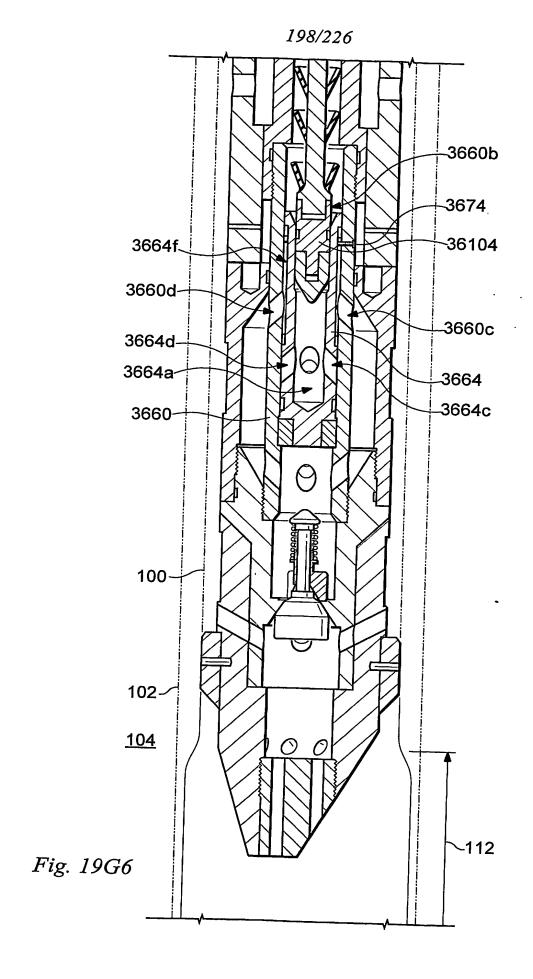
Fig. 19G2







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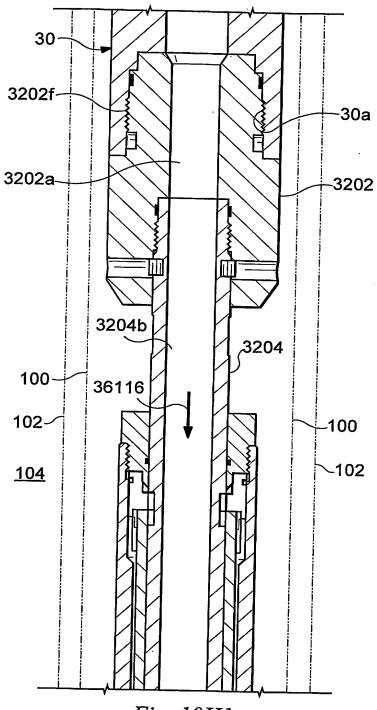
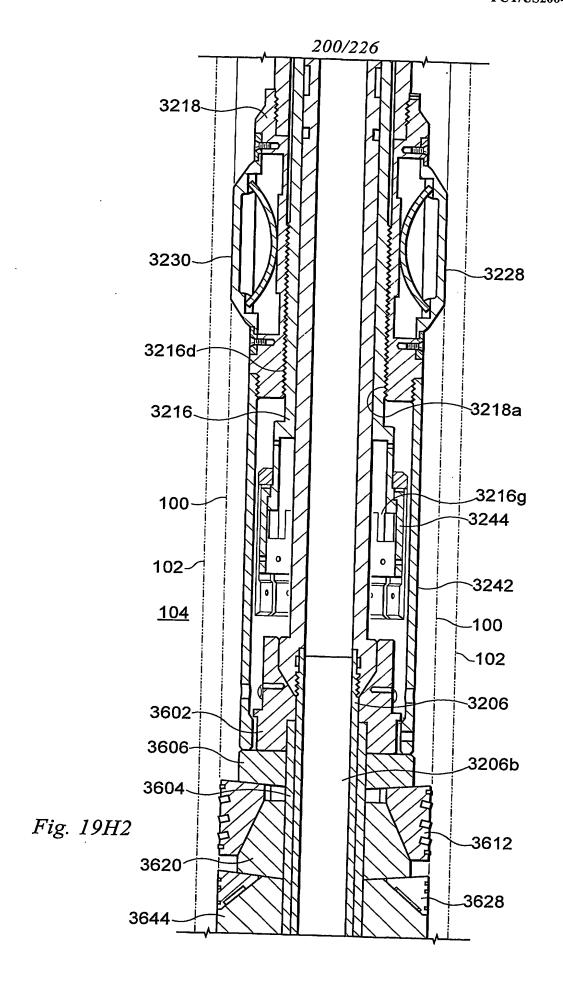
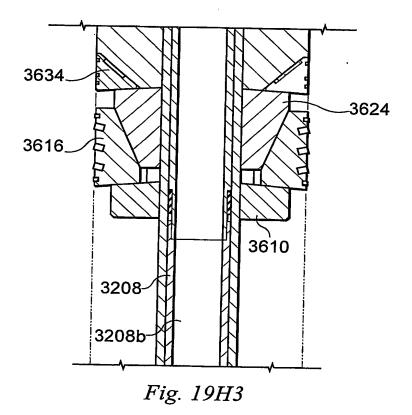


Fig. 19H1

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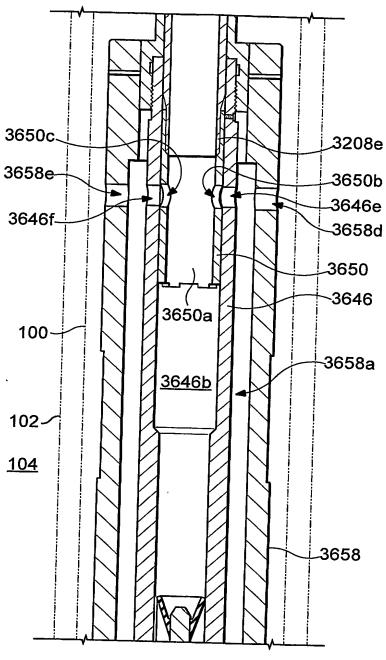
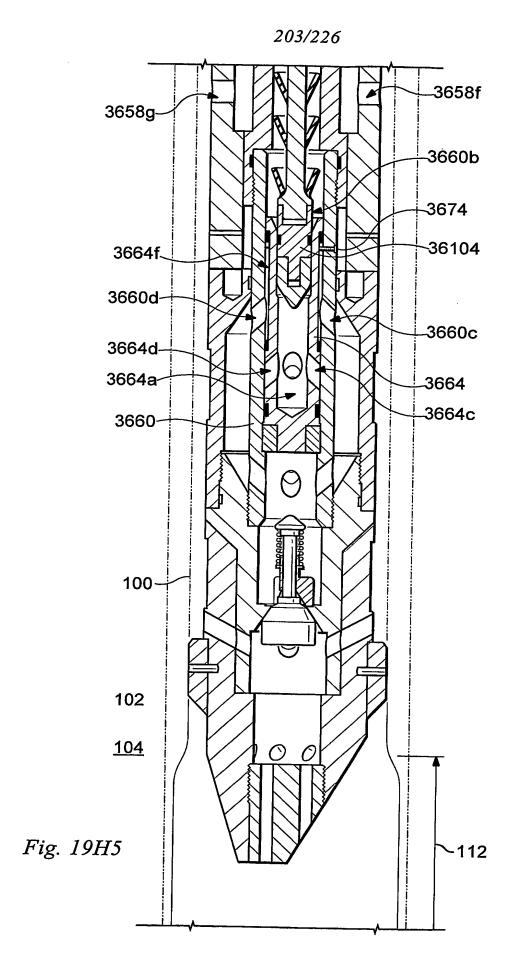
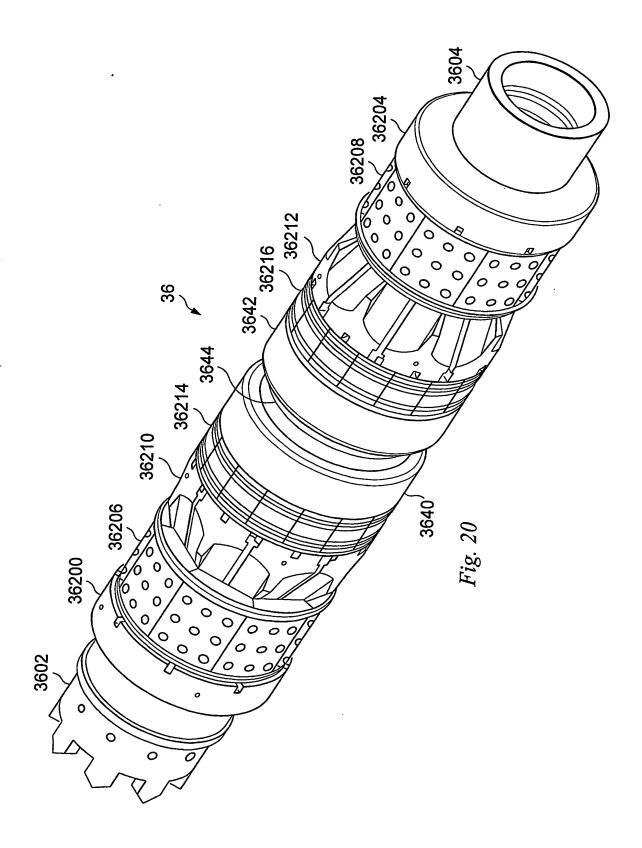


Fig. 19H4





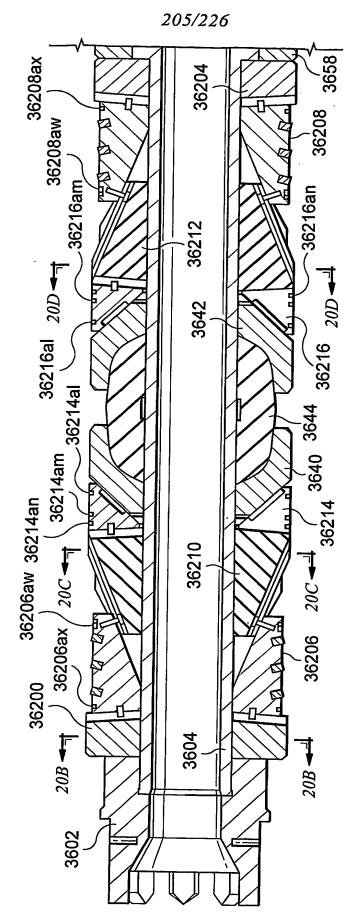
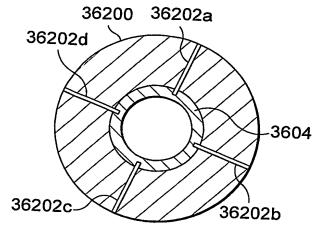


Fig. 20A



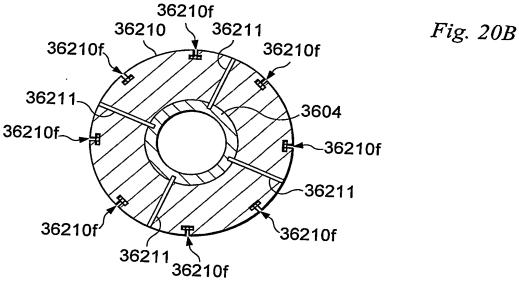


Fig. 20C

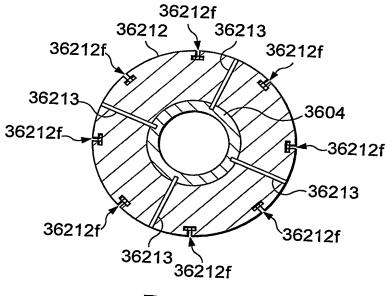


Fig. 20D

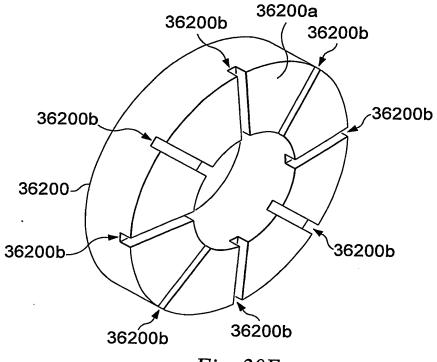


Fig. 20E

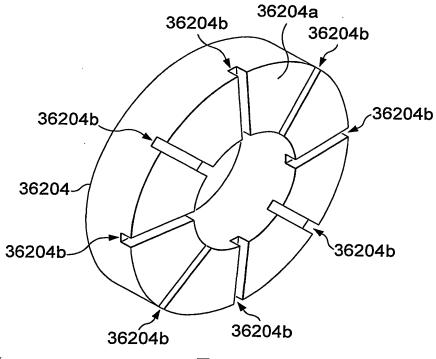
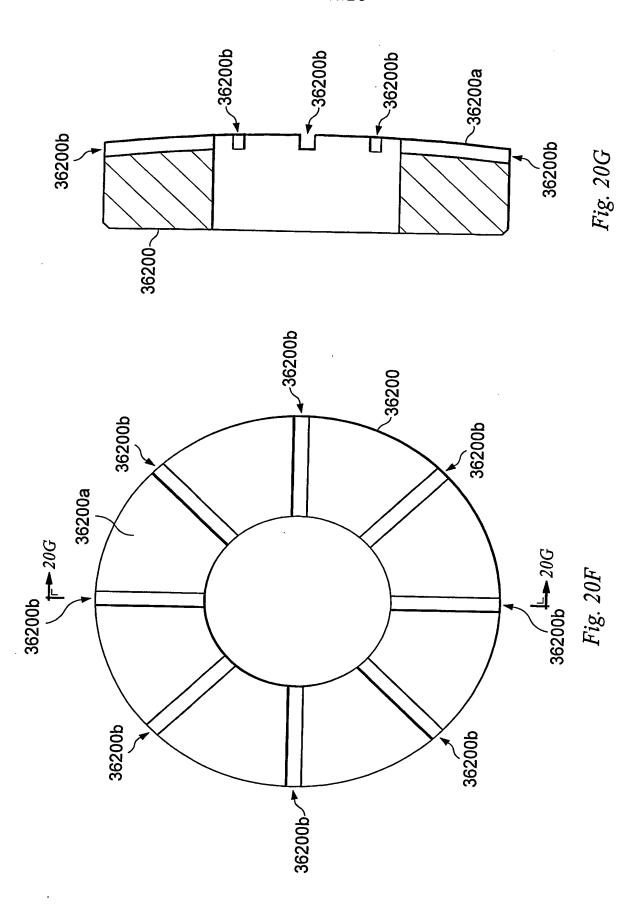
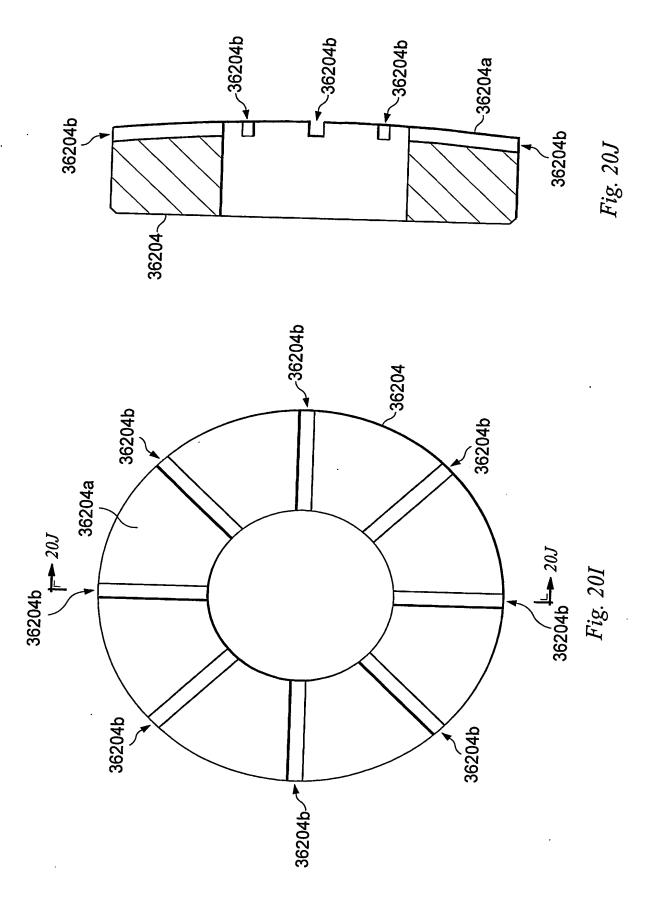
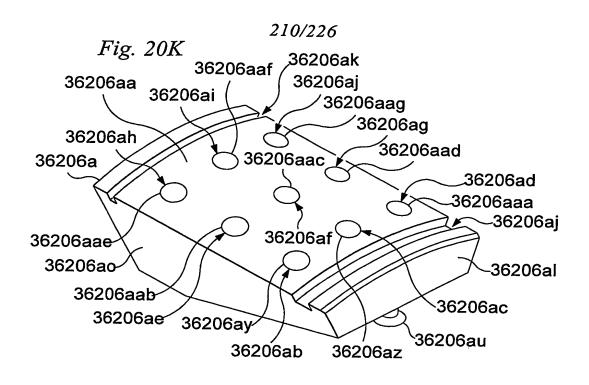


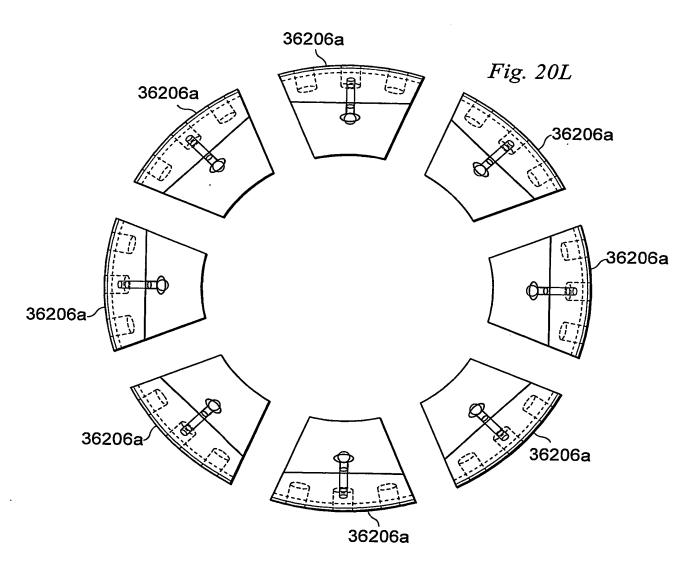
Fig. 20H



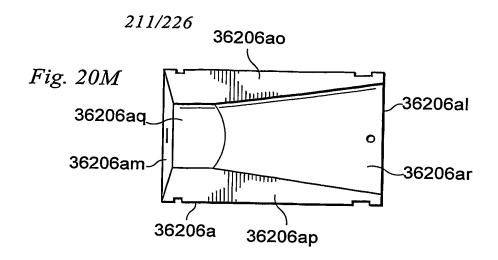


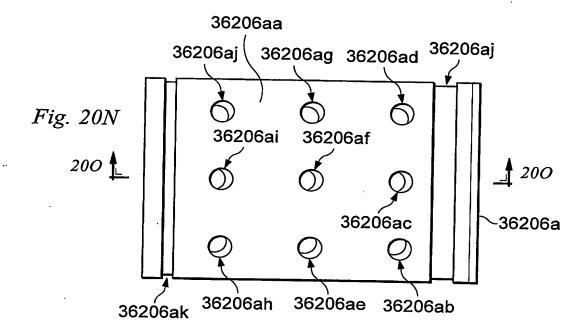
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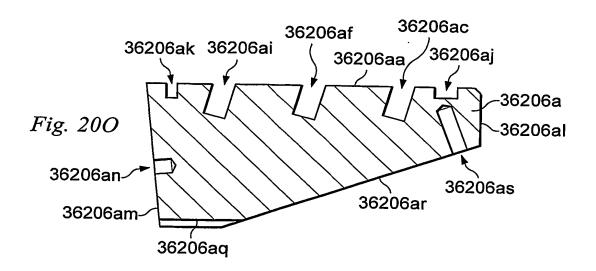




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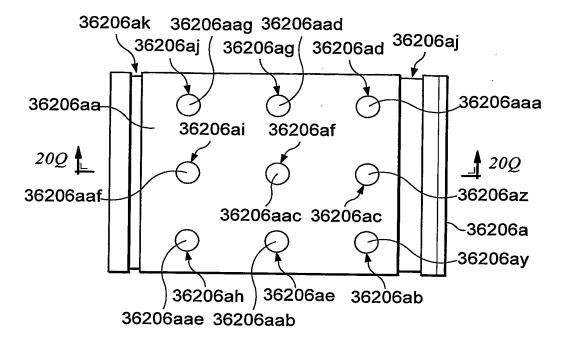
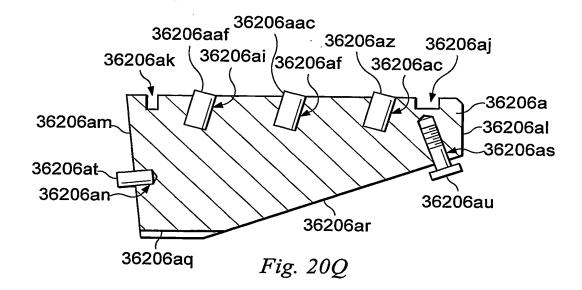
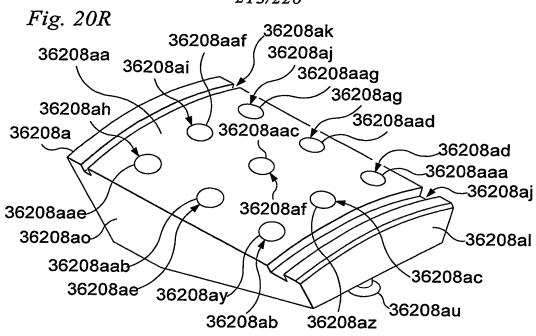
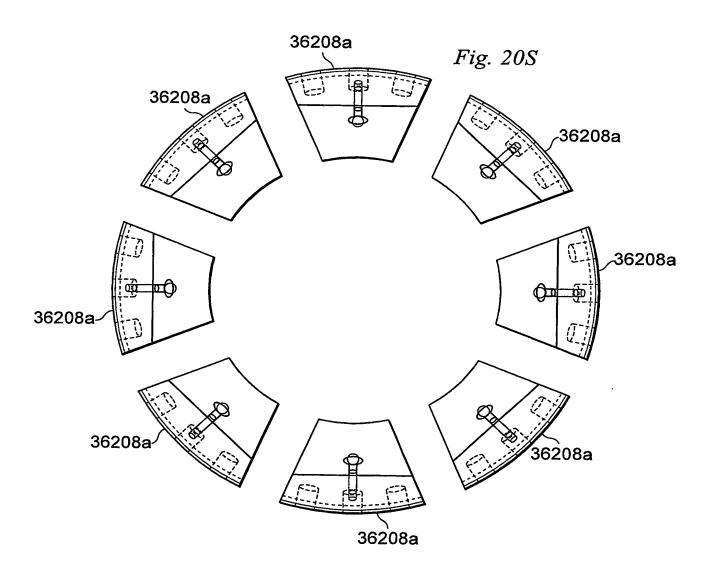


Fig. 20P

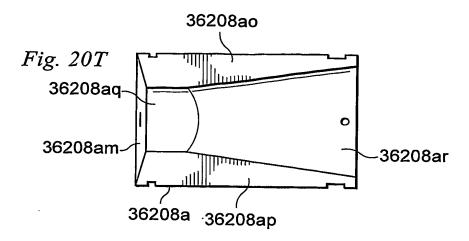


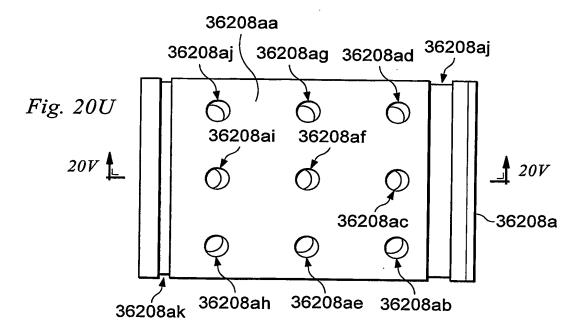


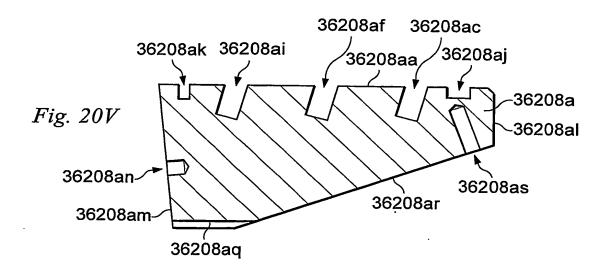




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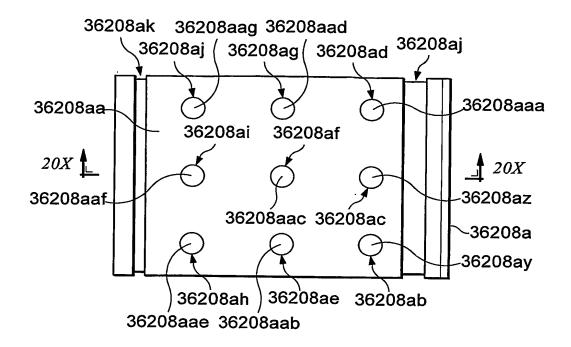
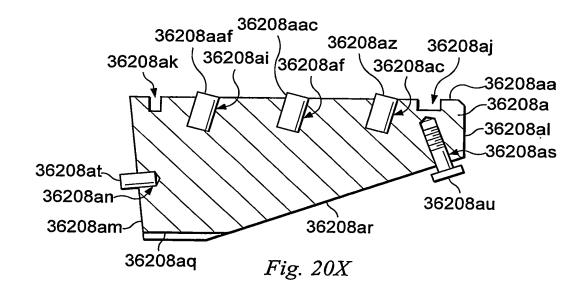


Fig. 20W



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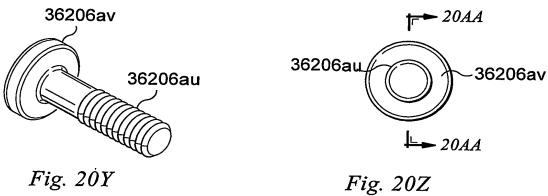


Fig. 20Y

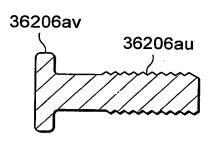
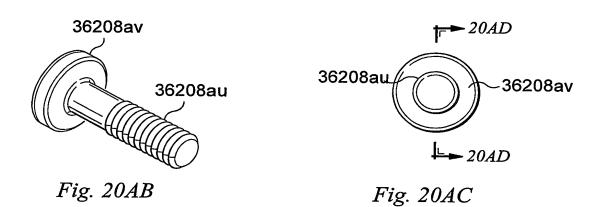


Fig. 20AA



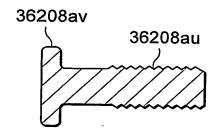


Fig. 20AD

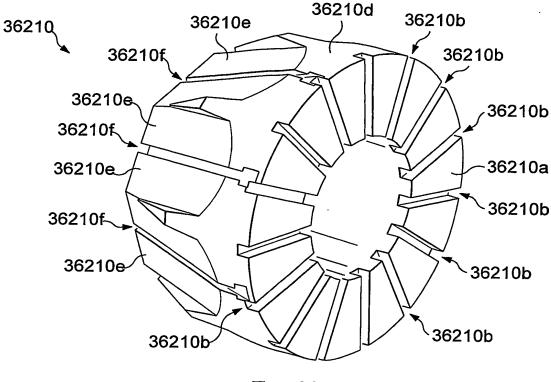
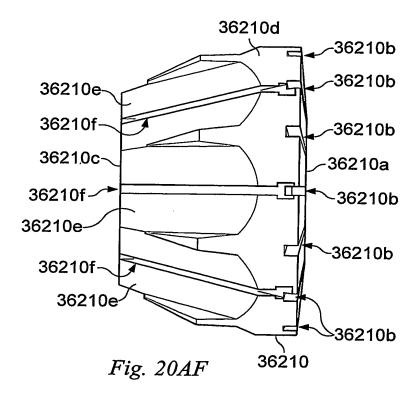
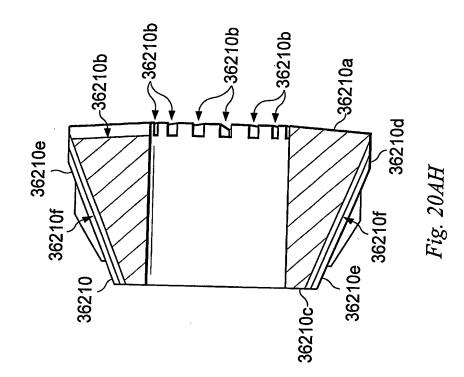
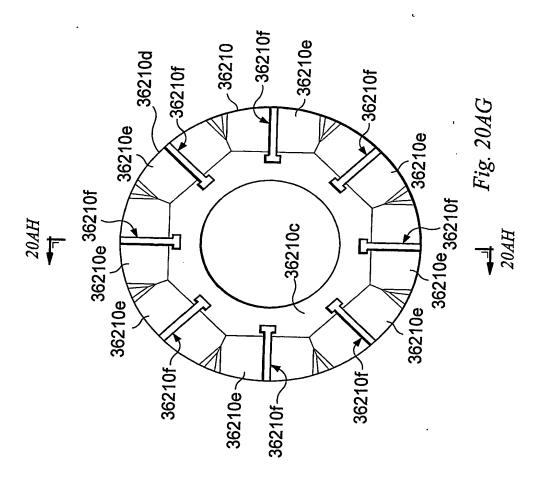


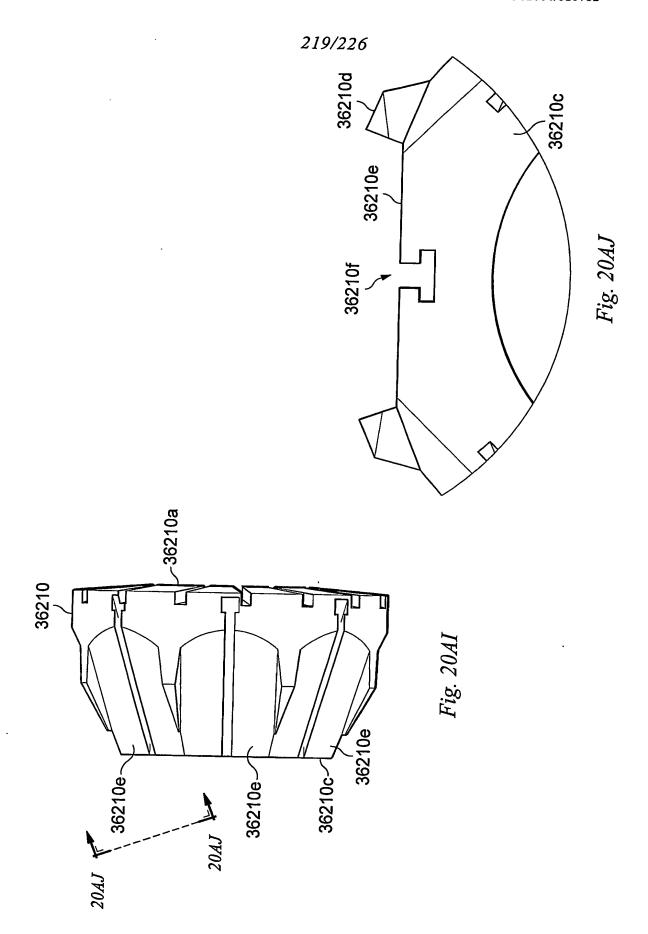
Fig. 20AE



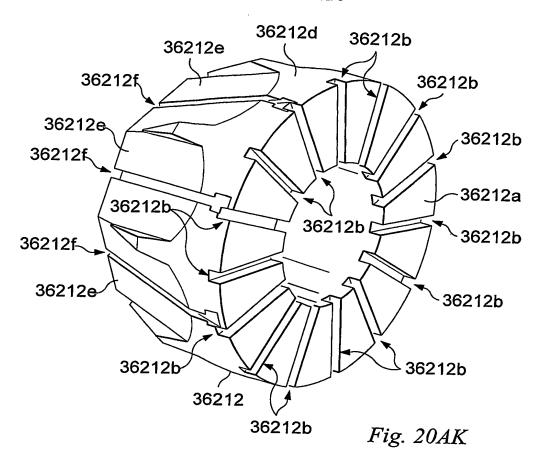


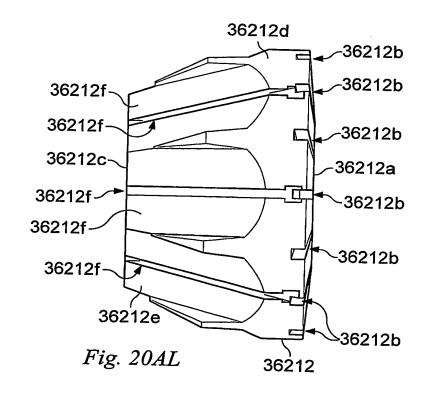


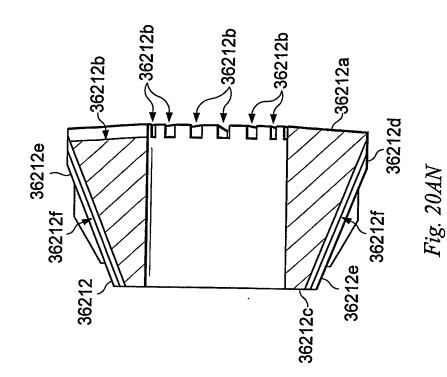


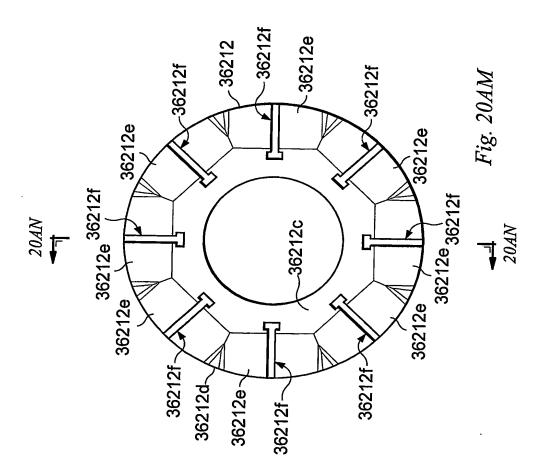


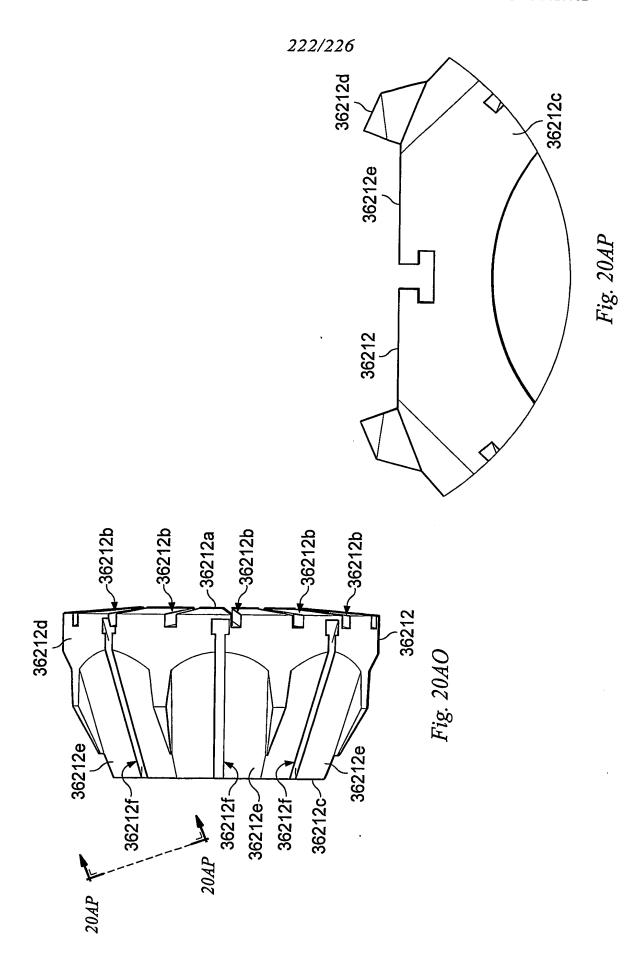
WO 2004/092528 PCT/US2004/010762











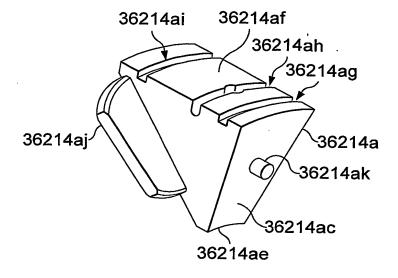


Fig. 20AQ

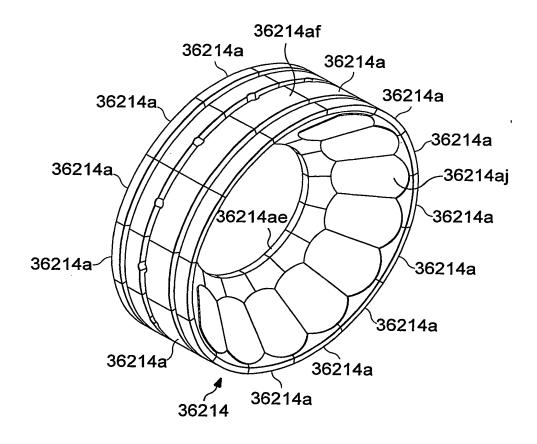
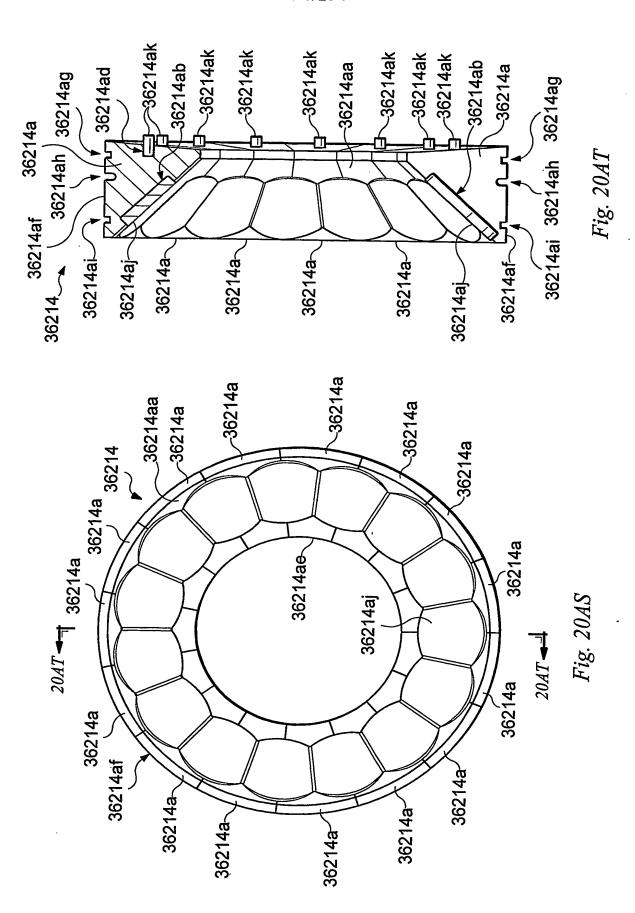
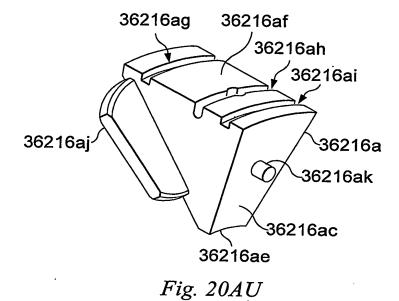


FIG. 20AR





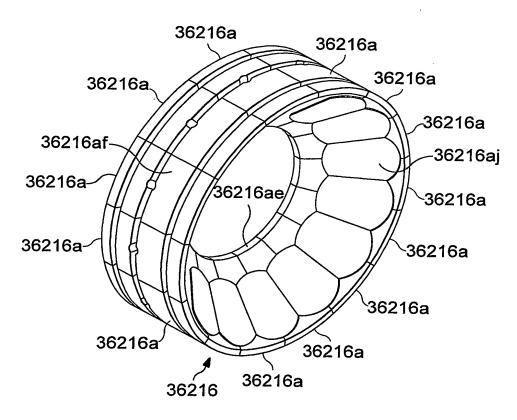


FIG. 20AV

